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MICROPROCESSOR CONTROLLED  
DETECTION AND DRILLING OF PCB HOLES  
UTILIZING AN X-Y STAGE SCANNER

by

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1984

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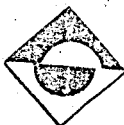
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To My Mother

## ACKNOWLEDGEMENTS

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## ABSTRACT

The purpose of the thesis is to design and realise a system to detect and simulate the drilling of drilling-hole positions in printed circuit board masks making use of a stepper motor driven mechanical moving stage scanner under the control of microprocessor.

Determination of the print outline and the effective frame length, detection of the dots at proper drilling-hole positions, scanning of the dot mask in a meander pattern, generation of switching sequence of the unipolar stepper motors are under the control of software and achieved by interfacing the stage scanner, drive circuitry of the steppers and the detection system to a Z-80 microprocessor card.

Since all the control actions are performed by the microprocessor, the prototype can be considered as an intelligent system. The drilling part of the software minimizes the drilling process time making use of optimum path algorithm.

## ÖZETÇE

Günümüzde, baskılı devrelerin delik delme işlemleri devreler deneme safhasındayken miktarların azlığı nedeniyle önemli bir problem oluşturmakta ve kalıp-pin yöntemi masraflı olduğundan delikler el ile delinmektedir. Tezin amacı bu soruna çözüm getirmektir.

Yapılan prototipte baskılı devre üzerindeki delik yerleri ışık geçiren bir filme işaretlenerek bu filmin mikro işlemci denetiminde optik yöntemle taranmasıyla saptanmakta ve delme işlemi bir ışıkla simüle edilmektedir.

Sistemde kullanılan mekanik tezgah X ve Y yönlerinde adımlayıcı motorlarla hareket ettirilmekte ve tarama işleminde satır yöntemi kullanılmaktadır. Optik sistemin ve motorların tüm kontrolü Z-80 mikroişlemcisi ile gerçekleştirilmiş bir kart tarafından sağlanmaktadır. Geliştirilen sistemde yazılım, delme işleminde zamanı kısaltmak için optimum yol algoritmasını içermektedir.

TABLE OF CONTENTS

	<u>Page</u>
ACKNOWLEDGEMENTS . . . . .	iii
ABSTRACT . . . . .	iv
ÖZETÇE . . . . .	v
LIST OF FIGURES . . . . .	vi
LIST OF TABLES . . . . .	vii
I.    INTRODUCTION . . . . .	1
II.   STEPPER MOTORS . . . . .	4
A.  CONSTRUCTION AND OPERATION . . . . .	5
1.  STEP ANGLE . . . . .	6
2.  STEP ACCURACY . . . . .	6
3.  TORQUE . . . . .	7
a.  HOLDING TORQUE . . . . .	7
b.  RESIDUAL TORQUE . . . . .	7
4.  STEP RESPONSE . . . . .	8
5.  RESONANCE . . . . .	9
6.  TRANSLATOR . . . . .	9
7.  PRESET INDEXER . . . . .	9
8.  RAMPING . . . . .	10
9.  START/STOP WITHOUT ERROR . . . . .	11
10.  SLEW RATE . . . . .	11
11.  DAMPING . . . . .	12
B.  DRIVE METHODS . . . . .	13
1.  BIPOLAR . . . . .	13
2.  UNIPOLAR . . . . .	13
3.  L/R DRIVE . . . . .	15
4.  BI-LEVEL DRIVE . . . . .	15

	5. CHOPPER DRIVE . . . . .	17
	6. WAVE DRIVE . . . . .	17
	C. CHARACTERISTICS OF STEPPERS USED IN THE SYSTEM . . . . .	17
III.	SYSTEM HARDWARE . . . . .	19
	A. MECHANICAL ASSEMBLY . . . . .	19
	B. MECHANICAL DESIGN . . . . .	20
	1. BASE PLATE . . . . .	20
	2. INTERMEDIATE Y-PLATE . . . . .	20
	3. INTERMEDIATE X-PLATE . . . . .	21
	4. LINEAR MOTION BEARINGS WITH CYLINDRICAL SHAFTS . . . . .	21
	5. LEAD-SCREW AND ITS NUT . . . . .	22
	6. MOTOR SHAFT--LEAD-SCREW COUPLINGS . . . . .	23
	7. GLASS PLATE . . . . .	23
	8. OPERATION . . . . .	24
	C. STEPPER MOTOR DRIVE CIRCUITRY . . . . .	25
	D. Z-80 MICROPROCESSOR BASED CARD . . . . .	32
	1. Z-80 CPU . . . . .	32
	2. Z-80 PIO . . . . .	32
	3. MEMORY . . . . .	33
	4. OTHER IC'S . . . . .	34
	E. POWER SUPPLY UNIT . . . . .	36
	1. HIGH VOLTAGE SUPPLY (42V) . . . . .	36
	2. LOW VOLTAGE SUPPLY (18V) . . . . .	36
	3. +5 VOLT SUPPLY . . . . .	37
	4. ADJUSTABLE VOLTAGE SUPPLY . . . . .	37



	F. OPTIC DETECTOR . . . . .	40
IV.	SYSTEM SOFTWARE . . . . .	43
	A. DETECTION PROGRAM . . . . .	43
	1. LINE DETECTION PROGRAM . . . . .	43
	2. FRAME LENGTH DETECTION PROGRAM . . . . .	46
	3. SCANNING AND STORING PROGRAM . . . . .	48
	a. CONSTANT SPEED SCANNING AND DETECTION . . . . .	48
	b. HIGH SPEED SCANNING AND DETECTION . . . . .	51
	c. STORE PROGRAM . . . . .	54
	B. DRILLING PROGRAM . . . . .	56
	C. SUBPROGRAMS . . . . .	58
	1. RESET ROUTINE . . . . .	58
	2. INTERRUPT SERVICE ROUTINE . . . . .	59
	3. ACCELERATION AND DECELERATION SUBROUTINES . . . . .	61
	4. CONSTANT SPEED SUBROUTINES . . . . .	62
	5. DELAY SUBROUTINES . . . . .	62
V.	CONCLUSION . . . . .	64
APPENDIX	A ( OPERATING INSTRUCTIONS ) . . . . .	67
APPENDIX	B ( STEPPER MOTOR SPECIFICATIONS ) . . . . .	70
APPENDIX	C ( MECHANICAL ASSEMBLY ) . . . . .	71
APPENDIX	D ( Z-80 CPU ) . . . . .	74
APPENDIX	E ( Z-80 PIO ) . . . . .	78
APPENDIX	F ( NEGATIVE CIRCUIT LAYOUTS ) . . . . .	81
APPENDIX	G ( CIRCUIT SCHEMATICS ) . . . . .	84
APPENDIX	H ( FLOWCHARTS ) . . . . .	85
APPENDIX	I ( ASSEMBLER PROGRAMS ) . . . . .	105
	BIBLIOGRAPHY . . . . .	151

## LIST OF FIGURES

	<u>Page</u>
FIGURE 1.1 System configuration	2
FIGURE 2.1 Schematic-4 step switching sequence	5
FIGURE 2.2 Single step response	8
FIGURE 2.3 Step rate/time	10
FIGURE 2.4 Speed/torque curve	11
FIGURE 2.5 Damped response	12
FIGURE 2.6 Schematic bipolar switching sequence	14
FIGURE 2.7 Schematic unipolar switching sequence	14
FIGURE 2.8 L/R drive	16
FIGURE 2.9 Unipolar bi-level drive	16
FIGURE 3.1 RL circuit transient	27
FIGURE 3.2 RL transient of the prototype	28
FIGURE 3.3 Stepper motor drive circuitry	31
FIGURE 3.4 Drill simulator circuitry	34
FIGURE 3.5 Address decoding	34
FIGURE 3.6 Power supply circuits	39
FIGURE 3.7 Detection circuitry	41
FIGURE 3.8 Detection mechanism	42
FIGURE 4.1 Dot dimensions	45
FIGURE 4.2 Line detection	63
FIGURE 4.3 Frame detection	63
FIGURE 4.4 Scanning pattern	63

# I. INTRODUCTION

The automatic drilling machines for drilling holes in printed circuit boards at positions stored on cassettes are widely used, but the determination of the hole positions often has to be done by hand. For a small series of printed circuit boards, generating the list of drilling positions is a very substantial part of the total production time. Another method but far more primitive, is drilling holes manually, which consumes more time and is less accurate than the aforementioned.

On the other hand, in the near future, Computer Aided Design will become very important, at which time the drilling positions will be known from the design process. However presently many of the layouts are made by hand. So the best way of handling holes of printed circuit boards is by the automatic determination of drilling positions, which is very cost-effective, where a small series of boards is concerned.

The developed prototype has mainly two aspects: One of them is the automatic scanning of the transparent layout with an optic sensor. The other is the simulation of the drilling procedure. For this purpose, a LED is used instead of a drill. Software provides all controls i.e, scanning, detection, the driving of the stepper motors and simulation of the drilling operation. Thus the system does not need any manual work for operation except pushing the start button and provides high accuracy due to precision stepper motors and high resolution optic sensor.

SYSTEM CONFIGURATION

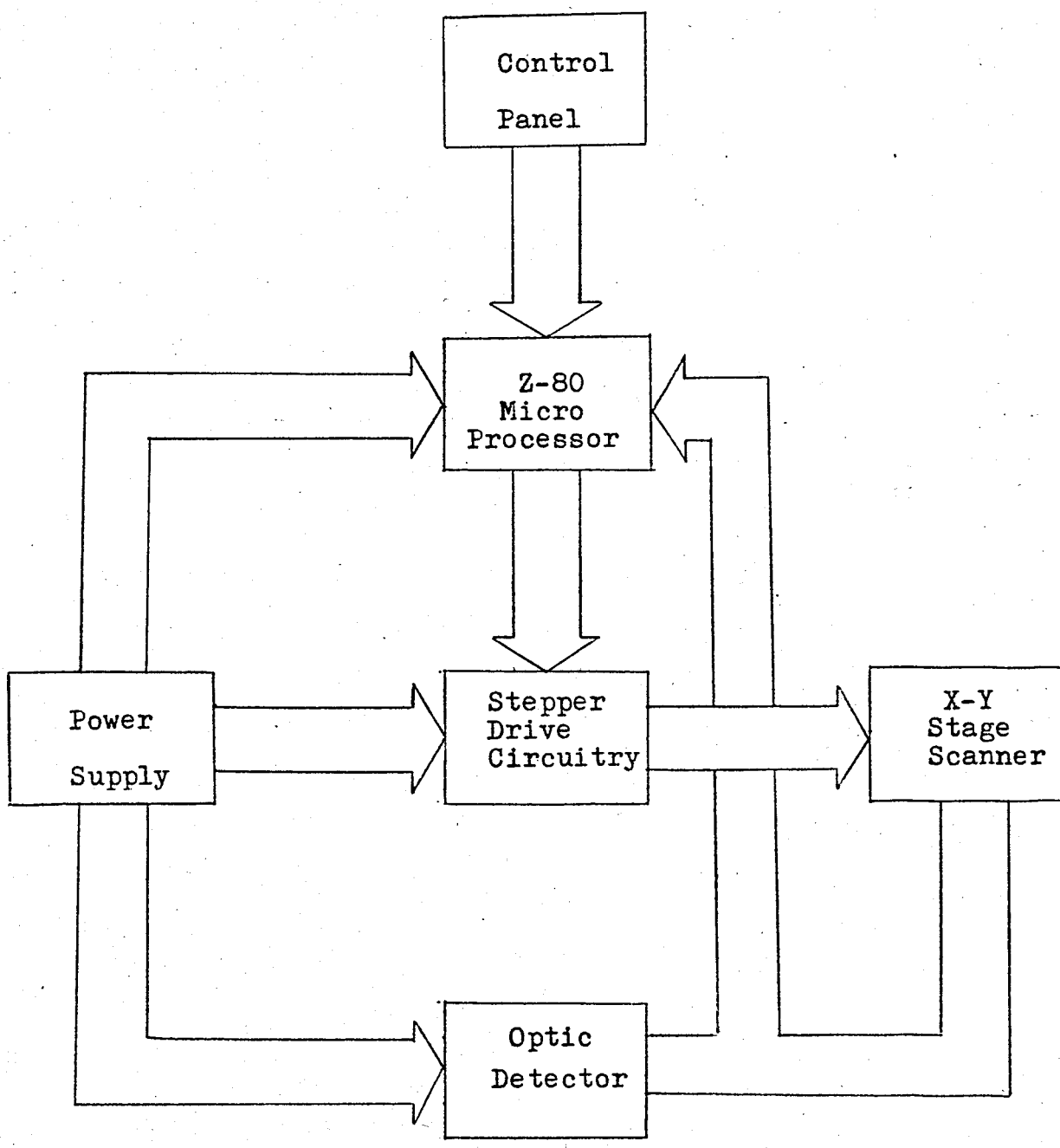


Figure 1.1

System has six main units. Those are :

1. Control panel
2. Z-80 microprocessor based card
3. Stepper drive circuitry
4. Mechanical assembly
5. Power supply unit
6. Optic detector

The above units will be explained in detail in the system hardware section.

## II. STEPPER MOTORS

The stepping motor is a device which translates electrical pulses into mechanical movements. The output shaft rotates or moves through a specific angular rotation per each incoming pulse or excitation. This angle or displacement per movement is repeated precisely with each succeeding pulse translated by appropriate drive circuitry. The results of this precise, fixed and repeatable movement is the ability to accurately position. As opposed to a conventional motor which has a free running shaft, the step motor shaft rotation is in fixed, repeatable, known increments. The stepping motor therefore allows load control ability of velocity, distance and direction. Initial positioning accuracy of a load being driven by a stepping motor is excellent. The repeatability (the ability to position through the same pattern of movements a multiple number of times) is even greater. The only system error introduced by the stepping motor is its single step error, and this is generally less than five percent of one step. Most significantly this error is non-cumulative, regardless of distance positioned or number of times repositioning takes place.

## A. Construction and Operation

In a typical motor, electrical power is applied to two coils. Two stator cups formed around each of these coils with pole pairs mechanically displaced by half a pole pitch, become alternately energized north and south magnetic poles. Between the two stator-coil pairs the displacement is one fourth of a pole pitch.

The permanent magnet rotor is magnetized with the same number of pole pairs as contained by one stator-coil section. Interaction between the rotor and stator (opposite poles attracting and likes repelling) causes the rotor to move one fourth of a pole pitch per winding polarity change. A two phase motor with 12 pole pairs per stator-coil section would thus move 48 steps per revolution or seven and a half per step.

The normal electrical input is a four step switching sequence as shown in figure 2.1

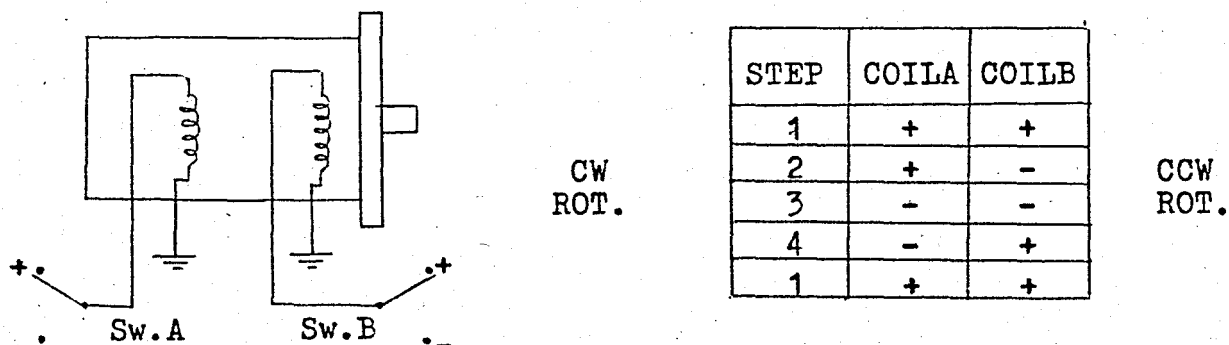


Figure 2.1

Continuing the sequence causes the rotor to rotate forward. Reversing the sequence reverses the direction of rotation. Thus, the stepper motor can be easily controlled by a pulse input drive which can be a two flip-flop logic circuit operated either open or closed loop.

Hereafter some specific names will be used for the stepper motors, so the below terminology will be needed :

### 1. Step Angle

The motor shaft rotates its specific angular increment each time the winding polarity is changed. This specific degree of rotation or increment is called the step angle. It is specified in degrees.

### 2. Step Accuracy

Defined as positional accuracy tolerance. This figure is generally expressed in percent and indicates the total error introduced by the stepping motor in a single movement. The error is noncumulative i.e it does not increase as additional steps are taken. In a linear positioning, with a resolution of .001 inches a three percent motor would introduce a maximum of .00003 inches error into the system. This total error would not accumulate nor increase with total distance moved or number of movements made. A particular step condition



of the four step sequence repeatedly uses the same coil , magnetic polarity and flux path. Thus the most accurate movement would be to step in multiples of four since electrical and magnetic imbalances are eliminated. Increased accuracy also results from movements which are multiples of two steps. So, in positioning applications it is better to use two or four steps or multiples thereof for each desired measured increment.

3. Torque

The torque produced by a specific stepper motor depends on several factors :

- i. The step rate
- ii. The drive current supplied to the windings
- iii. The drive design

a. Holding Torque. At standstill (i.e zero steps per second and rated current) the torque required to deflect the rotor a full step is called the holding torque. Normally the holding torque is higher than the running torque and thus acts as a strong brake in holding a load. Since deflection varies with load, the higher the holding torque the more accurate the position will be held.

b. Residual Torque. The non-energized detent torque of a PM stepper motor is called residual torque. A result of the permanent magnet flux and bearing friction, it has a value

of approximately one tenth the holding torque. This characteristic of permanent magnet steppers is useful in holding a load in the proper position even when the motor is de-energized. The position, however will not be held as accurately as when the motor is energized.

#### 4. Step Response

When given a command to take a step, the motor will respond within a specific time period. This step response or time for a single step is a function of the torque to inertia ratio of the motor and of the characteristics of the electronic drive system. Ratings are given for no-load conditions with time generally expressed in milliseconds. Single step response is shown in figure 2.2

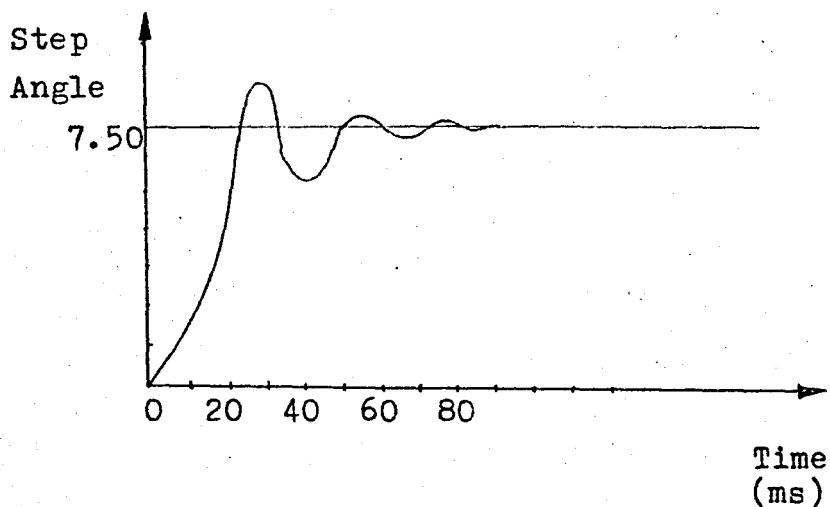


Figure 2.2

## 5. Resonance

Stepper motors are a spring-mass system and, as such, have certain natural frequency characteristics. When a motor's natural frequency or resonance is reached, an increase in the audible level of the motor's operation can be detected. In cases of severe resonant condition, the motor may lose steps and/or oscillate about a point. The frequency at which this resonance occurs varies, depending on the motor and the load. In many applications it may not occur to any perceptible degree; however, it is felt that the designer should realize that this condition can exist and specific facts about the resonant characteristics of an individual motor should be obtained from the manufacturer.

## 6. Translator

An electronic control with circuitry to convert pulses into the proper switching sequence, resulting in one motor step taken for each pulse received.

## 7. Preset Indexer

An electronic control which includes the translator function plus additional circuitry to control the number of steps taken as well as direction and velocity.

## 8. Ramping

The process of controlling pulse frequency to accelerate the rotor from zero speed to maximum speed as well as to decelerate the rotor from maximum speed to zero speed. Ramping increases the capability of driving the motor and load to higher speed levels, particularly with large inertial loads. A typical acceleration control frequency plot for an incremental movement with equal acceleration and deceleration time would be as shown in figure 2.3

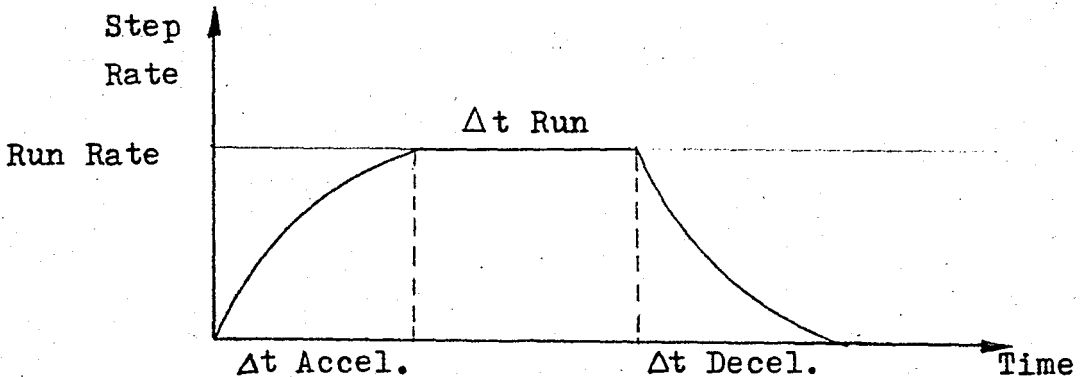


Figure 2.3

Ramping acceleration or deceleration control time allowed :

$$T_j \text{ (Torque mNm)} = J_t \cdot \frac{\Delta V}{\Delta t} \cdot K$$

Where  $J_t$  = Rotor inertia ( $\text{g.m}^2$ ) plus load inertia

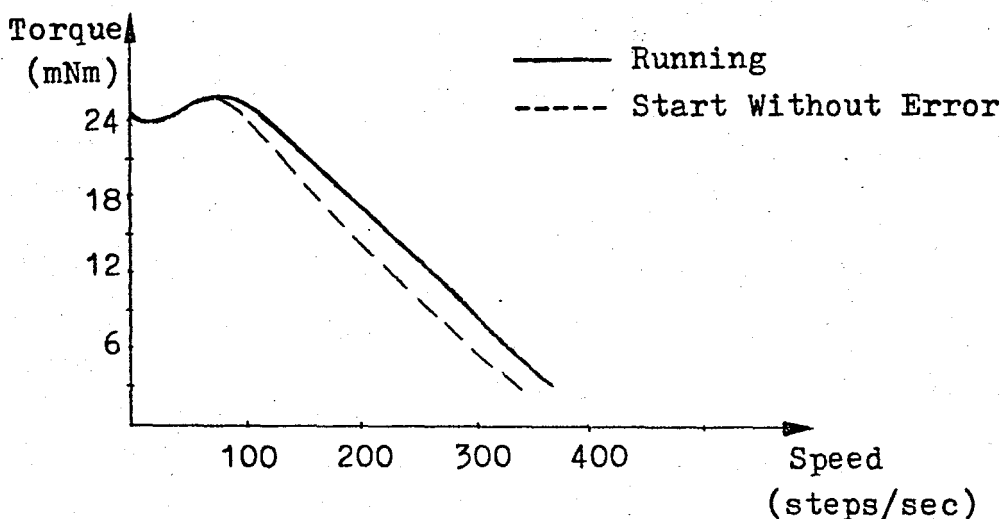
$\Delta V$  = Step rate change

$\Delta t$  = Time allowed for acceleration in sec.

$$K = \frac{2\pi}{\text{Steps/rev}}$$

## 9. Start / Stop Without Error

The start without error curve shows what torque load the motor can start and stop without loss of a step when started and stopped at a constant step or pulse rate. The running curve is the torque available when the motor is slowly accelerated to the operating rate. It is thus the actual dynamic torque produced by the motor. This curve is sometimes called the slew curve. The difference between the running and the start without error torque curves is the torque lost due to accelerating the motor rotor inertia. A typical torque versus step rate characteristics curve is shown in figure 2.4.



Speed-Torque Curves

Figure 2.4

## 10. Slew Rate

An area of high speed operation where the motor can run unidirectionally in synchronism. However it cannot

instantaneously start, stop or reverse. A stepping motor is brought up to a slewing rate using acceleration and is then decelerated to a stop under conditions where no step loss can be tolerated.

## 11. Damping

The reduction or elimination of step overshoot is defined as damping. It is used in applications where settling down time is important. In figure 2.5 electronically damped response is shown.

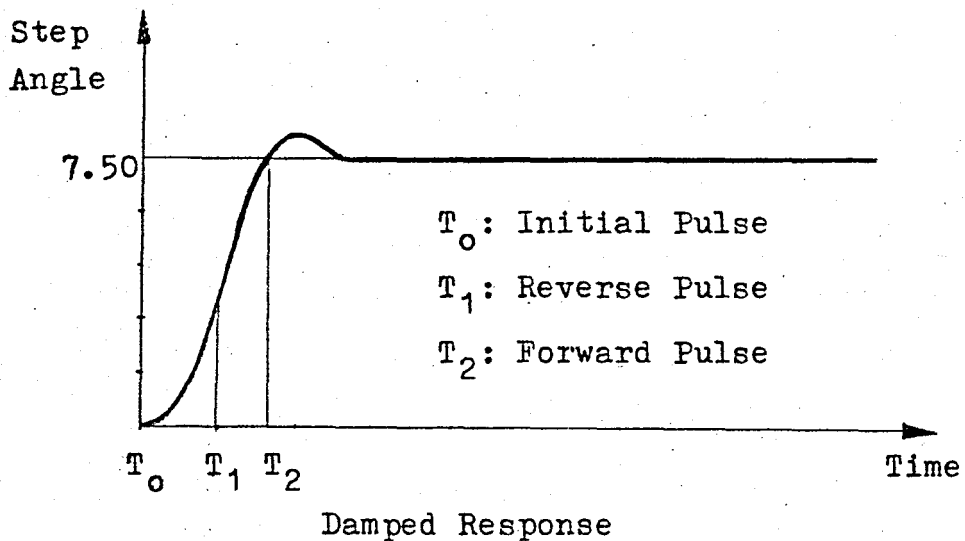


Figure 2.5

## B. Drive Methods

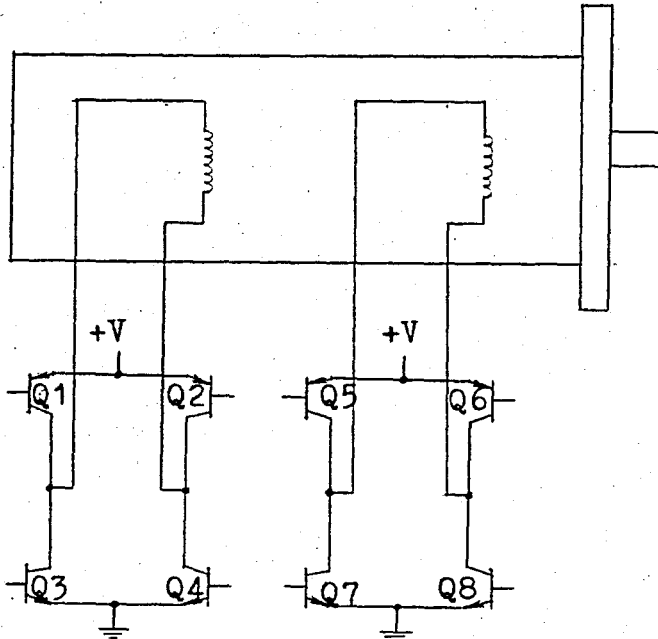
### 1. Bipolar

The stator flux with a bipolar winding is reversed by reversing the current in the winding. It requires a push-pull bipolar drive. Care must be taken to design the circuit so that the transistors in series do not short the power supply by coming on at the same time. Properly operated, the bipolar winding gives the optimum motor performance at low to medium step rates.

### 2. Unipolar

A unipolar winding has two coils wound on the same bobbin per stator half. Flux is reversed by energizing one coil or the other coil from a single power supply. The use of a unipolar winding, sometimes called a bifilar winding allows the drive circuit to be simplified. Not only are half as many power switches required (four vs. eight) but the timing is not as critical to prevent a current short through two transistors as is possible with bipolar drive. For a unipolar motor to have the same number of turns per winding as a bipolar motor, the wire diameter must be decreased and therefore the resistance increased. As a result unipolar motor have 30 percent less torque at low speeds. However at higher rates the torque outputs are equivalent.

SCHMATIC BIPOLAR SWITCHING SEQUENCE



Step	Q <sub>1</sub> -Q <sub>4</sub>	Q <sub>2</sub> -Q <sub>3</sub>	Q <sub>5</sub> -Q <sub>8</sub>	Q <sub>1</sub> -Q <sub>7</sub>
1	ON	OFF	ON	OFF
2	ON	OFF	OFF	ON
3	OFF	ON	OFF	ON
4	OFF	ON	ON	OFF
1	ON	OFF	ON	OFF

Normal  
4 Step Sequence

1	ON	OFF	ON	OFF
2	ON	OFF	OFF	OFF
3	ON	OFF	OFF	ON
4	OFF	OFF	OFF	ON
5	OFF	ON	OFF	ON
6	OFF	ON	OFF	OFF
7	OFF	ON	ON	OFF
8	OFF	OFF	ON	OFF
1	ON	OFF	ON	OFF

CW  
ROTATION

CCW  
ROT.

1/2 Step  
8 Step Sequence

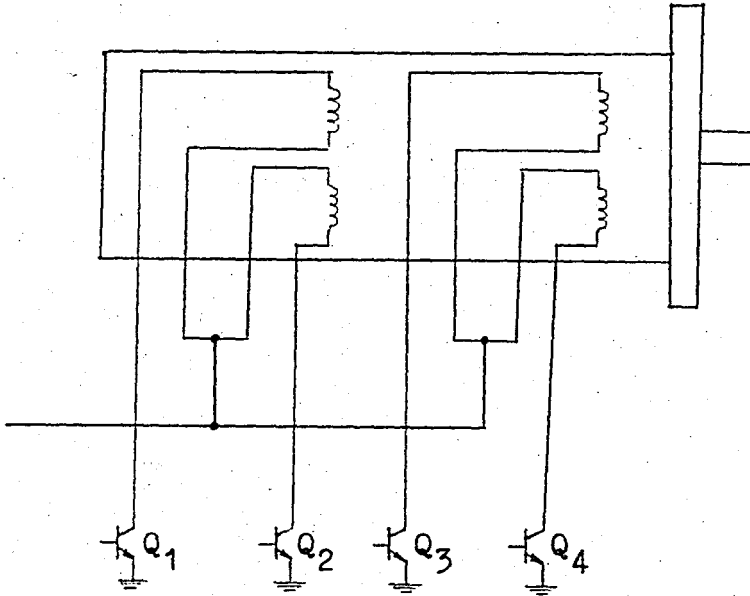
1	ON	OFF	OFF	OFF
2	OFF	OFF	OFF	ON
3	OFF	ON	OFF	OFF
4	OFF	OFF	ON	OFF
1	ON	OFF	OFF	OFF

Wave Drive  
4 Step Sequence

Figure 2.6



SCHMATIC UNIPOLAR SWITCHING SEQUENCE



Step	Q <sub>1</sub>	Q <sub>2</sub>	Q <sub>3</sub>	Q <sub>4</sub>
1	ON	OFF	ON	OFF
2	ON	OFF	OFF	ON
3	OFF	ON	OFF	ON
4	OFF	ON	ON	OFF
1	ON	OFF	ON	OFF

Normal  
4 Step Sequence

1	ON	OFF	ON	OFF
2	ON	OFF	OFF	OFF
3	ON	OFF	OFF	ON
4	OFF	OFF	OFF	ON
5	OFF	ON	OFF	ON
6	OFF	ON	OFF	OFF
7	OFF	ON	ON	OFF
8	OFF	OFF	ON	OFF
1	ON	OFF	ON	OFF

CW  
ROTATION

CCW  
ROT.

1/2 Step  
8 Step Sequence

1	ON	OFF	OFF	OFF
2	OFF	OFF	OFF	ON
3	OFF	ON	OFF	OFF
4	OFF	OFF	ON	OFF
1	ON	OFF	OFF	OFF

Wave Drive  
4 Step Sequence

Figure 2.7

### 3. L / R Drive

A motor operated at a fixed rated voltage has a decreasing torque curve as the frequency or step rate increases. This is due to the fact that the rise time of the coil limits the percentage of power actually delivered to the motor. This effect is governed by the inductance to resistance ratio of the circuit (L/R). Compensation for this effect can be by either increasing the power supply voltage to maintain a constant current as the frequency increases, or by raising the power supply voltage and adding a series resistor as is shown in Fig.2.8 . As the L/R is changed, more total power is used by the system. The series resistors, R, are selected for the L/R ratio desired. For L/4R they are selected to be 3 times the motor winding resistance with a:

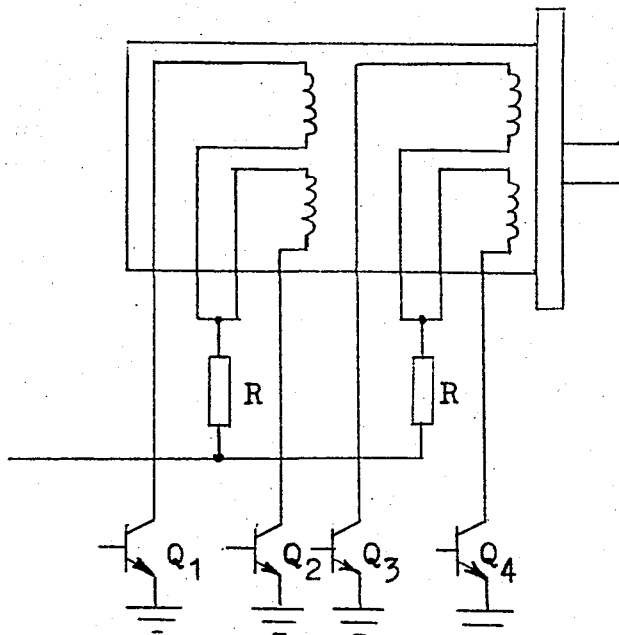
$$\text{Watts rating} = (\text{Current per winding})^2 \times R$$

The power supply voltage is increased to 4 times motor rated voltage so as to maintain rated current to the motor. The power supplied will thus be 4 times that of a L/R drive. The unipolar motor which has a higher coil resistance thus has a better L/R ratio than a bipolar motor.

### 4. Bi-Level Drive

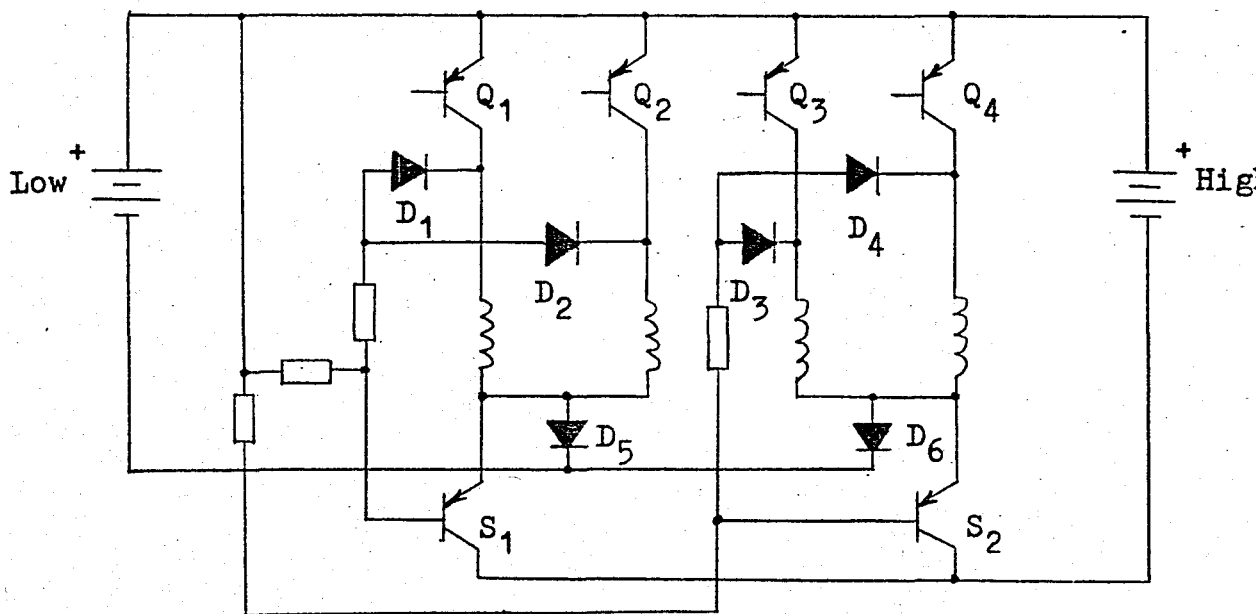
The bi-level drive allows the motor at zero step per second to hold at a lower than rated voltage, and when stepping to run at a higher than rated voltage. The high voltage may be switched on through the use of a current

sensing resistor of a circuit which uses the inductively generated turnoff current spikes to control the voltage, is used.



L/R Drive

Figure 2.8



Unipolar Bi-Level Drive

Figure 2.9

## 5. Chopper Drive

A chopper drive maintains an average current level through the use of a current sensor which turns on a high voltage supply until an upper current value is reached. It then turns off the voltage until a low level limit is sensed where it turns on again. A chopper is best for fast acceleration and variable frequency applications. It is more efficient than a constant current amplifier regulated supply. The supply voltage of choppers is generally five to ten times the motor voltage rating.

## 6. Wave Drive

Energizing one winding at a time is called wave excitation. It produces the same increment as the four-step sequence. Since only one winding is on, the hold and running torque with rated voltage applied will be reduced thirty percent. Within limits, the voltage can be increased to bring output power back to near rated torque value. The advantage of this type of drive is increased efficiency while the disadvantage is decreased step accuracy.

### C. Characteristics of Steppers Used In The System

In the prototype system stepper motors are supplied

from Oriental Motor Company. Specifications of the motors are as follows :

Type	:	PH296-03
Voltage	:	14 V
Current per phase	:	0.7 A/phase
Holding Torque	:	123 N-cm
Resistance per phase	:	20 ohm/phase
Inductance per phase	:	60 mH/phase
Rotor Inertia	:	560 g-cm <sup>2</sup>
Weight	:	1.5 kg
Step Angle	:	1.8
Construction Type	:	Hybrid
No. of phase	:	2
Shaft Type	:	Single
Temperature Range	:	-10° C to 50° C
Temperature Rise	:	80 C or less
Insulation Type	:	Class B
Insulation Resistance	:	100 Mohm at 500 VDC
Dielectric Strength	:	Withstands in normal when impressing 0.5 kV at 60 Hz between the windings and the frame for one minute.

The other characteristics and graphs are in Appendix B.

### III. SYSTEM HARDWARE

The developed system mainly consists of five units :

1. Mechanical assembly
2. Stepper motor drive circuitry
3. Z-80 Microprocessor based card
4. Power supply unit
5. Optic detector system

#### A. Mechanical Assembly

The realization in recent times of the need to implement efficient usage of manpower through improvement in production processes by automation has led to the development of devices such as the X - Y table.

The X - Y stage scanner facilitates the motion of the object to be positioned in either or both the X and Y axes. Obviously there are many methods to design a right angled motion table. Many factors need be carefully considered before deciding on a particular design. The factors are important in the sense that they determine the accuracy and reliability of the equipment. The motions are controlled by motors and the precision required in this application is obtained by using stepper motors which are driven by pulses that can easily be

generated by drive circuits receiving single pulses from Z-80 microprocessor card.

Stepper motors give a very high precision motion depending on the lead - screw used to drive the table. The pitch of the lead - screw determines the amount of linear motion of the table per step of the motor. The main disadvantage of using lead - screw mechanism is backlash. Ofcourse there are some methods to prevent this disadvantage e.g using adjustable nut or spring system.

In the developed system backlash did not cause any problem so compensating methods were not applied.

## B. Mechanical Design

### 1. Base Plate

The base plate supports the entire assembly. Aluminium is preferred due to strength and light property of this metal. Dimensions of this plate are : 260mm x 350mm x 4mm . The base plate supports two other plates at right angles and those plates have shafts and lead-screw mounted on them.

### 2. Intermediate Y - Plate

This is also made of aluminium. Its dimensions are as follows :

330 mm x 110 mm x 4 mm . This plate is placed on the linear motion bearings and the nut which are in turn mounted on shafts and lead-screw. This intermediate plate supports the other plate ( Y - Table ) which has dimensions : 420 mm x 195 mm x 4 mm and this supports the other two plates at right angles which are connected to the shafts and the lead screw.

### 3. Intermediate X - Plate

This plate is supported on the nut and the linear motion bearings which are mounted on shafts and the lead-screw. The dimensions of this plate are : 110 mm x 195 mm x 4 mm . This plate supports the top X-Plate which has dimensions 290 mm x 220 mm x 4 mm .

### 4. Linear Motion Bearings with Cylindrical Shafts

The best way is to use linear bearings to provide smooth movements. These bearings move along their shafts and are designed to give a smooth movement, which has extremely low friction. The X and Y tables are straight away mounted on these bearings and the lead-screws move the tables on those bearings giving perfect motion.

In order to have a robust system two shafts for the Y - table and two shafts for the X - table are used. Four bearings support each table. This means two bearings on



each shaft. The shafts are made out of steel. The length of the X-table shafts is 400 mm and that of the Y-table is 320 mm. The diameter of both shafts is 16 mm.

Iko linear motion bearings ( No. D-16 ) were selected and placed inside of aluminium blocks to support the X and Y tables. The shafts of both the X and the Y tables are supported by two other blocks at each end.

## 5. Lead-Screw and Its Nut

The most significant part of the X - Y table is the realization of the lead-screw and its nut. The pitch of the lead-screw determines the linear distance through which the X - Y stage scanner moves. The lead-screw moves in a nut and in the prototype, together they have virtually no backlash. The lead-screw has eight threads per inch, therefore the motor shaft needs to make eight revolutions to linearly displace the given X-Y table by one inch. Every revolution of the motor is made as a series of 200 steps i.e 1600 steps of the motor produce a linear displacement of one inch or one step produces  $1/1600$  inch displacement of the table i.e 0.015875 mm. This is the resolution of the prototype X-Y positioning table.

The nut is fixed under both the X and Y tables and the rotating lead-screw will move through the nut. Since the lead-screw motion is restricted to rotation only, it will cause the nut and hence the table to move linearly along the axis of the lead-screw. Since the length of the lead-screw is too long it is safer to give it some kind of radial bearing

support. These bearings allow the lead-screws to rotate within them i.e the lead-screw will move within the bearing and at the same time will be supported by the bearing support. The lead-screw is suitably machined so that the support bearing fits on to the lead-screw perfectly. These bearings are fixed with some supports that are produced in the workshop of the university.

#### 6. Motor Shaft, Lead - Screw Couplings

The power from the motor is transmitted to the lead-screw by coupling the motor shaft into the lead-screw and the combination is tightened by two screws which have housings on the lead-screw shaft.

The X and Y table motors are mounted to the block where two shafts and lead-screw are mounted. For this purpose four screws for each motor are used through the metal spacing units. At this point the important thing is the adjustment of the levels of the motor shaft and the lead-screw. In the developed system this levelling did not cause any problem due to design.

#### 7. Glass Plate

This is the top part of the X-Y table which is placed on the X plate by using metal spacing units at all the four corners of the X-table. The aim of this spacing is to install the light source under the sample film to be scanned. So, the

order of the units from top to bottom is : optic detector, sample film, glass plate and the X-plate. The distance between the glass plate and the X-table is 32 mm. The dimensions of the glass plate are 270 mm x 220 mm x 4 mm.

## 8. Operation

Every pulse input from the microprocessor card to the drive circuit makes the stepper motor rotate through one step or 1.8 degrees. Hence a total of 200 pulses, input to the drive circuit cause the motor shaft to make one revolution.

The scanning area of the X-Y table is defined by the length of the shafts. The developed system can scan an area which has an X-length of 220 mm and a Y-length of 150 mm.

The details related to the mechanical assembly are given in the appendix C.

### C. Stepper Motor Drive Circuitry

The drive methods for stepper motors are explained in chapter 2. In the second chapter. It can be easily understood that the drive circuitry affects the speed-torque characteristics of the steppers.

In order to have a proper drive, first the mechanical characteristics of the system must be considered, and then the selection of right stepper motors drive circuitry.

The best way to approach this problem, is to examine the speed-torque characteristics curves, and then settle the load specifications. If no acceleration is needed and the load is frictional, start-without-error curve should be used. The running curve, in conjunction with the equation :

$$T = I\alpha$$

where

T = Torque

$\alpha$  = Angular acceleration

I = Inertia

must be considered when the load is inertial and/or acceleration control is needed.

In the prototype system, X-Y stage scanner moves on linear motion bearings which have very little friction, hence the system does not need large amount of torque output from the motor, except that it needs high speed due to time consuming high resolution scanning.

Since the stepper motors are supplied before the realization of X-Y stage scanner, they are ordered from the powerful series. Thus it was a must to have a powerful drive

stage to run these steppers at the required high speed.

The speed versus torque characteristics show that the steppers used in this project have the highest torque output at approximately hundred pulses per second. In addition to this, from the inertia versus starting-pulse-rate characteristics, it is seen that the maximum starting-pulse-rate is around two hundred pulses per second, and sometimes it is advisable to start with half of this speed in order not to lose any steps.

Under these circumstances, when all the drive methods are examined, the most suitable drive type seems to be the chopper drive.

In the chopper drive, current is sensed by a current sensing resistor which turns on a high voltage supply as soon as the current reaches 0.7 amperes and turns it off when the current falls below this value.

The prototype system as mentioned above needs acceleration, high speed and deceleration to save time. For this purpose it is appropriate to give some explanation about stepper's behaviour at variable frequency applications.

The torque output of the stepper motors needed to move the X-Y table is directly proportional to the current that passes through the coils of stepper motor. So, at high speed applications current cannot easily reach its rated value when normal supply voltage is used. It is very logical from the basic equation  $V = I Z$  that, in order to have high currents through a coil showing an impedance  $Z$ , voltage must attain higher values.

The rise of current depends on the L/R time constant. This can be expressed by the following formula :

$$I = I_f \left( 1 - e^{-\frac{t_1 R}{L}} \right)$$

where

$I$  shows the value of current at time  $t_1$ , and

$I_f$  represents the final value of current

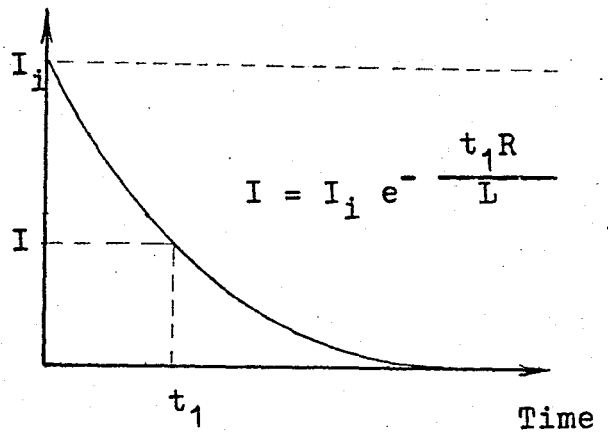
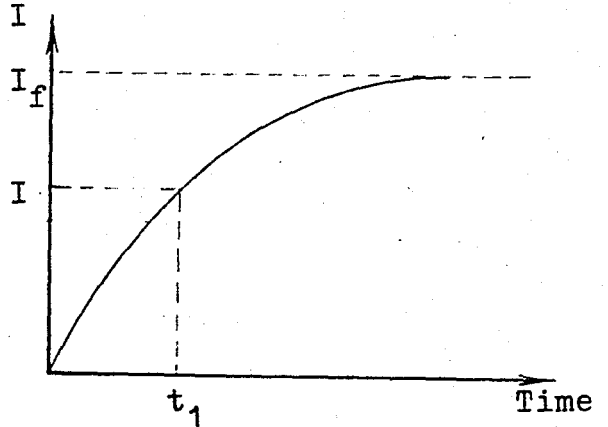
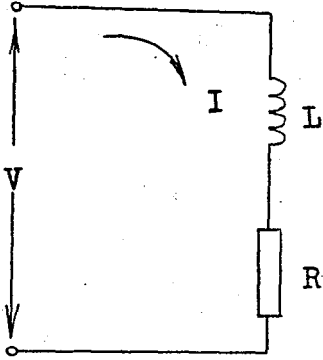


Figure 3.1

Current reaches around 60 percent of its final value at time  $t=L/R$  during charging. Discharge process can be viewed as the opposite of charging process. For example in the prototype the rated voltage of stepper motors is 14 V and their resistance per phase is 20 ohms and inductance per phase is 60 mH.

According to these data, the current reaches its 60 percent of its final value at time  $t=L/R$ .

$$I_f = \frac{V}{R} = \frac{14}{20} = 0.7 \text{ A}$$

$$I = 0.42 \text{ A at } t=L/R$$

On the other hand, if high voltage (e.g 42 V in the prototype) supply is used :

$$I_f = \frac{42}{20} = 2.1 \text{ A}$$

$$I = 1.26 \text{ A at } t=L/R$$

It can be seen from these rough calculations that the current can reach three times high a value when it is driven from the higher voltage supply in spite the fact that the time interval does not change i.e  $t=L/R$ .

Considering all these advantages a modified version of chopper drive is used. It somewhat behaves like a bi-level drive which is also mentioned in chapter two.

In the developed system :

$$V = 42 \text{ V}$$

$$R = 20 \text{ ohm}$$

$$L = 60 \text{ mH}$$

$$I = 0.7 \text{ A}$$

So the time required to attain a current of 0.7 A is 0.0012 s. As a result , a speed of 835 pulse per second is obtained.

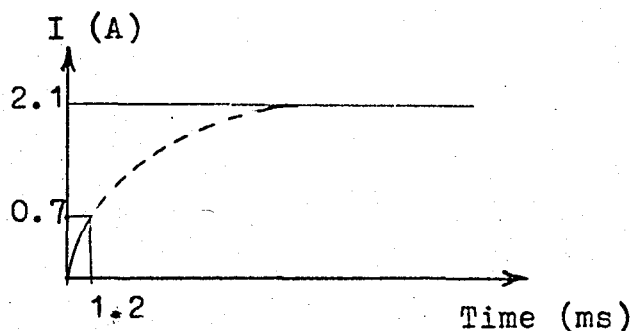


Figure 3.2

Referring to the figure 3.3 where two different supply levels are seen, the high voltage supply (42 V) is connected to the stepper motor windings through  $Q_1$  and  $Q_2$  power transistors. These transistors stay on, till the final value of winding current (0.7 A) is reached. Then  $Q_{11}$ ,  $Q_{12}$  conduct and  $Q_1$  and  $Q_2$  go into cut off and some power is dissipated through the  $R_1$  and  $R_2$ . At this time, the second low voltage (18 V) supply takes over the current and dissipation of  $Q_1$  and  $Q_2$  is avoided.

The diodes  $D_1$  and  $D_3$  are used to prevent the reverse biasing of  $Q_1$  and  $Q_2$ . There can be seen two fuses ( $F_1, F_2$ ) to protect the system.  $D_2$  (zener),  $D_4$  (zener),  $D_5$ ,  $D_6$ ,  $D_7$ ,  $D_8$  are used for voltage suppression. Also  $D_9, D_{10}, D_{11}, D_{12}$  prohibits the negative pulses that may come from the windings due to the magnetic field created by the rotating permanent magnet rotor. Whenever winding current is turned off, a high voltage inductive spike will be generated which could damage the drive circuit switching transistors.

The above mentioned inductive spike results as per the inductor voltage equation :

$$V = L \frac{dI}{dt}$$

where a high value of rate of change of current is encountered due to an extremely small switching time interval.

The normal method used to suppress these spikes is to put a diode (Free Wheeling diode) across each winding. This, however, will reduce the torque output of the motor unless the voltage across the switching transistors is allowed to build up to at least twice the supply voltage. The higher this



voltage the faster the induced field and current will collapse and thus the better performance. In the prototype circuit 120 V zener diodes are used for this purpose. Diodes  $D_{13}$  and  $D_{14}$  avoid the reverse currents to the low level supply (18 V).

The second supply is set to 18 V, since there will be a 14 V drop on the motor windings, 0.7 V on the diodes ( $D_{13}$  and  $D_{14}$ ), 2.5 V collector to emitter voltage drop on the transistors ( $Q_4, Q_5, Q_8, Q_9$ ) and 0.7 V on the current sensing resistors ( $R_9$  and  $R_{10}$ ).

The pulse sequence from the microprocessor card taken as output from the peripheral device (PIO) is fed to the bases of  $Q_3, Q_6, Q_7, Q_{10}$  through the base resistors  $R_3, R_4, R_5$  and  $R_6$ .

Ofcourse there are some limitations due to the stepper motor characteristics beside the drive method. Increasing the voltage to a stepper motor at standstill or low stepping rates will produce a proportionally higher torque until the magnetic flux paths within the motor saturate. As the motor nears saturation, it becomes less efficient and thus does not justify the additional power input.

The maximum speed a stepper motor can be driven is limited by hysteresis and eddy current losses. At some rate, the heating effects of these losses limits any further effort to get more speed or torque output by driving the motor harder.

The realised driving cicuitry improved the speed characteristics of the stepper motors which are not very suitable for high speed applications. During scanning a speed of 835 pulse per second is reached by means of this modified chopper drive circuit.

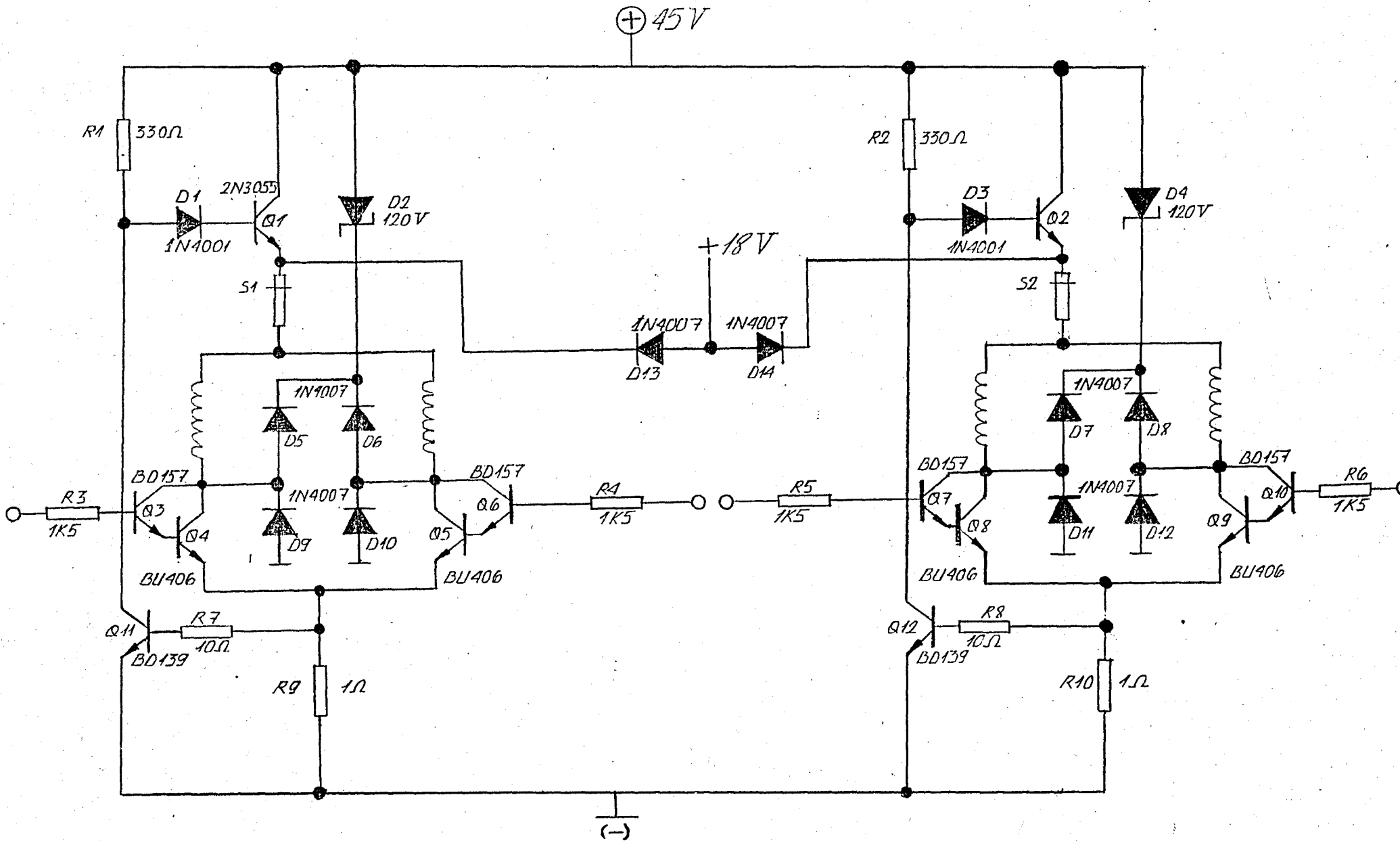


Figure 3.3 Stepper Motor Driving Circuitry

## D. Z-80 Microprocessor Based Card

This card consists of four main parts :

1. Z-80 CPU
2. Z-80 PIO
3. Memory Section
4. Other IC's

### 1. Z-80 CPU

All controls are carried out by this unit. It works with a 2 MHz clock. This frequency obtained from a D-type flip-flop which divides the 4 MHz crystal frequency. The Reset input of the CPU is used through a D-type flip-flop also. The non-maskable interrupt, Wait and Bus Request inputs are connected to the  $V_{cc}$  by the pull-up resistors. The Halt state is shown by driving a PNP transistor which is used to turn on the LED.

### 2. Z-80 PIO

The Z-80 parallel input-output circuit is a programmable, two port device which provides a TTL compatible interface between peripheral devices and the Z-80 CPU. The CPU can configure the Z-80 PIO to interface with a wide-range of peripheral devices. In the prototype an 8 bit output is used to give the step sequence of motors, 4 least significant bits are controlling the X-motor, while the most significant

4 bits controlling the Y-motor.

The other port (B) is used as an input port during the scanning process and as an output port while simulation of the drill process. The circuit shown in the figure 3.4 is used for simulation making the LED flash when the detector (simulating the drill) comes on to the dot which should be drilled.

### 3. Memory

System uses three memory units. Two of them are 2k x 8 bit EPROMS (2716 type) and the other is a 2k x 8 bit static RAM (6116 P-3 type).

The storage size of the 2k RAM limits the card size to 170 mm x 140 mm despite that the maximum scanning area is 220 mm x 150 mm (X,Y) mechanically. Along with the hole position storage, a part of the RAM acts as a stack and also as a scratch-pad for the program.

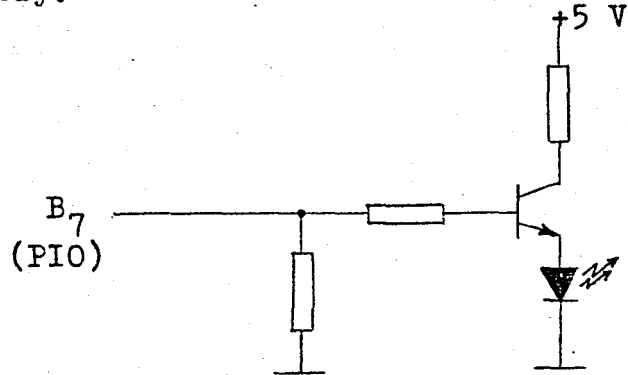
The memory addresses of the system are decoded as follows :

EPROM 1	.....	0000	-	07FF
EPROM 2	.....	0800	-	0FFF
RAM	.....	8000	-	87FF

This decoding is performed by one half of a 74LS139 (Decoder/Demux). Inputs of this IC are supplied from the address pins ( $A_{11}$  and  $A_{15}$ ) and  $\overline{MREQ}$  pin of CPU.  $Y_0$ ,  $Y_1$ ,  $Y_2$  outputs of the decoder select the EPROM 1, EPROM 2 and RAM

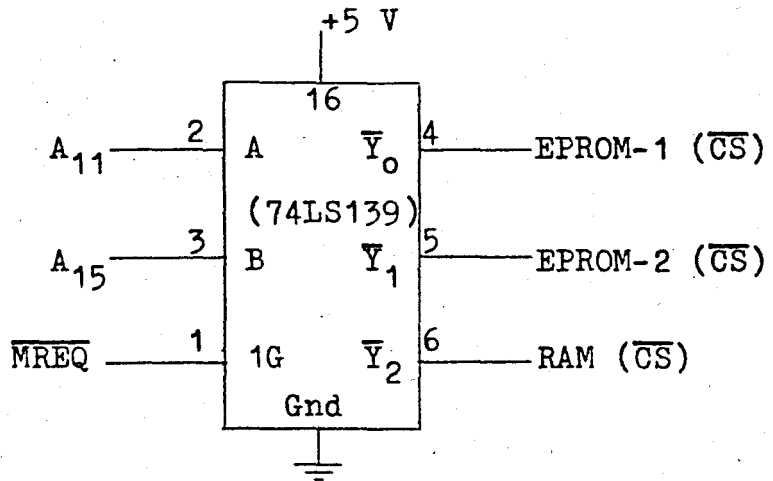
respectively, as shown in the figure 3.5

The output enable pins of EPROMS and RAM are connected to the  $\overline{RD}$  pin of CPU. The RAM output enable pin has connection with the  $\overline{WR}$  pin of CPU to perform writing operations into the memory.



Drill Simulator

Figure 3.4



Address Decoding

Figure 3.5

#### 4. Other IC's

The other IC's perform the interrupt action as follow  
System interrupt mode is set to 2 to have control inputs for

the X-Y table movements. In mode 2 system creates 16 bit starting address of the service routine. The programmer maintains a table of 16 bit starting addresses for every interrupt service routine. This table may be located anywhere in the memory. When an interrupt is accepted a 16 bit pointer must be formed to obtain the desired interrupt service routine's starting address from the table. The upper 8 bits of this pointer are formed from the content of the I-register. The I-register must have been previously loaded with the desired value by the programmer. In the developed board, the lower 8 bits of the pointer are supplied by the interrupting switches. The point to note is that only 7 bits can be used leaving the least significant bit zero. This is needed since the pointer is used to get two adjacent byte to form a complete 16 bit service routine's starting address and the addresses must always start in even locations.

In the Z-80 hardware layout given in the appendix, this interrupt mode works as follows : When one of the switches connected to interrupt inputs is drawn to ground, the NAND gate output goes high and sends a 1.3 microsecond interrupt pulse through the capacitor and resistor network, meanwhile the Octal Transparent Latch (74LS373) is enabled and it latches the data on its input. Meanwhile the CPU generates an INTA signal which enables the latch output, hence the data is loaded on the data bus. As mentioned before, this data form the lower 8 bits of the 16 bit starting address of the service routine. Then the CPU executes the program from that address on.

## E. Power Supply Unit

This unit is made up of four main parts :

### 1. The High Voltage Supply

This supply uses 32 VAC input. After rectification and capacitive filtering, this unit is connected to the high voltage pin of the drive card. For this part of the supply no regulator is used since inductive spikes that are created due to high speed switching of the drive card, may damage the regulator circuit besides that there is no need for such regulation as far as drive circuit structure is concerned. The output of this supply is 45 V at no load conditions, and at loading it falls to 42 V that is sufficient for the drive card.

### 2. The Low Voltage Supply

After rectification and capacitive filtering 25 VDC is fed to the input of integrated voltage regulator (7818). The output (18 VDC) is used as the low level supply and approximately 350 mA current is drawn by the drive circuitry. This second supply is needed to have bi-level drive for the stepper motors, so it provides current at low speeds (246pps) mostly and prevents the dissipation of transistors ( $Q_1$  and  $Q_2$ ) due to high voltage, by keeping them at the cut off.

If the low voltage supply were not included in the power supply unit, then, after the inductor current reaches its rated value (0.7 A), there would be a voltage on the transistors ( $V_{CE}$ )  $Q_1$  and  $Q_2$  which is equal to  $42-17=25$  V where

42 V = The high voltage supply

17 V = Voltage drop on the motor windings +  $V_{CE}$  of switching transistors ( $Q_4$ ,  $Q_5$ ,  $Q_8$  and  $Q_9$ ) + Voltage drop on the current sensing resistors ( $R_9$  and  $R_{10}$ )

Thus this voltage (25 V) with the rated current of motor windings, would cause approximately 17.5 W power dissipation on the transistors  $Q_1$  and  $Q_2$ .

### 3. + 5 Volt Supply

The output of 18 V voltage regulator is also taken as the input for +5 V regulator (7805).

+5 V supply is used for the Z-80 microprocessor card, for the drill simulator circuit and also for the detection circuitry. The amount of current that is drawn from this supply is approximately 250 mA.

### 4. Adjustable Voltage Supply

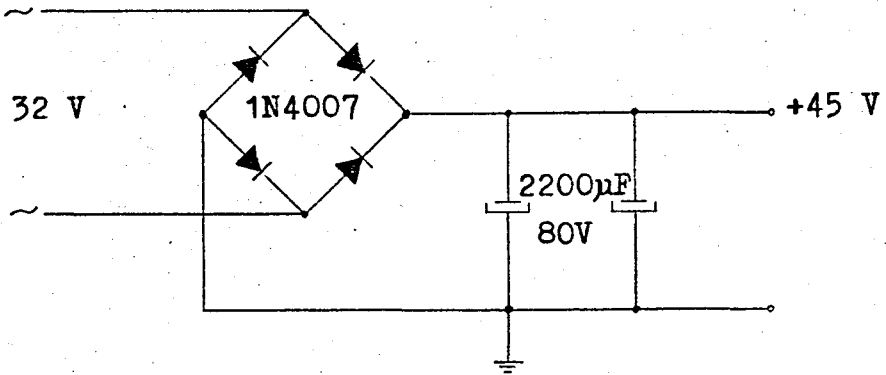
This adjustable voltage regulator (723) also uses 18 V regulator output as input and gives output to the lamp



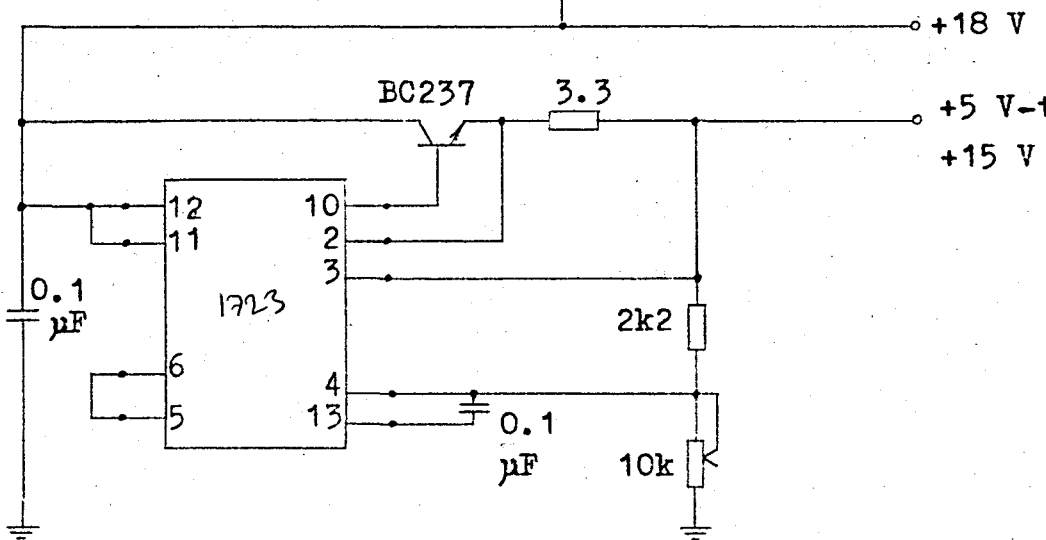
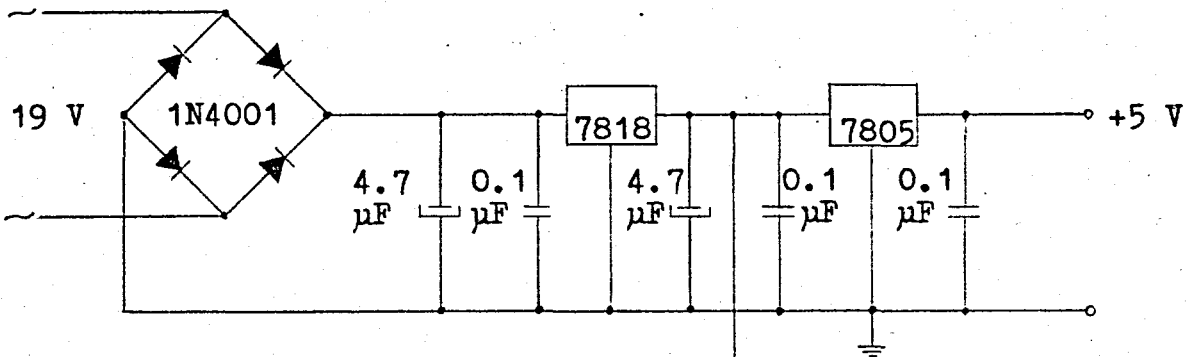
of the detection circuit. The voltage regulator is so set that its output can be adjusted from +5 V to +15 V. Adjustable source is needed because of the critical trigger levels of optic sensor output. Lamp needs approximately 70 mA.

The related figures of the power supply unit are shown on the following page.

High Voltage Supply



Low Voltage & +5 V Supply



Adjustable Supply

Figure 3.6

## F. Optic Detector System

The optic detection is one of the most important features of this thesis. Presently, there are many different kinds of optical sensors. In the developed system, the resolution of two consecutive points is 1.27 mm. This is not a very small distance for the sensor which is chosen for scanning procedure.

The optic sensor is not sensitive to the side lights due to its lens. In application, a small light source is used and the detector is centered on top of it, keeping a distance for the glass plate and the film.

For detection process, the operator places the dark solid dots on the transparent film. Then this film is scanned line by line. The sensor which is a transistor changes its state depending on the intensity of the light. The transistor is used in the common emitter configuration and the collector voltage is taken as output. Due to the mechanical movement and other disturbances, the best results can be achieved by using a comparator. For this purpose, LM 324 is used in the prototype. So the triggering level can be determined by adjusting the potentiometer i.e. comparator inverting input voltage level is adjusted.

The comparator is essential in the circuitry in order to generate a +5 V signal for even a small input from the optical sensor. Direct coupling between the sensor and the microprocessor would not be appropriate because of the weak signal from the sensor, not being able to trigger the input port of the PIO of the Z-80 microprocessor.

Consequently, the output switches between high (+5V) and low (0V) levels. Those voltages are applied to the input port of the PIO of the Z-80 microprocessor card and this optical information is written to the memory, according to the scan program.

The detection circuitry and the detection mechanism are shown in figure 3.7 and figure 3.8 respectively.

### Detection Circuitry

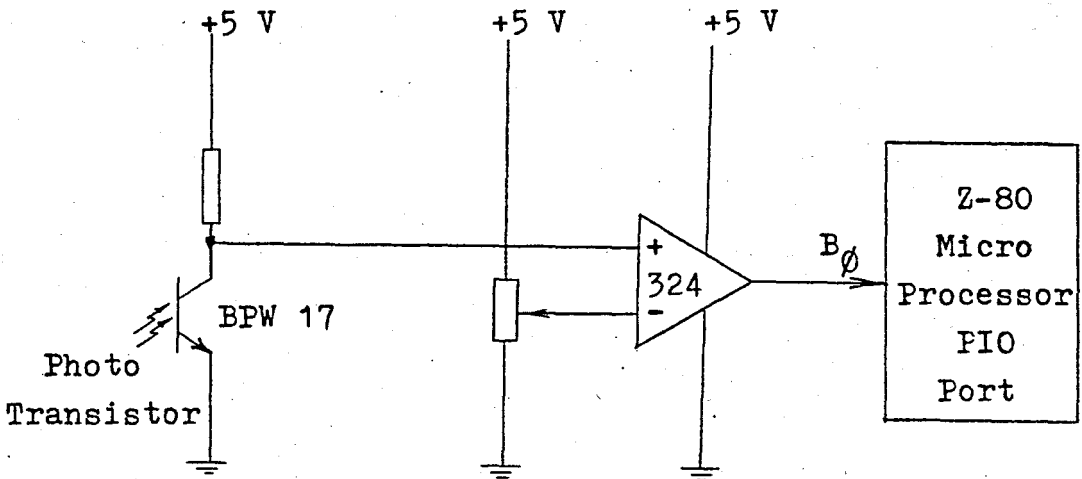


Figure 3.7

## Detection Mechanism

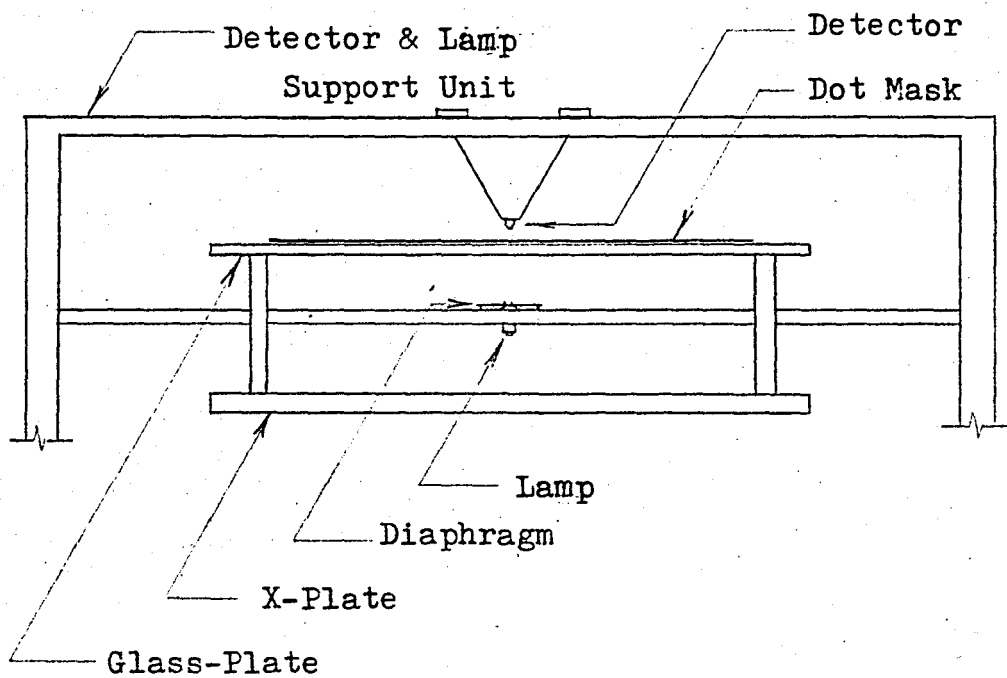


Figure 3.8

## IV. SYSTEM SOFTWARE

The software of the system consists of mainly two sections and each program contains subprograms.

### A. Detection Program

1. Line Detection Program
2. Frame-length Detection Program
3. Scanning and Storing Program

### B. Drilling Program

### C. Subprograms

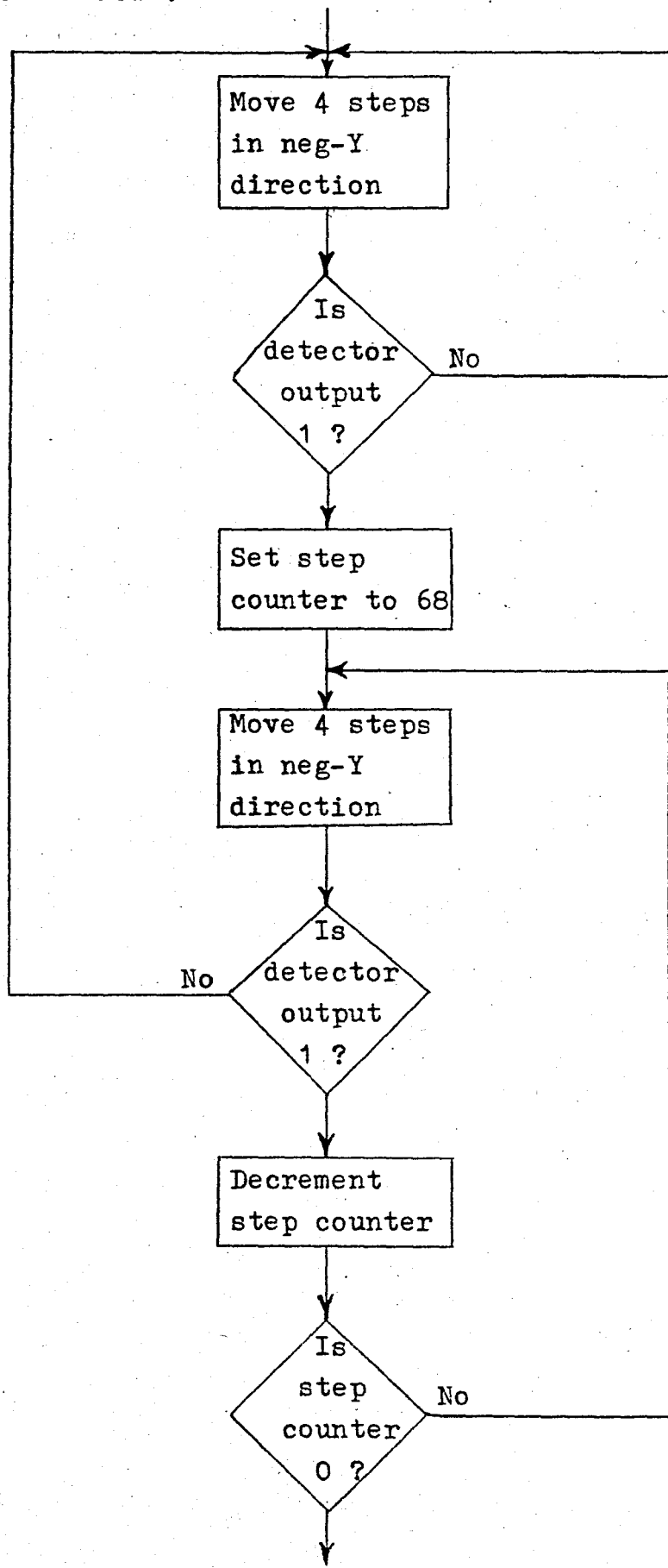
1. Reset Routine
2. Interrupt Service Routine
3. Acceleration and Deceleration Subroutines
4. Constant Speed Subroutines
5. Delay Subroutines

### A. Detection Program

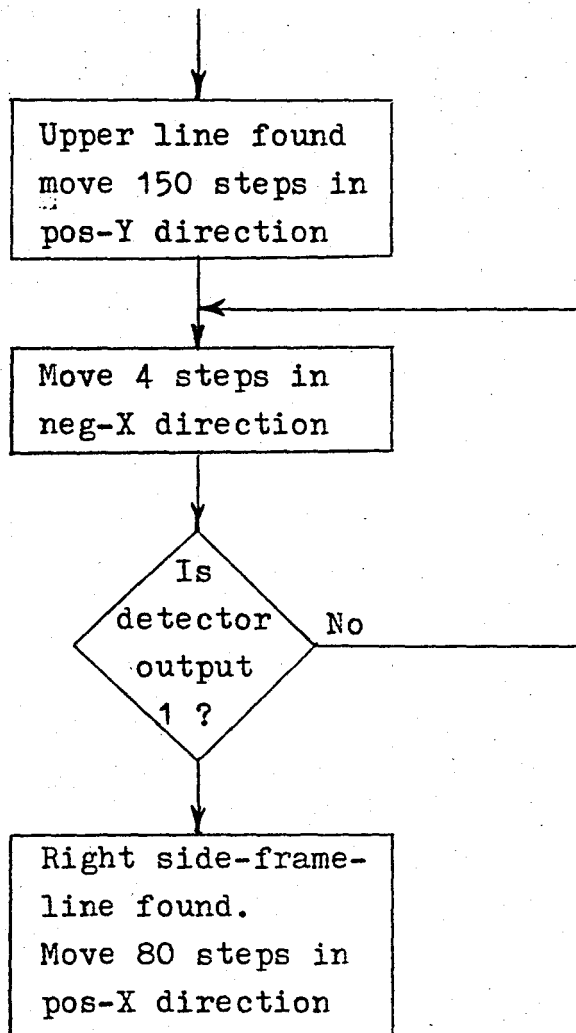
#### 1. Line Detection Program

This routine searches the frame lines and locates the detector on the top right corner of the dot mask. Program

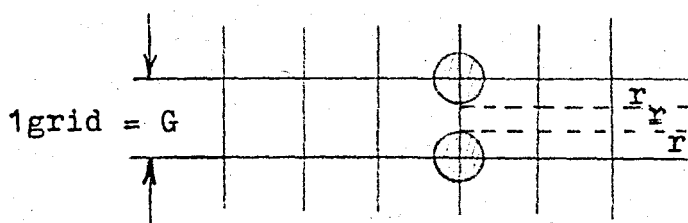
flow is shown below :



Continued in the next page



The number of steps written in the flowchart are found according to the dimension of dots and grid length i.e dots have a radius of 27 steps where each step is equal to 0.015875 mm. and the length of a grid is 80 steps. Thus, two consecutive dots have a spacing distance of 26 steps as shown in Figure 4.1 .



1 Grid=1/10 inc  
r:Radius of dot

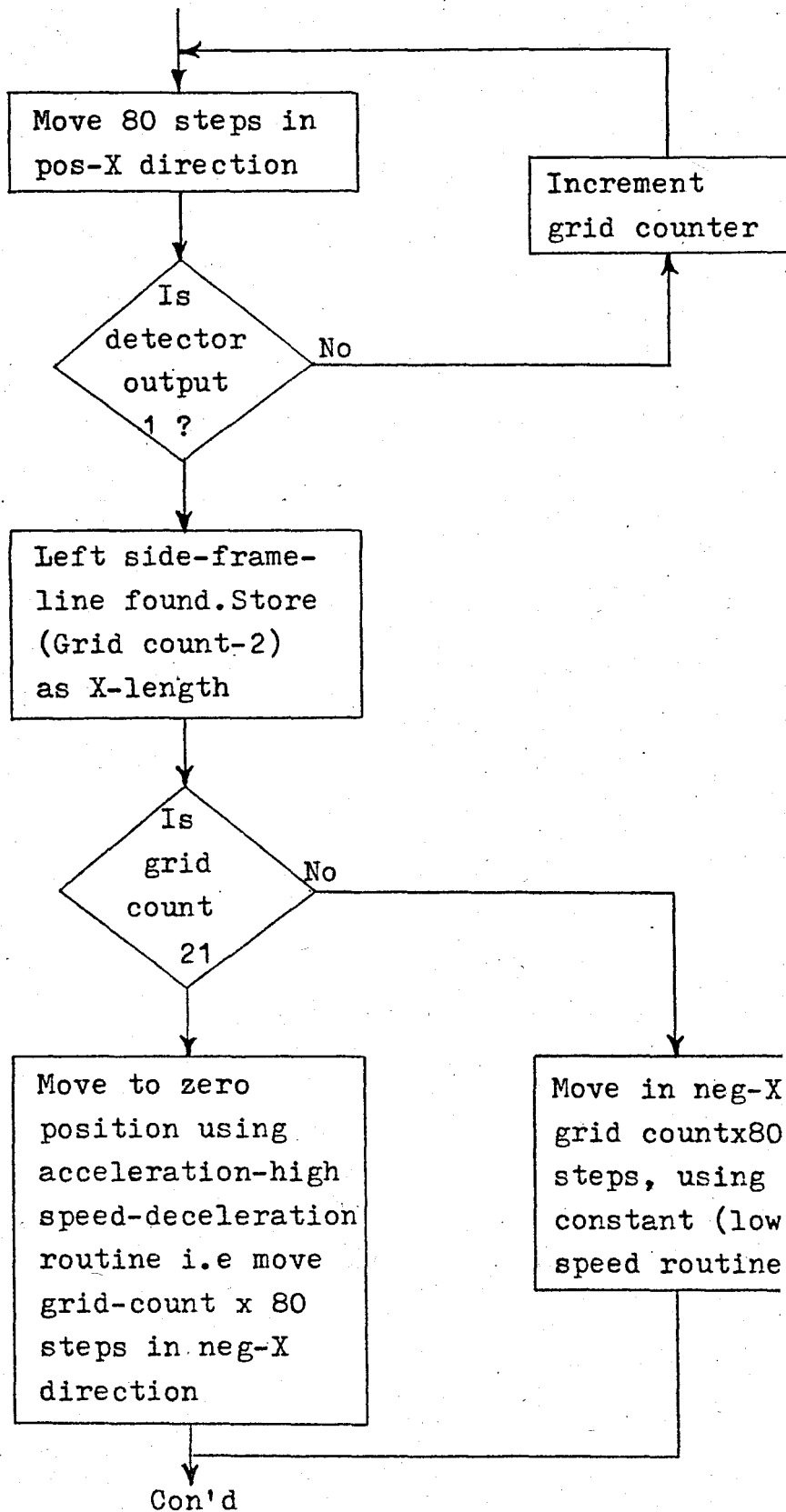
Dot dimensions

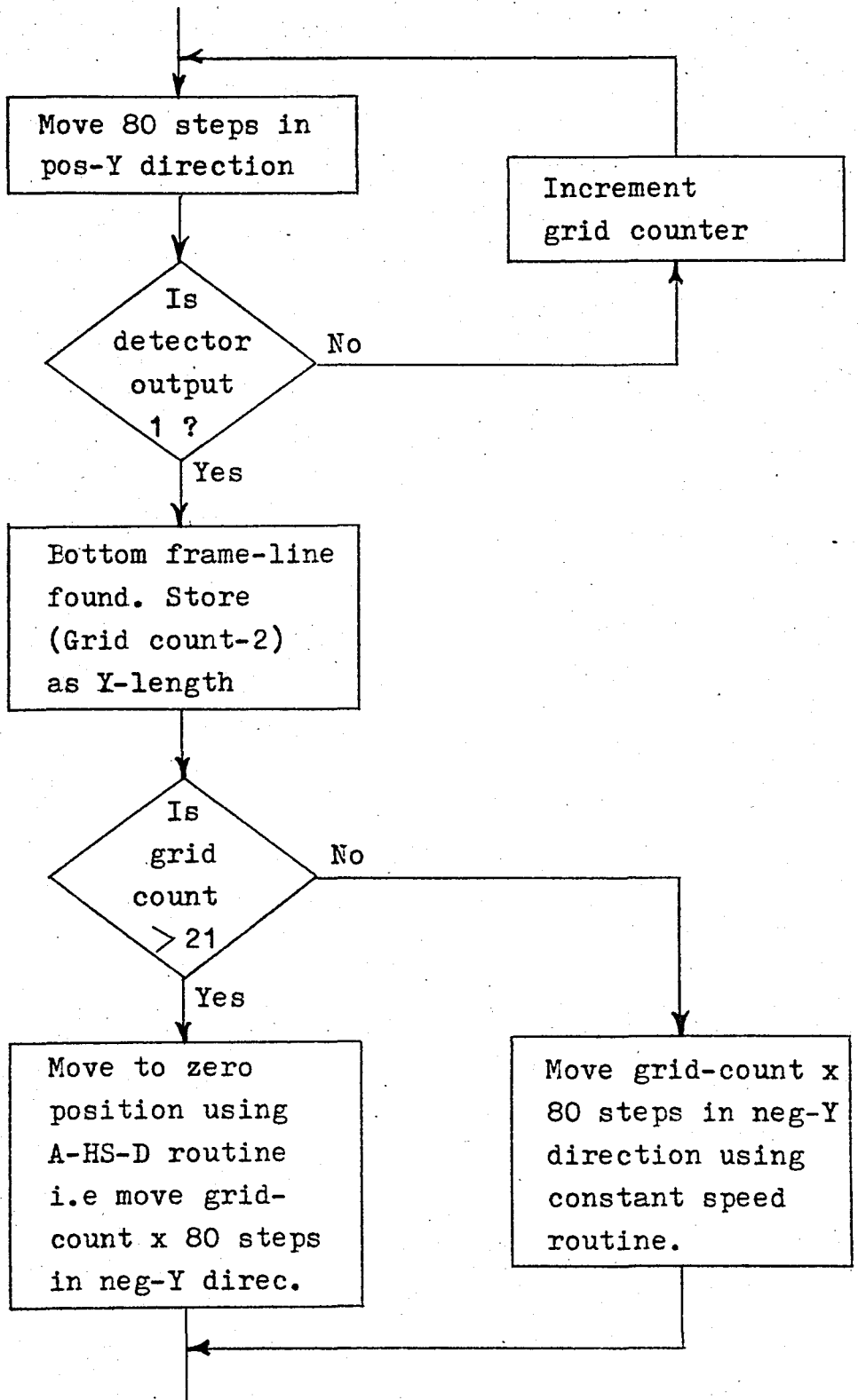
Figure 4.1



## 2. Frame Length Detection Program

This program measures the X and Y lengths of the frame of dot mask.





In this program the grid counter is compared with 21 since 11 grids are needed for acceleration and 10 for deceleration (1 grid = 80 steps).

In the flowchart A-HS-D is used to express the acceleration-high speed-deceleration routine in short.

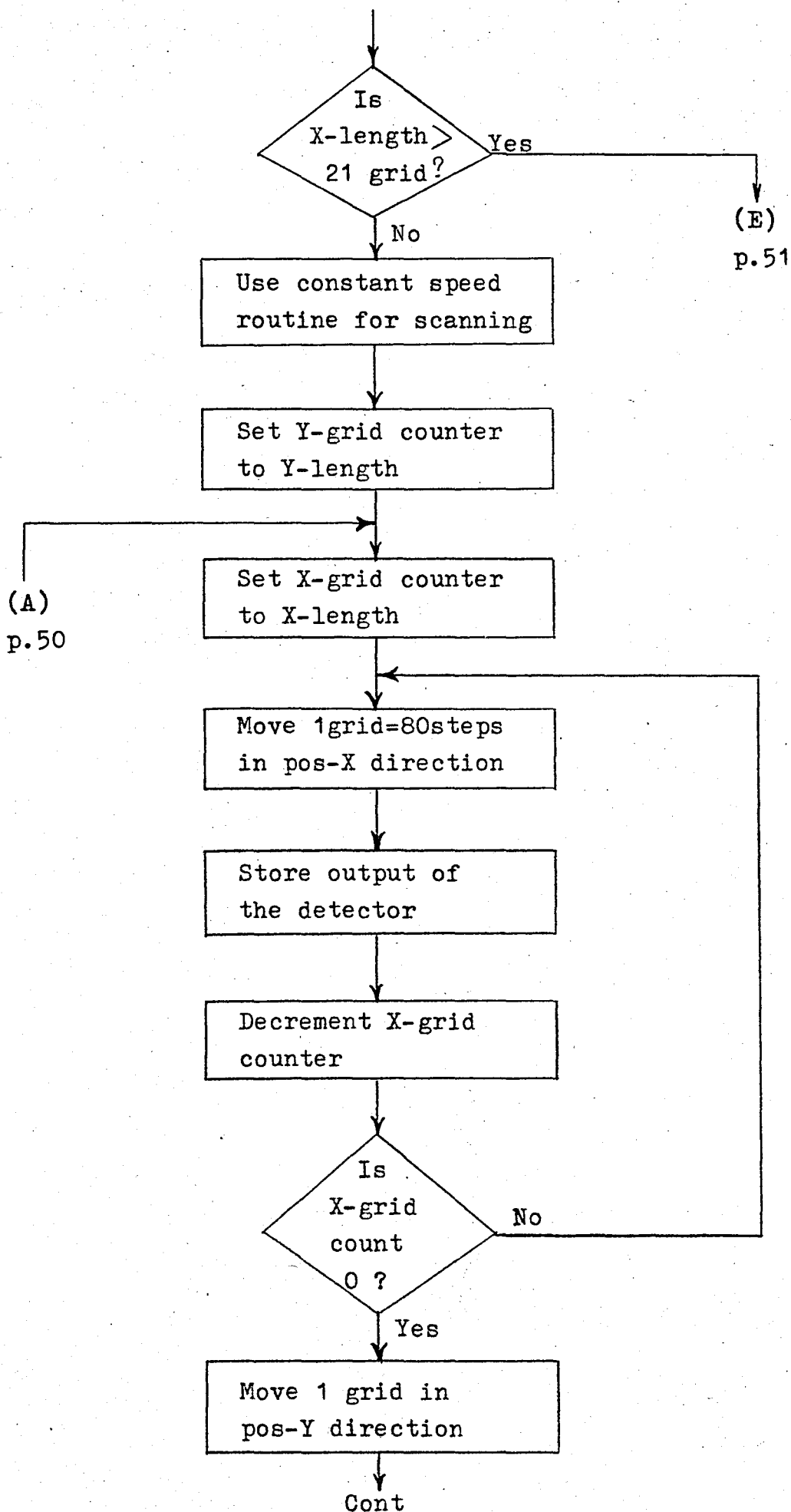
### 3. Scanning and Storing Program

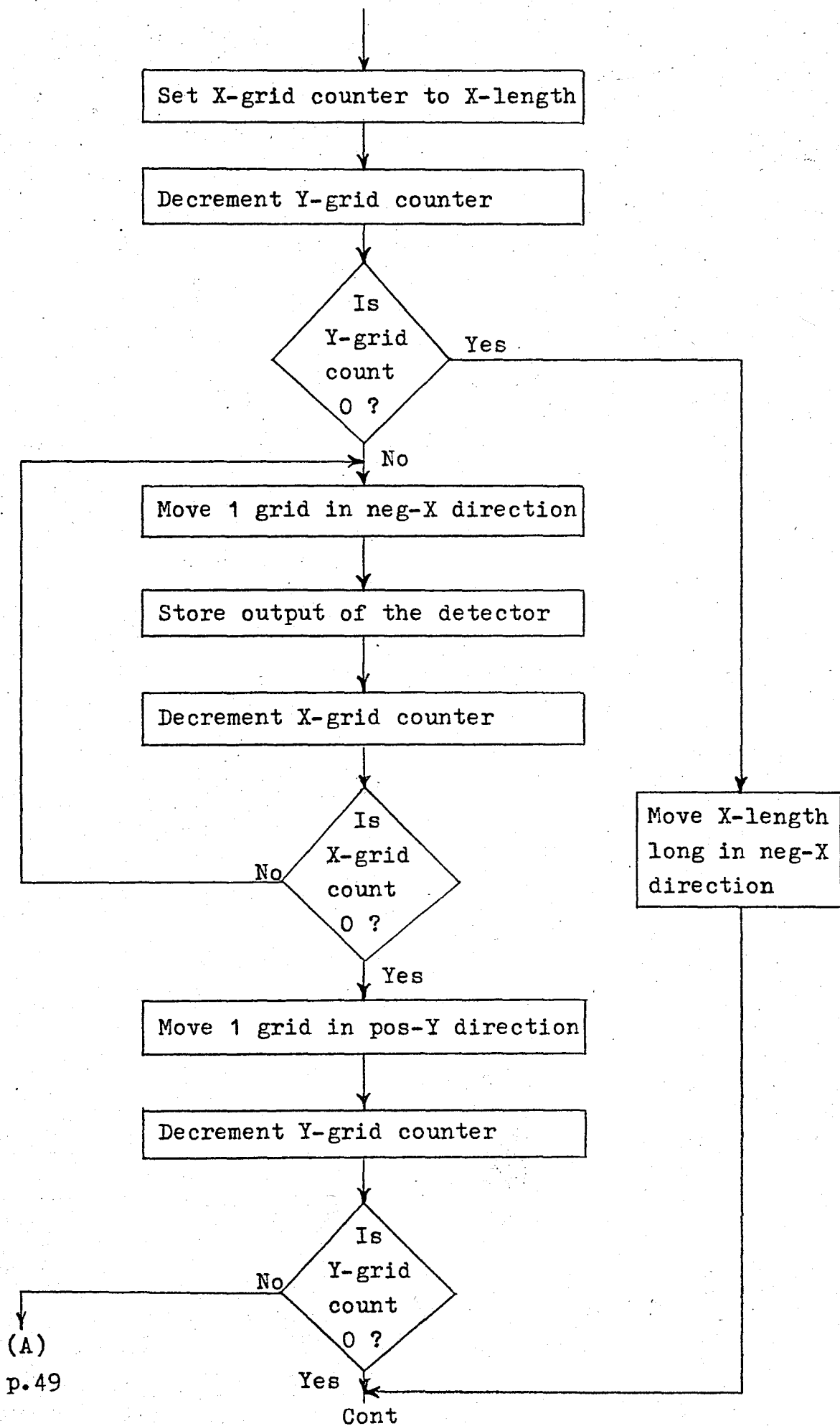
This program scans the dot mask whose dimensions are specified in the previous programs, in a meander pattern i.e odd numbered lines are scanned from right to left while even numbered lines are scanned in the opposite direction.

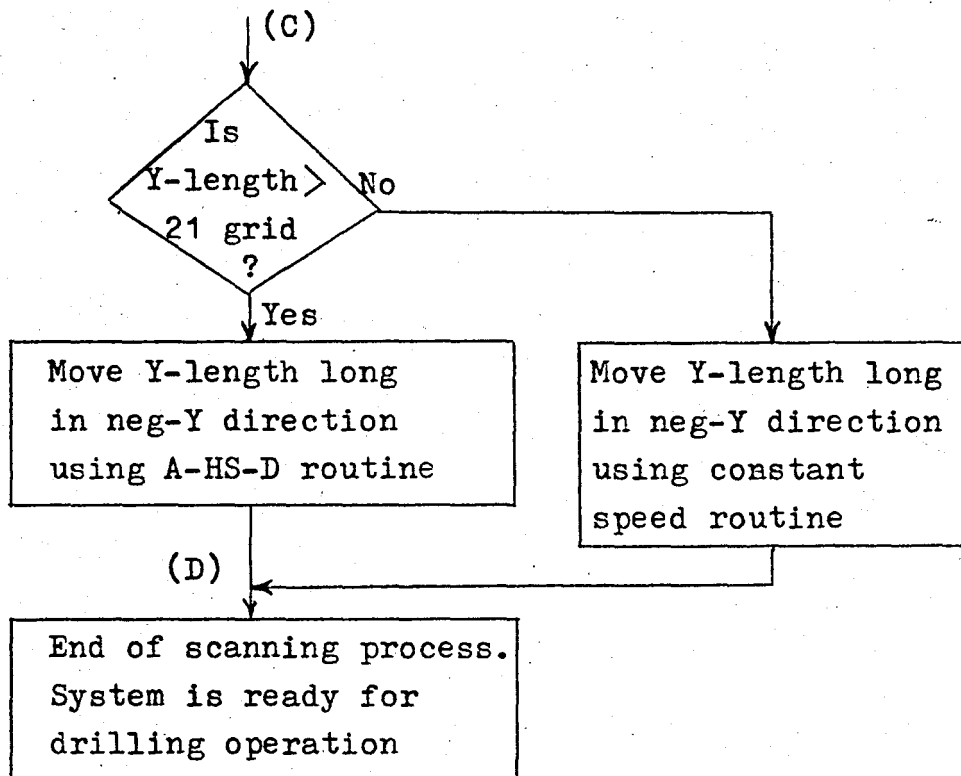
The store routine tests the output of the detector at every grid-node where spacing between two grids is 80 steps which is equal to  $1/20$  inch. Each test result (0 or 1) is stored in a temporary memory location and when 8 consecutive hole-position information is read ( i.e one byte is filled ) then this datum(byte) is stored in the memory starting from the address 8000 H.

The scan program can proceed with two different speeds. One of them is constant speed (246 steps/sec) scanning routine and the other is acceleration-high speed-deceleration routine. Those cases will be explained respectively.

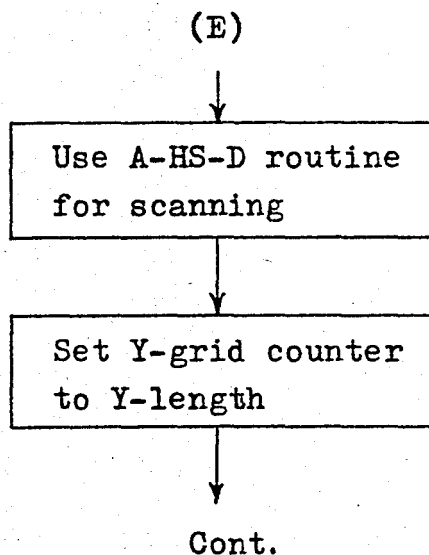
a. Constant Speed Scanning and Detection. This routine is selected if the X-length of the dot mask is equal or smaller than the distance required for acceleration, high speed and deceleration. This distance is equal to  $21/20$  inch. The flow-chart of this routine is in the following pages.

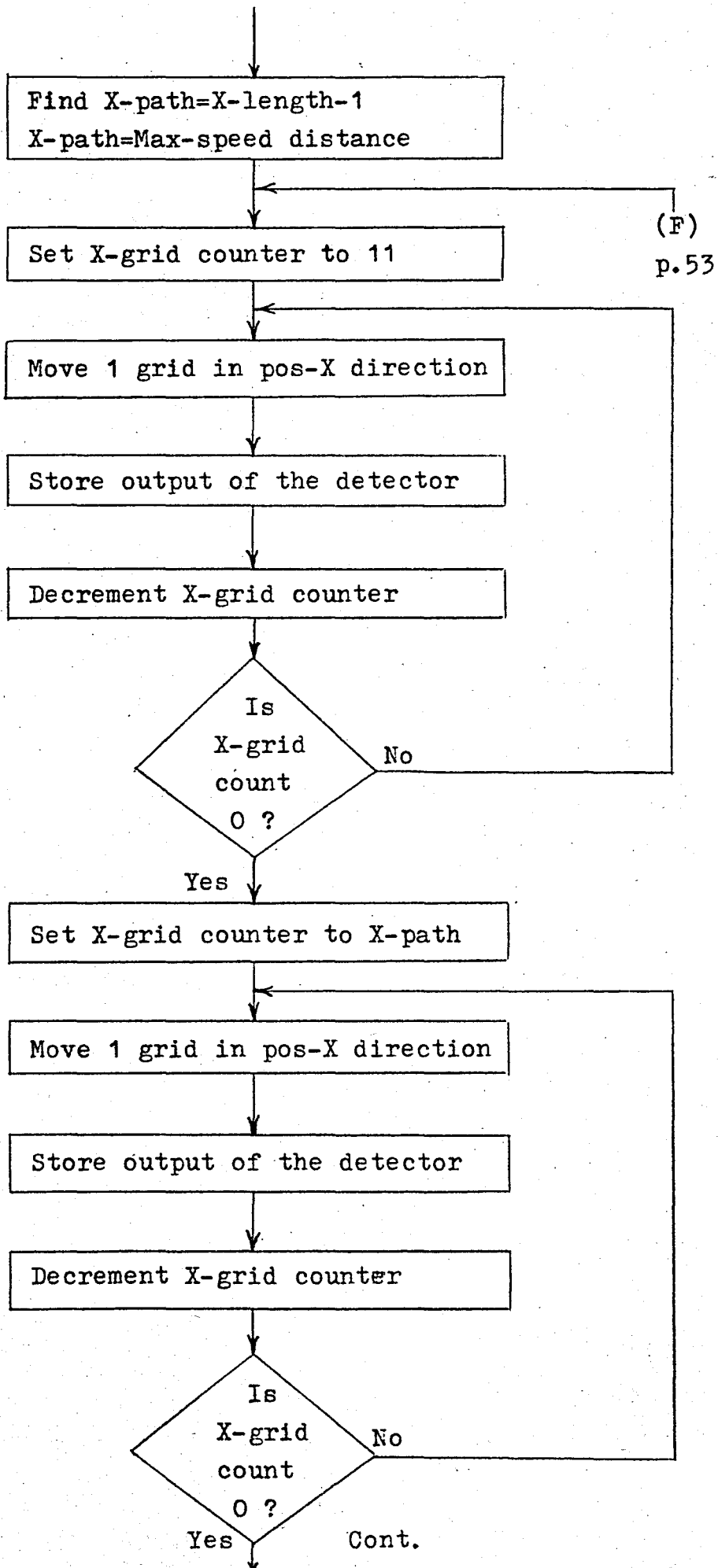


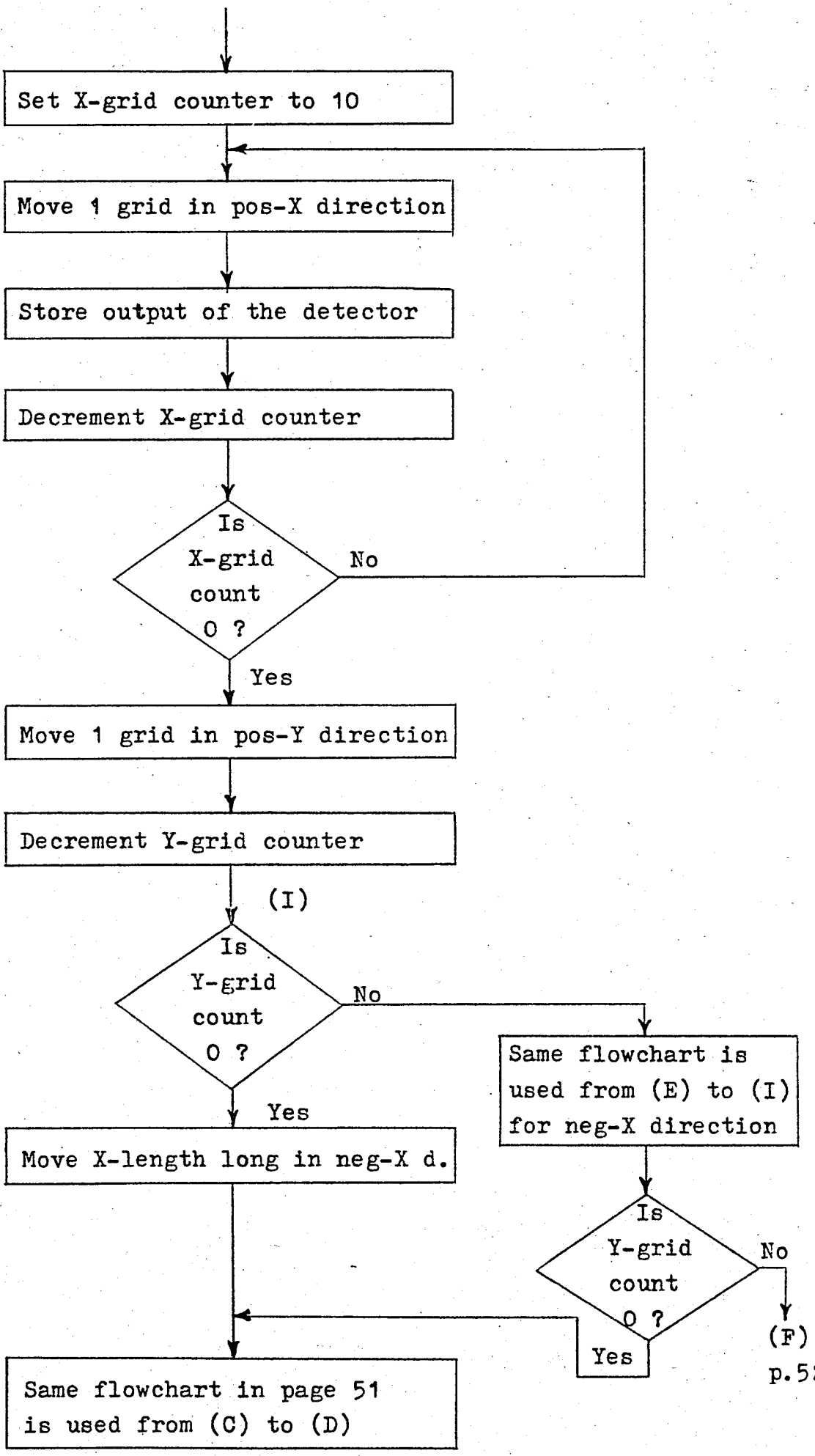




b. High Speed Scanning and Detection. When the X-length of the frame of dot mask, is greater than 21/20 inch, this routine is selected, so a better performance (i.e a shorter scanning time) is obtained due to acceleration--high speed (835 steps/sec)-deceleration profile instead of constant speed (246 steps/sec) scanning. Program flow is as follows :

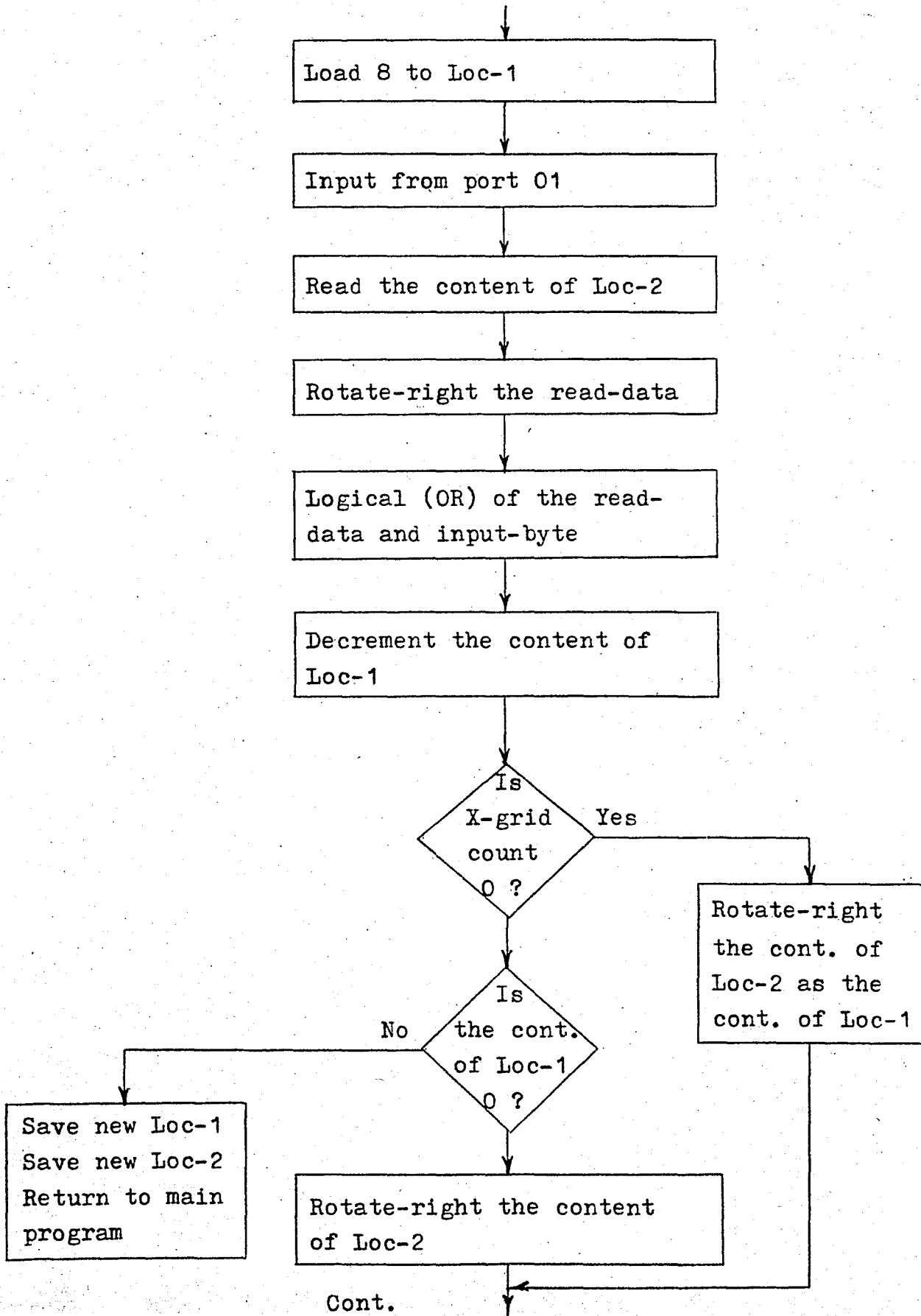


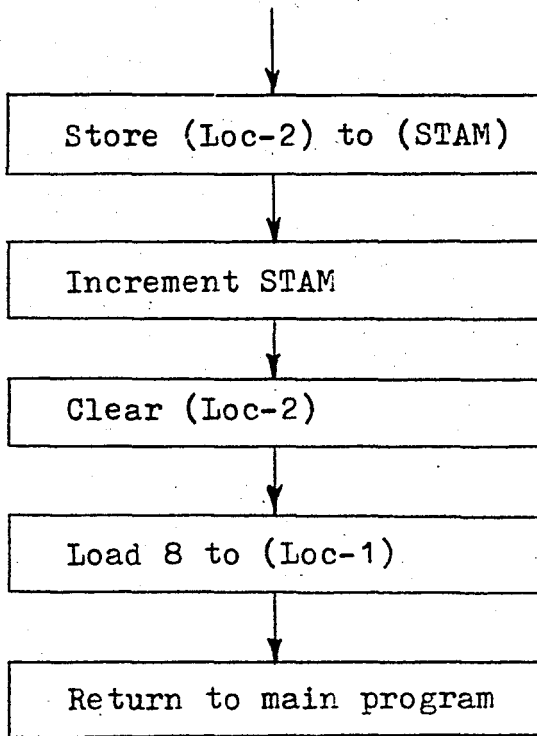






c. Store Program. By this program data which hold the drilling-hole-position information, are stored in the memory sequentially. Flowchart of the program is shown below:





Expressions used in the above flowchart are:

Loc-1 : Holds the bit count. Initially Loc-1 contains 8 and decremented at each test of the output of detector (at each grid-node ). Its content reaches zero when 8 data are taken i.e a byte of hole-position information is ready to be stored.

Loc-2 : Keeps the data till a byte of information is formed. Then that byte is stored in the memory.

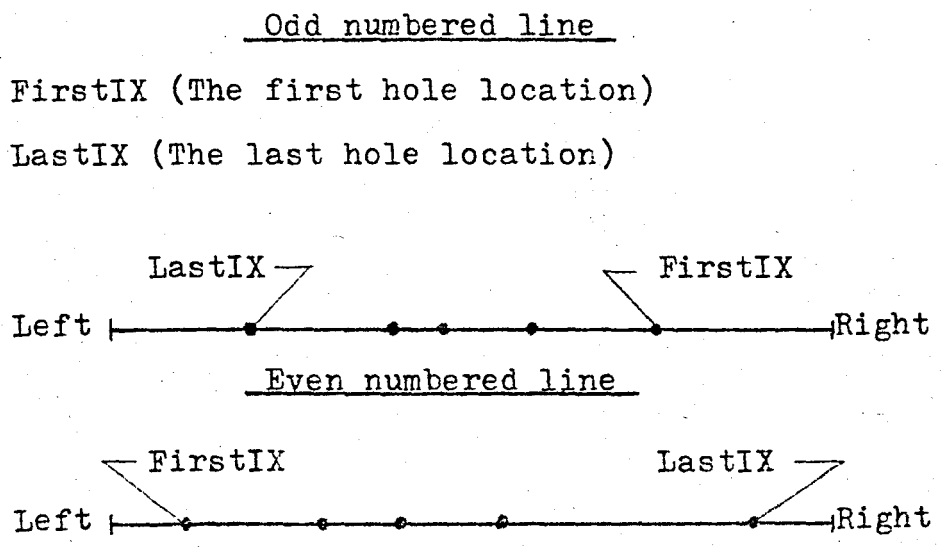
STAM : Means starting address of memory. The data (byte) in Loc-2 is stored to the memory location that STAM shows. In the beginning STAM contains 8000 H which is the first RAM location in the memory unit. STAM is incremented after each byte-store.

### B. Drilling Program

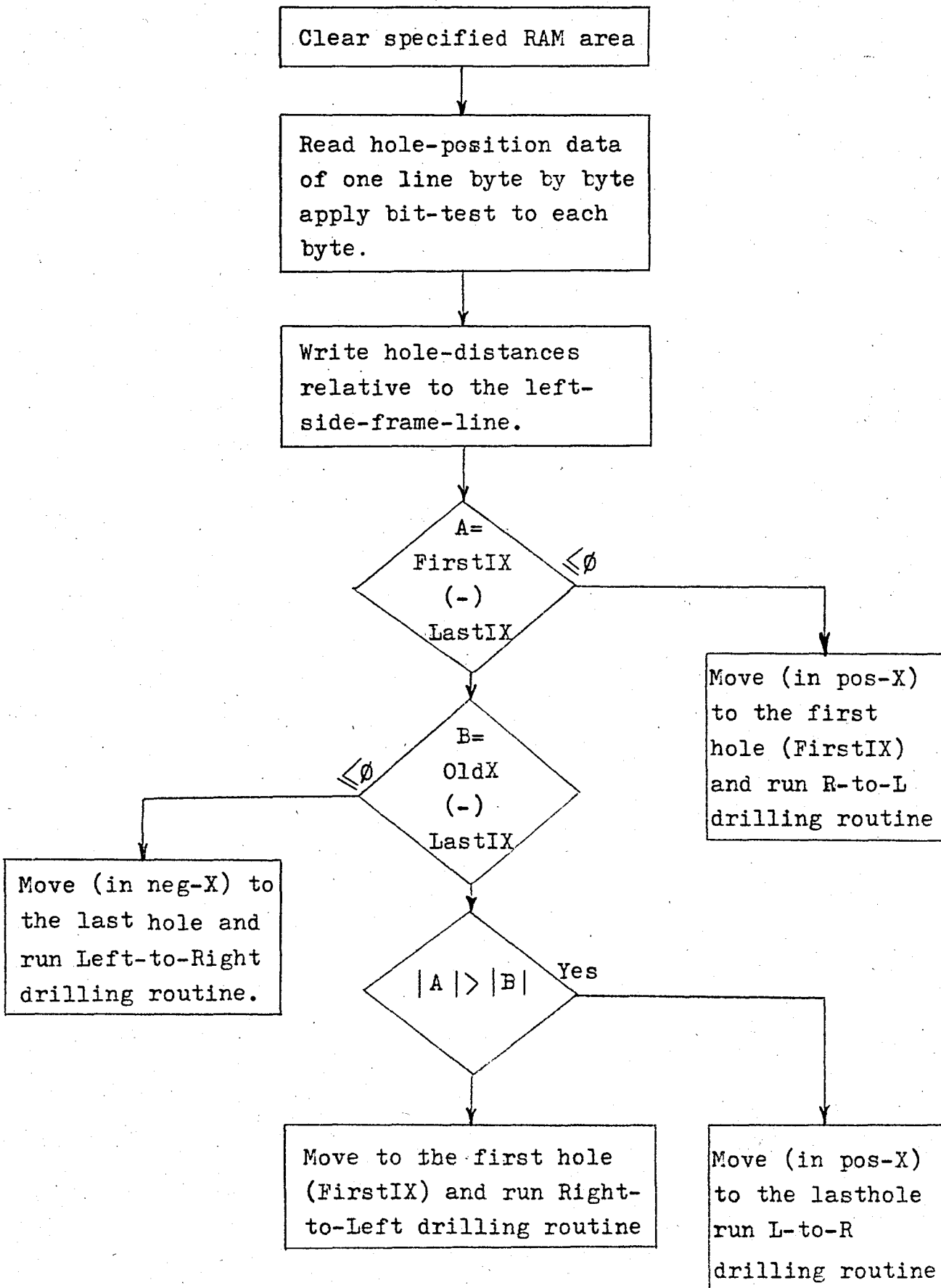
This program reads the hole-position data from the memory and drives the X-Y stage scanner to perform the drilling process. Path optimization algorithm is used to minimize the drilling procedure time.

In the program, hole-position data is read from the memory as one byte at a time and every byte is tested bit by bit. A position counter (register) is set to X-length value and it is decremented at each bit test. If the tested bit contains '1' i.e that is a hole information then the value of position counter is stored in the memory starting from the address FirstIX=8730H. Zeroes which are encountered during bit test are not taken into consideration. When position counter reaches zero then it means that, line is finished and drilling of the holes on that line can be performed.

The flowchart in the following page is written for the odd numbered lines. In the even numbered lines hole-positions are listed (stored) from left to right. This can be simply shown as follows:



Flowchart of the drilling program for the odd numbered lines:



In the drilling program, OldX contains the last location of the X-motor. Locations of the holes are specified according to the distance from the left-frame-line i.e hole-position numbers increase from left to right.

After the execution of one line, the next line data are tested. If there is no data in any line then stage moves one grid (80 steps) in the positive-Y direction.

The movement of the stage from one hole position to another is performed due to calculation of relative distance between two subsequent hole-positions. If the distance between two hole-positions is greater than 21 grids then acceleration-maximum speed-deceleration routine is run otherwise the X-Y stage scanner moves with constant speed.

At the end of drilling program, return routine takes place and moves the X-Y table to its original zero position for another drilling operation.

### C. Subprograms

#### 1. Reset Routine

This subroutine :

- a. Sets the stack pointer to 87E5 H
- b. Chooses interrupt mode 2
- c. Loads (I) interrupt page address register with 07
- d. Programs A-port of PIO as output port and,  
B-port of PIO as input port

Reset Routine

0000	31 E5 87	LD SP, 87E5 H
0003	ED 5E	IM 2
0005	3E 07	LD A, 07
0007	ED 47	LD I, A
0009	3E 0F	LD A, 0F H
000B	D3 02	OUT (02), A
000D	3E 4F	LD A, 4F H
000F	D3 03	OUT (03), A
0011	AF	XOR A
0012	D3 00	OUT (00), A
0014	FB	EI
0015	76	HALT

Table 4.1

## 2. Interrupt Service Routine

Control of the X-Y stage scanner is provided by this routine. Start switch starts the scanning and then the drilling programs. The other four switches (pos-X, neg-X, pos-Y, neg-Y) are used to move the X-Y table in both X and Y directions. Stop switch is used to break the above mentioned programs when they are running.

This routine utilizes the interrupt feature of Z-80 microprocessor. The Z-80 CPU is so operated that an indirect call to any memory location can be achieved in response to an interrupt. For this purpose the I register is loaded with 07 which is the high order 8-bits of the indirect address. The

lower 8-bits of the address are provided by the interrupting switch.

Interrupt Service Routine Starting Addresses

Start Switch	07BE : 1F
	07BF : 00
Stop Switch	07DE : 25
	07DF : 07
Pos-X Switch	07FC : 00
	07FD : 07
Neg-X Switch	07FA : 40
	07FB : 07
Pos-Y Switch	07F6 : 65
	07F7 : 07
Neg-Y Switch	07EE : D0
	07EF : 06

Table 4.2

### 3. Acceleration and Deceleration Subroutines

In the second section, driving conditions are examined for stepper motors. The necessary pulse sequences are supplied from the microprocessor card and the look-up table for bit patterns (shown in Table 4.3) is created in the memory. Since stepper motors cannot start at high speeds, they are driven at low speed in the beginning and speed is increased step by step, changing the delays between pulse-patterns. For the above mentioned reasons, a specific distance is needed to accelerate and decelerate, which is 11 grids for acceleration and 10 grids for deceleration (1Grid=80steps). In the prototype, by changing delay constants, speed is changed from 238 steps/sec to 791 steps/sec in 11 stages.

Stepper Look-up Table

<u>Memory Address</u>	<u>Bit Pattern</u>	
Ø7AØ H	ØA H	
Ø7A1 H	Ø9 H	
Ø7A2 H	Ø5 H	X-MOTOR
Ø7A3 H	Ø6 H	
-----		
Ø7BØ H	AØ H	
Ø7B1 H	9Ø H	Y-MOTOR
Ø7B2 H	5Ø H	
Ø7B3 H	6Ø H	

Table 4.3



These bit patterns (shown in Table 4.3) are sent to drivers through PIO unit. For clockwise rotation, bit patterns are in the form of A, 9, 5, 6 and opposite order for the counterclockwise rotation.

#### 4. Constant Speed Subroutines

These routines are used almost in all programs. They provide constant delay between pulse patterns to be sent to stepper motor drivers. Motors obtain a speed of 246 steps/sec by these routines, and a register of the processor is used as the step counter. At every 80 step routine repeats itself.

#### 5. Delay Subroutines

In all programs those routines are used either in constant form or in variable form.

For the stepper motor's pulse sequence, a delay of 8017 T-cycles long, is used between two consecutive pulses. Where, every T-cycle takes 0.5 microsecond due to 2 MHz clock frequency.

For the variable delay, a constant, in the delay routine, is changed. This kind of delay is used in the acceleration-maximum speed-deceleration routine to provide different speeds.

## Line Detection

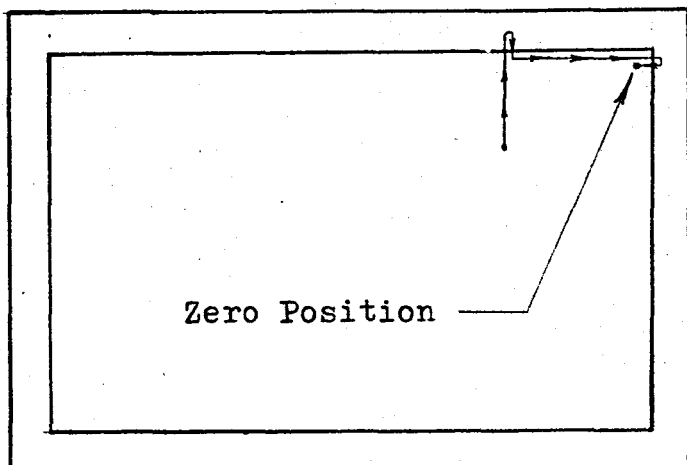


Figure 4.2

## Frame Detection

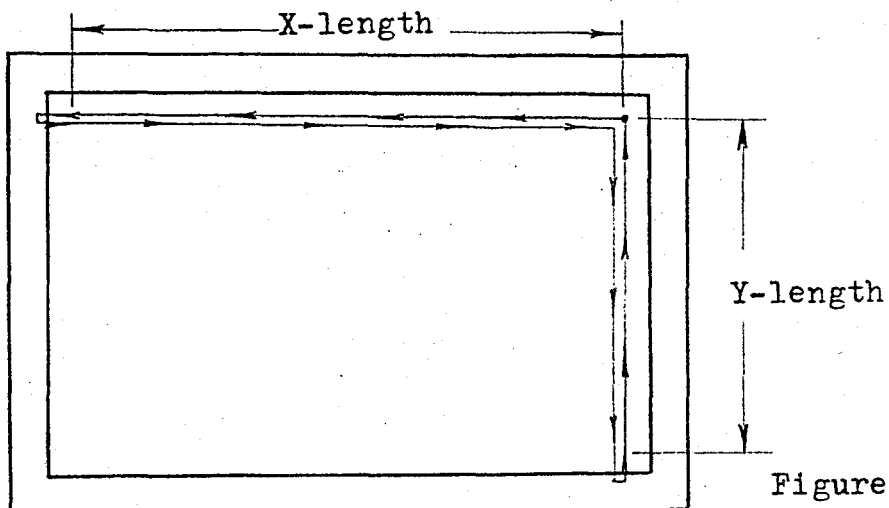


Figure 4.3

## Scanning (Meander Pattern)

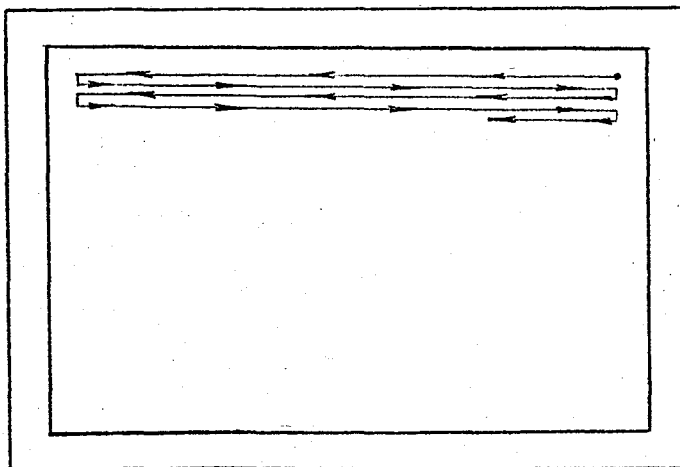


Figure 4.4

## V . CONCLUSION

Presently the automation has led to the improvement in production processes, thereby needing minimum manpower. The advantages are, that the whole process once set up, can be executed repeatedly at higher speeds than is possible with an operator, mechanically doing the settings.

During the realization of the prototype, some problems were encountered but all of them were eliminated, for instance, for the mechanical assembly the most important thing was the backlash of the system, which was eliminated by a great deal of precision on the part of the mechanic. Also, in the same case certain methods to prevent backlash ( e.g spring system, adjustable nut) could be utilized. Keeping in mind that it was better if the bearings at each end of the lead-screws were of the type that can move in their housing freely, bearings of such a nature could have been used. In addition to these, the alignment of the mechanical assembly had to have some adjustment points to provide smooth movement. In the developed system this was solved by the expertise of the mechanic.

The other important thing was the selection of stepper motors. Since , prior to this selection it was not known how much torque, a mechanical assembly would need, the steppers were chosen from powerful series which generally have low speed, high torque characteristics. This aspect resulted in success by means of the designed drive circuitry.

The designed system shows an effective use of micro-processors in the industrial field. The objective was to

realize a system that needs minimum interaction of the user and to give accurate results. The system performance provides the above mentioned properties. The user can design his/her circuits freely and also due to system resolution, it can fit the mask pattern. The scan time, though, could be reduced considerably if motors of high speed (motors with a speed of upto 4000 steps/sec, rather than the ones used with a speed of 835 steps/sec) more suitable, were selected. The scanning process for a Eurocard takes about 17 minutes, which is considerably short a time due to the right and efficient usage of the software. By using the optimum path concept, this reduction in time is achieved.

The system can work as a drilling machine with some mechanical modifications such as the detector, the lamp and the glass plate can be replaced by a drill set to perform the drilling operation.

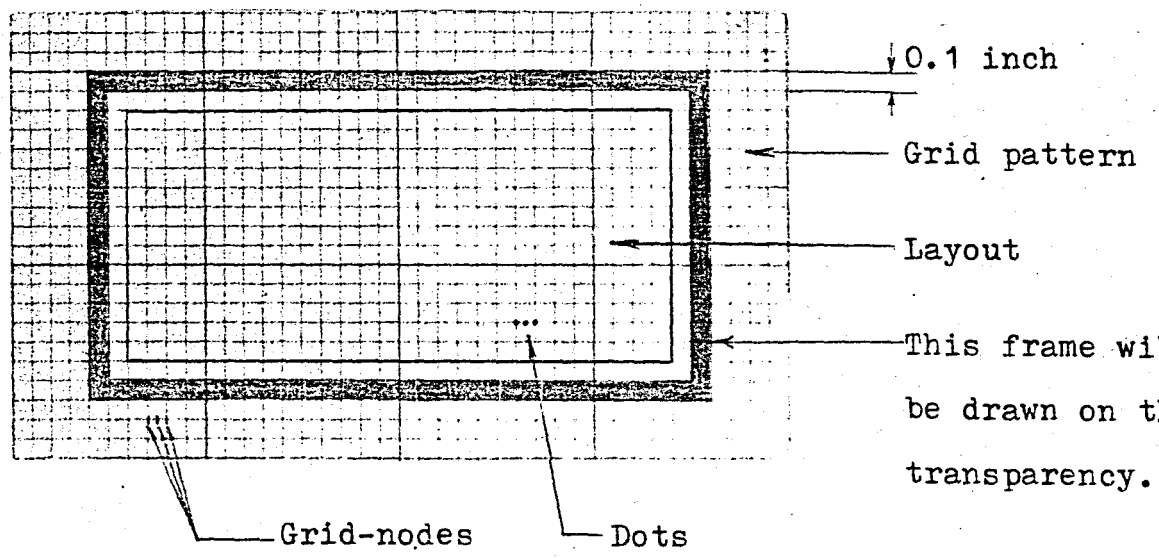
## A P P E N D I C E S

# APPENDIX A

## OPERATING INSTRUCTIONS

### 1. How to Prepare The Dot Mask

i. After the printed circuit layout is drawn, it is placed on a paper which has 0.1 inch divisions (as shown below fig.). On these two, the clean transparency is located.



ii. The frame lines of the dot mask are drawn such that every side of the mask frame is 0.1 inch greater than the frame of the layout. Frame-line thickness of 0.1 inch is considered to be enough and it is advisable to use a drawing-pen with black ink (e.g Rapido 0.5 mm).

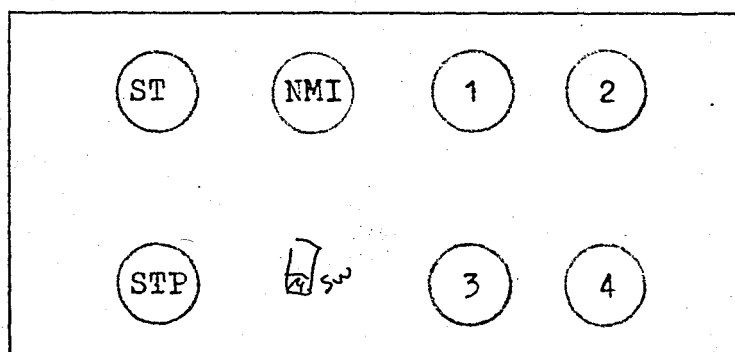
iii. Hole positions are marked on the transparency by locating them at the nodes of the grid pattern. One more hole can be marked between each node of the grid pattern shown in the previous page, because the scanning resolution of the system is  $1/20$  inch.

If there are any hole positions on the layout which do not coincide with the nodes of the grid pattern, they should be placed on to the closest node.

After the dot-mask is prepared, it is correctly placed onto the glass plate, matching the upper right corner of the dot-mask frame to the right-angled marker on the glass.

## 2. Running The System

i. System is switched on. Power on-reset runs the reset program and Halt LED is turned on at the end of this program. Then using the manuel control switches, the detector is placed somewhere in the dot-mask frame ( i.e X-Y table is positioned in such a way that Detector points somewhere in the dot-mask frame).



Control Panel

The functions of the buttons are as follows:

Button ST : START

Button STP : STOP

Button NMI : Emergency stop

Button 1 : X-Motor control (stage moves in neg-X direction)

Button 2 : X-Motor control (stage moves in pos-X direction)

Button 3 : Y-Motor control (stage moves in pos-Y direction)

Button 4 : Y-Motor control (stage moves in neg-Y direction)

ii. Pressing the ST (Start) button starts the scanning and detection program and at the end, stage takes its original zero position (at the upper right corner) and HALT LED turns on.

iii. Now ST button commences the drilling program. At each drilling-hole-position, stage stops, a LED flashes for a few seconds to simulate the drilling operation.

iv. After completing the drilling process of all holes, stage moves to zero-position and stops. Drilling process can be repeated as desired by pressing the ST button.

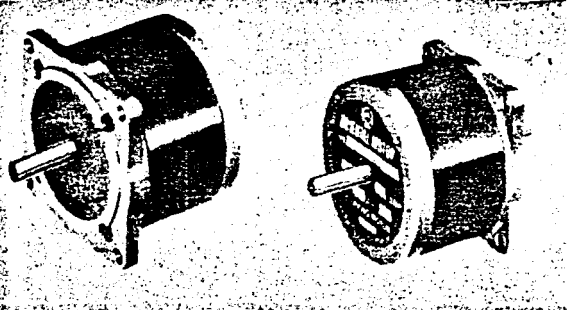
v. For a new dot-mask-scanning process, RST (Reset) must be given to the system, then same order (from ii to iv) is followed.

In case of emergency, NMI button should be pressed.



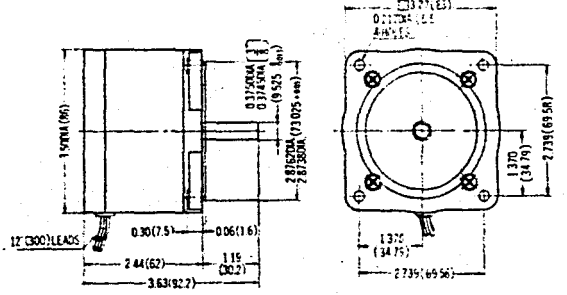
# 1.8° STEP ANGLE HYBRID TYPE

# PH296-□□

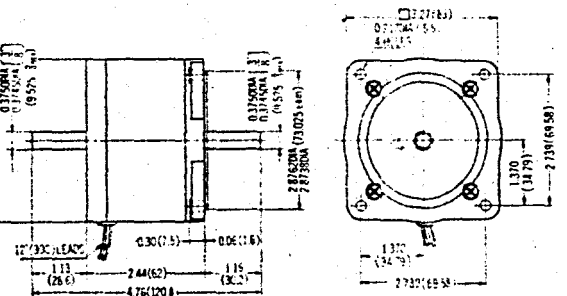


## DIMENSIONS

### Single Shaft

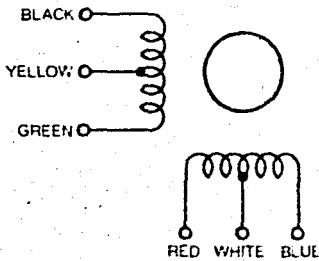


### Double Shaft

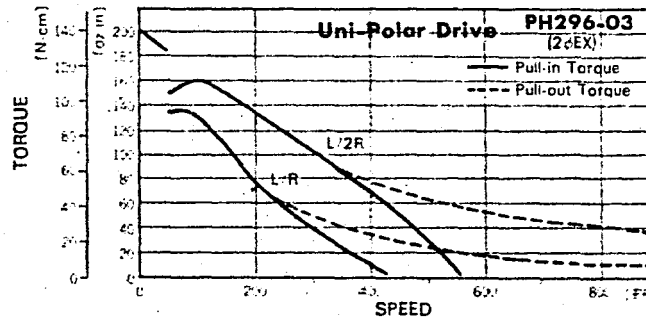
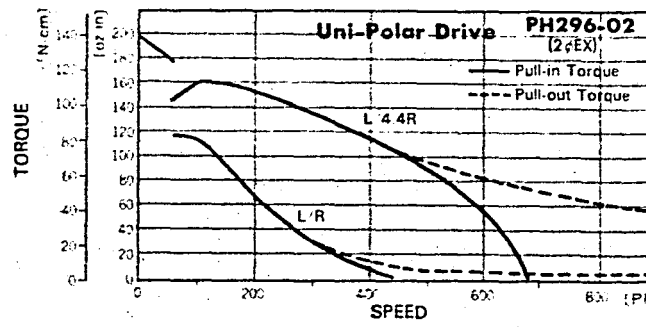
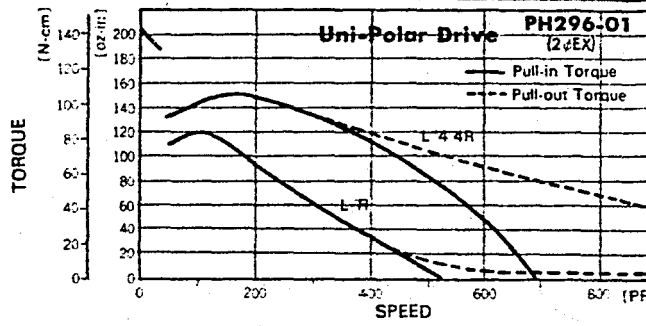


scale 1:4, unit=inch (mm)

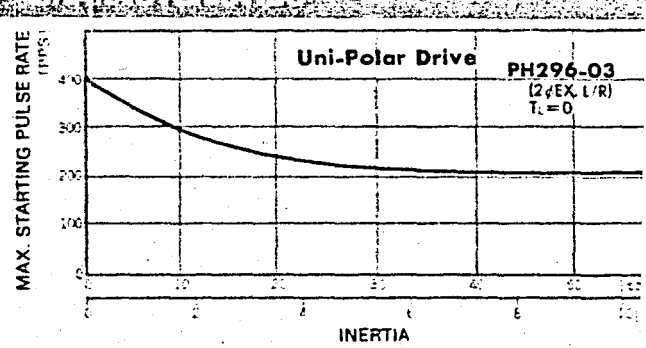
## COLORS OF LEAD WIRES



## SPEED VS. TORQUE CHARACTERISTICS



## INERTIA VS. STARTING PULSE RATE CHARACTERISTICS

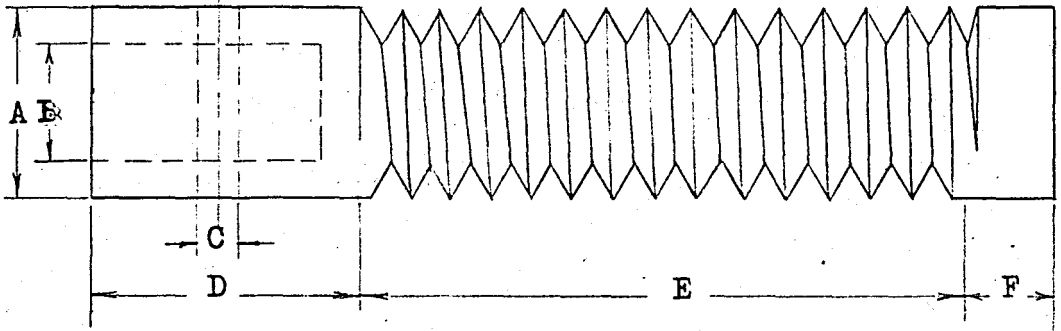


## SPECIFICATIONS (2-phase full-step)

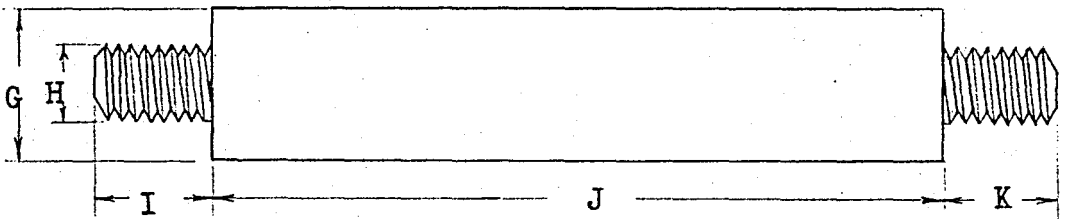
Motor type		Voltage V	Current per phase A/phase	Holding Torque		Resistance per phase ohm/phase	Induct per phase mH/p
Single Shaft	Double Shaft			oz-in	N-cm		
PH296-01	PH296-01B	1.8	4.5	174	123	0.4	1.4
PH296-02	PH296-02B	5.5	1.25	174	123	4.4	14
PH296-03	PH296-03B	14	0.7	174	123	20	60

Rotor inertia 3.1 oz-in<sup>2</sup> (560g-cm<sup>2</sup>) • Weight 3.3lbs (1.5 kg)

## APPENDIX C

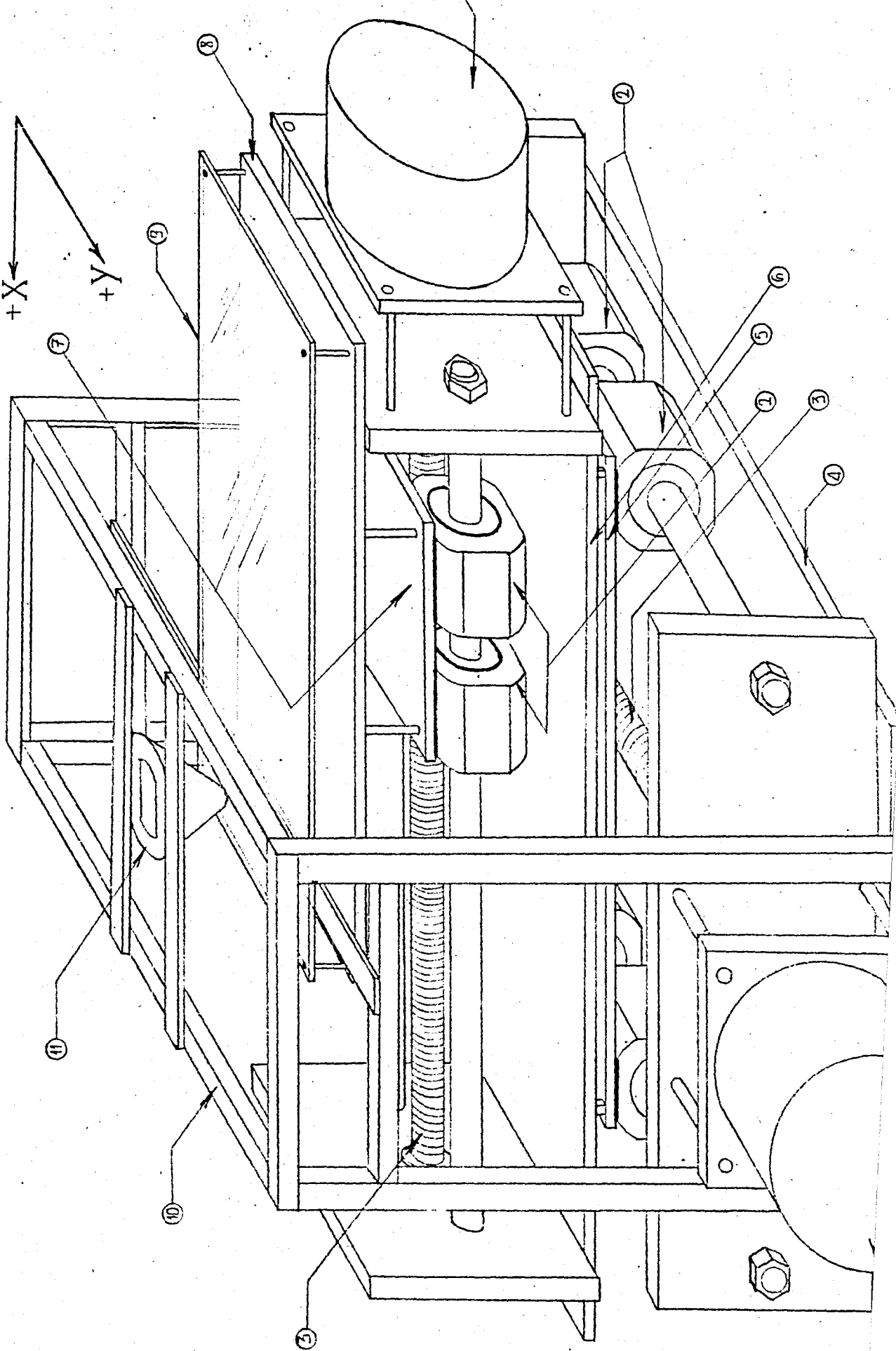
LEAD-SCREW

	A	B	C	D	E	F
X-Table	16	95	3	35	370	10
Y-Table	16	95	3	35	290	10

Cylindrical Shaft

	G	H	I	J	K
X-Table	16	10	15	370	15
Y-Table	16	10	15	290	15

- i. Drawings are not to scale.
- ii. All dimensions are in millimeters.



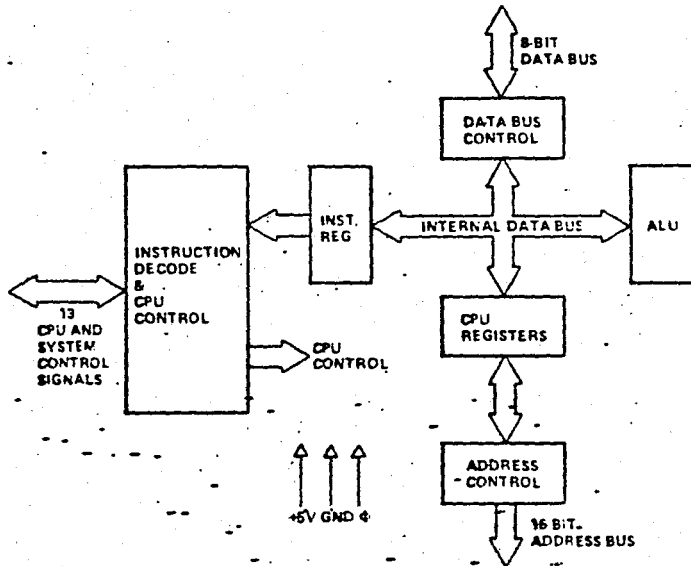
Part List of X-Y Stage Scanner

1. Stepper motors
2. Linear motion bearings
3. Lead-screws
4. Base plate
5. Intermediate Y-plate
6. Y-plate
7. Intermediate X-plate
8. X-plate
9. Glass plate
10. Support for lamp and photo-detector
11. Photo-detector system

## APPENDIX D

### Z-80 CPU ARCHITECTURE

A block diagram of the internal architecture of the Z-80 CPU is shown in figure 2.0-1. The diagram shows all of the major elements in the CPU and it should be referred to throughout the following description.



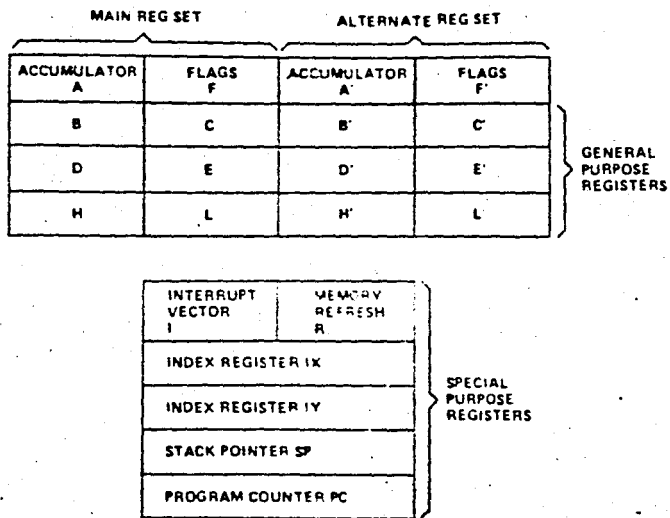
Z-80 CPU BLOCK DIAGRAM  
FIGURE 2.0-1

### CPU REGISTERS

The Z-80 CPU contains 208 bits of R/W memory that are accessible to the programmer. Figure 2.0-2 illustrates how this memory is configured into eighteen 8-bit registers and four 16-bit registers. All Z-80 registers are implemented using static RAM. The registers include two sets of six general purpose registers that may be used individually as 8-bit registers or in pairs as 16-bit registers. There are also two sets of accumulator and flag registers.

#### Special Purpose Registers

1. **Program Counter (PC).** The program counter holds the 16-bit address of the current instruction being fetched from memory. The PC is automatically incremented after its contents have been transferred to the address lines. When a program jump occurs the new value is automatically placed in the PC, overriding the incrementer.
2. **Stack Pointer (SP).** The stack pointer holds the 16-bit address of the current top of a stack located anywhere in external system RAM memory. The external stack memory is organized as a last-in first-out (LIFO) file. Data can be pushed onto the stack from specific CPU registers or popped off of the stack into specific CPU registers through the execution of PUSH and POP instructions. The data popped from the stack is always the last data pushed onto it. The stack allows simple implementation of multiple level interrupts, unlimited subroutine nesting and simplification of many types of data manipulation.



**Z-80 CPU REGISTER CONFIGURATION**  
**FIGURE 2.0-2**

3. **Two Index Registers (IX & IY).** The two independent index registers hold a 16-bit base address that is used in indexed addressing modes. In this mode, an index register is used as a base to point to a region in memory from which data is to be stored or retrieved. An additional byte is included in indexed instructions to specify a displacement from this base. This displacement is specified as a two's complement signed integer. This mode of addressing greatly simplifies many types of programs, especially where tables of data are used.
4. **Interrupt Page Address Register (I).** The Z-80 CPU can be operated in a mode where an indirect call to any memory location can be achieved in response to an interrupt. The I Register is used for this purpose to store the high order 8-bits of the indirect address while the interrupting device provides the lower 8-bits of the address. This feature allows interrupt routines to be dynamically located anywhere in memory with absolute minimal access time to the routine.
5. **Memory Refresh Register (R).** The Z-80 CPU contains a memory refresh counter to enable dynamic memories to be used with the same ease as static memories. Seven bits of this 8 bit register are automatically incremented after each instruction fetch. The eighth bit will remain as programmed as the result of an LD R, A instruction. The data in the refresh counter is sent out on the lower portion of the address bus along with a refresh control signal while the CPU is decoding and executing the fetched instruction. This mode of refresh is totally transparent to the programmer and does not slow down the CPU operation. The programmer can load the R register for testing purposes, but this register is normally not used by the programmer. During refresh, the contents of the I register are placed on the upper 8 bits of the address bus.

#### Accumulator and Flag Registers

The CPU includes two independent 8-bit accumulators and associated 8-bit flag registers. The accumulator holds the results of 8-bit arithmetic or logical operations while the flag register indicates specific conditions for 8 or 16-bit operations, such as indicating whether or not the result of an operation is equal to zero. The programmer selects the accumulator and flag pair that he wishes to work with with a single exchange instruction so that he may easily work with either pair.

### General Purpose Registers

There are two matched sets of general purpose registers, each set containing six 8-bit registers that may be used individually as 8-bit registers or as 16-bit register pairs by the programmer. One set is called BC, DE and HL while the complementary set is called BC', DE' and HL'. At any one time the programmer can select either set of registers to work with through a single exchange command for the entire set. In systems where fast interrupt response is required, one set of general purpose registers and an accumulator/flag register may be reserved for handling this very fast routine. Only a simple exchange commands need be executed to go between the routines. This greatly reduces interrupt service time by eliminating the requirement for saving and retrieving register contents in the external stack during interrupt or subroutine processing. These general purpose registers are used for a wide range of applications by the programmer. They also simplify programming, especially in ROM based systems where little external read/write memory is available.

### ARITHMETIC & LOGIC UNIT (ALU)

The 8-bit arithmetic and logical instructions of the CPU are executed in the ALU. Internally the ALU communicates with the registers and the external data bus or the internal data bus. The type of functions performed by the ALU include:

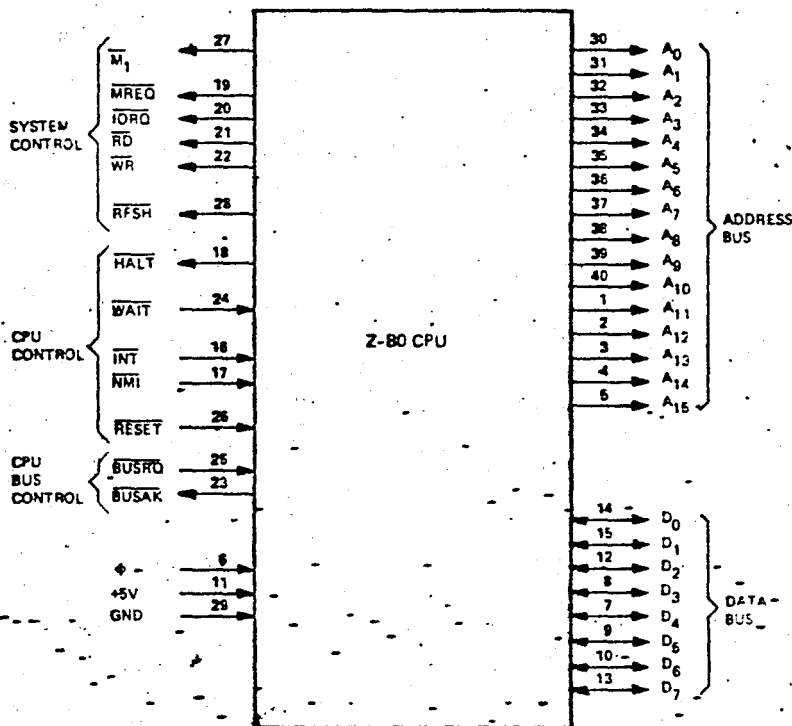
Add	Left or right shifts or rotates (arithmetic and logical)
Subtract	Increment
Logical AND	Decrement
Logical OR	Set bit
Logical Exclusive OR	Reset bit
Compare	Test bit

### INSTRUCTION REGISTER AND CPU CONTROL

As each instruction is fetched from memory it is placed in the instruction register and decoded. The control sections performs this function and then generates and supplies all of the control signals necessary to read or write data from or to the registers, control the ALU and provide all required external control signals.

## Z-80 CPU PIN DESCRIPTION

The Z-80 CPU is packaged in an industry standard 40 pin Dual In-Line Package. The I/O pins are shown in figure 3.0-1 and the function of each is described below.



Z-80 PIN CONFIGURATION  
FIGURE 3.0-1

$A_0$ - $A_{15}$   
(Address Bus)

Tri-state output, active high.  $A_0$ - $A_{15}$  constitute a 16-bit address bus. The address bus provides the address for memory (up to 64K bytes) data exchanges and for I/O device data exchanges. I/O addressing uses the 8 lower address bits to allow the user to directly select up to 256 input or 256 output ports.  $A_0$  is the least significant address bit. During refresh time, the lower 7 bits contain a valid refresh address.

$D_0$ - $D_7$   
(Data Bus)

Tri-state input/output, active high.  $D_0$ - $D_7$  constitute an 8-bit bidirectional data bus. The data bus is used for data exchanges with memory and I/O devices.

$\overline{M}_1$   
(Machine Cycle one)

Output, active low.  $\overline{M}_1$  indicates that the current machine cycle is the OP code fetch cycle of an instruction execution. Note that during execution of 2-byte op-codes,  $\overline{M}_1$  is generated as each op code byte is fetched. These two byte op-codes always begin with CBH, DDH, EDH or FDH.  $\overline{M}_1$  also occurs with  $\overline{IORQ}$  to indicate an interrupt acknowledge cycle.

$\overline{MREQ}$   
(Memory Request)

Tri-state output, active low. The memory request signal indicates that the address bus holds a valid address for a memory read or memory write operation.



## APPENDIX E

## INTRODUCTION

The Z-80 Parallel I/O (PIO) Circuit is a programmable, two port device which provides a TTL compatible interface between peripheral devices and the Z80-CPU. The CPU can configure the Z80-PIO to interface with a wide range of peripheral devices with no other external logic required. Typical peripheral devices that are fully compatible with the Z80-PIO include most keyboards, paper tape readers and punches, printers, PROM programmers, etc. The Z80-PIO utilizes N channel silicon gate depletion load technology and is packaged in a 40 pin DIP. Major features of the Z80-PIO include:

- Two independent 8 bit bidirectional peripheral interface ports with 'handshake' data transfer control
- Interrupt driven 'handshake' for fast response
- Any one of four distinct modes of operation may be selected for a port including:
  - Byte output
  - Byte input
  - Byte bidirectional bus (Available on Port A only)
  - Bit control mode
 All with interrupt controlled handshake
- Daisy chain priority interrupt logic included to provide for automatic interrupt vectoring without external logic
- Eight outputs are capable of driving Darlington transistors
- All inputs and outputs fully TTL compatible
- Single 5 volt supply and single phase clock are required.

One of the unique features of the Z80-PIO that separates it from other interface controllers is that all data transfer between the peripheral device and the CPU is accomplished under total interrupt control. The interrupt logic of the PIO permits full usage of the efficient interrupt capabilities of the Z80-CPU during I/O transfers. All logic necessary to implement a fully nested interrupt structure is included in the PIO so that additional circuits are not required. Another unique feature of the PIO is that it can be programmed to interrupt the CPU on the occurrence of specified status conditions in the peripheral device. For example, the PIO can be programmed to interrupt if any specified peripheral alarm conditions should occur. This interrupt capability reduces the amount of time that the processor must spend in polling peripheral status.

## PIO ARCHITECTURE

A block diagram of the Z80-PIO is shown in Figure 2.0-1. The internal structure of the Z80-PIO consists of a Z80-CPU bus interface, internal control logic, Port A I/O logic, Port B I/O logic, and interrupt control logic. The CPU bus interface logic allows the PIO to interface directly to the Z80-CPU with no other external logic. However, address decoders and/or line buffers may be required for large systems. The internal control logic synchronizes the CPU data bus to the peripheral device interfaces (Port A and Port B). The two I/O ports (A and B) are virtually identical and are used to interface directly to peripheral devices.

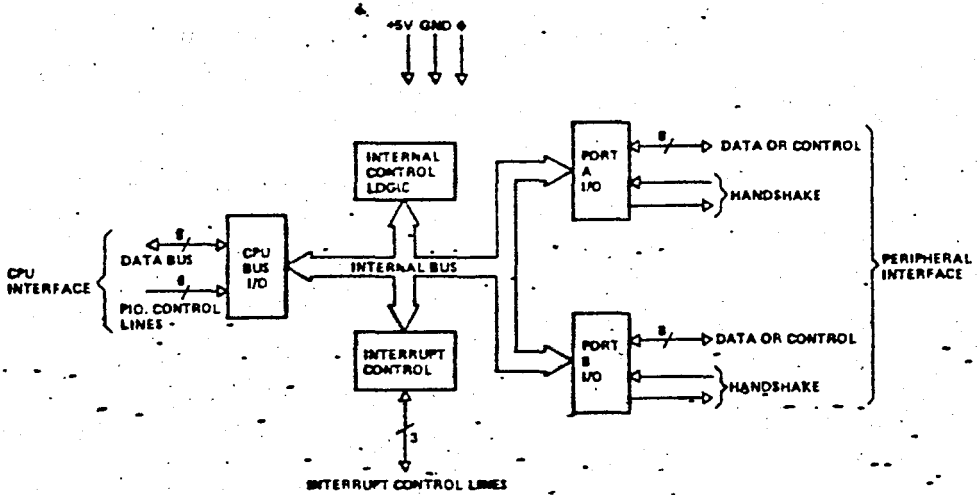


FIGURE 2.0-1  
PIO BLOCK DIAGRAM.

The Port I/O logic is composed of 6 registers with "handshake" control logic as shown in Figure 2.0-2. The registers include an 8-bit data input register, an 8-bit data output register, a 2-bit mode control register, an 8-bit mask register, an 8-bit input/output select register, and a 2-bit mask control register.

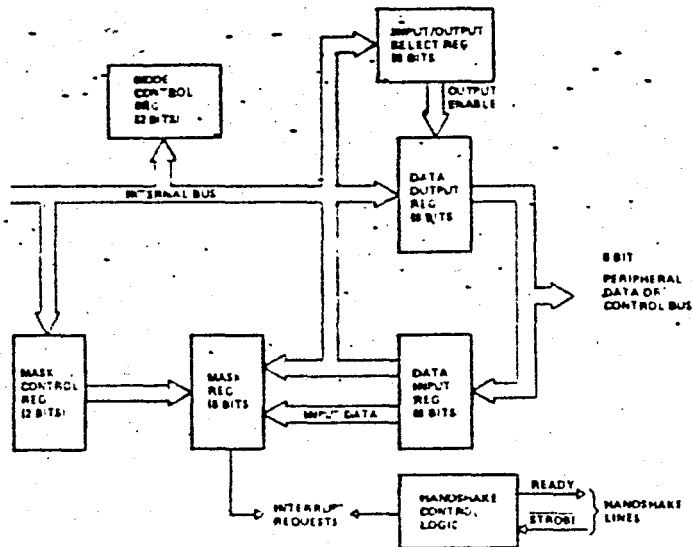


FIGURE 2.0-2  
PORT I/O BLOCK DIAGRAM

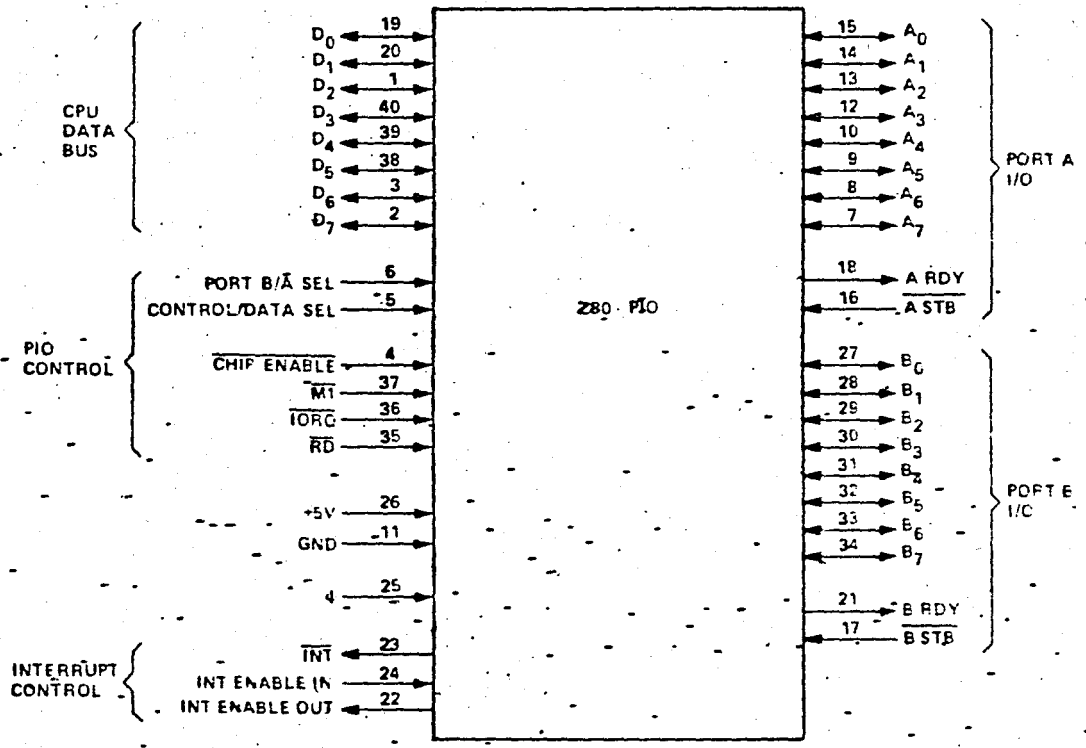
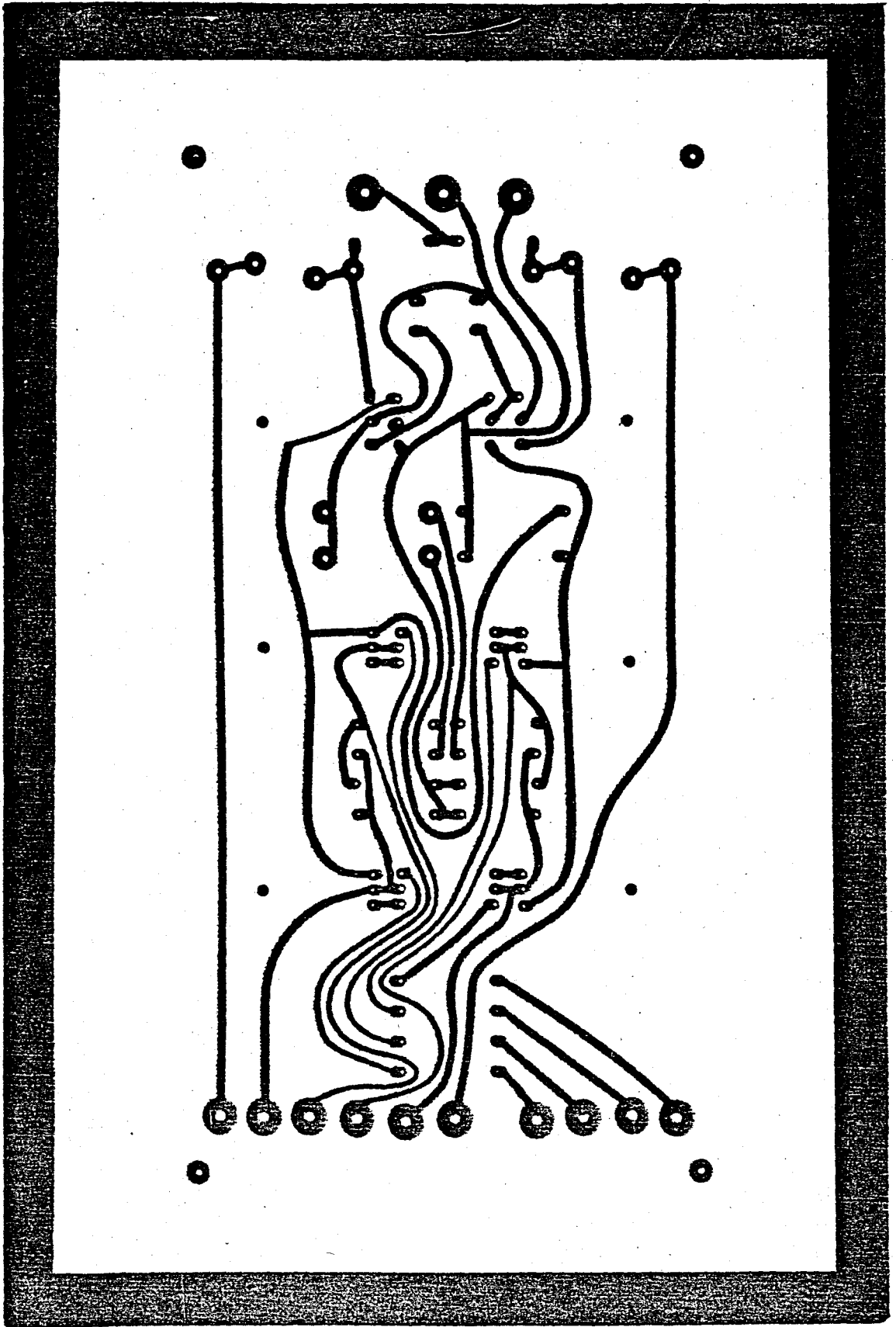
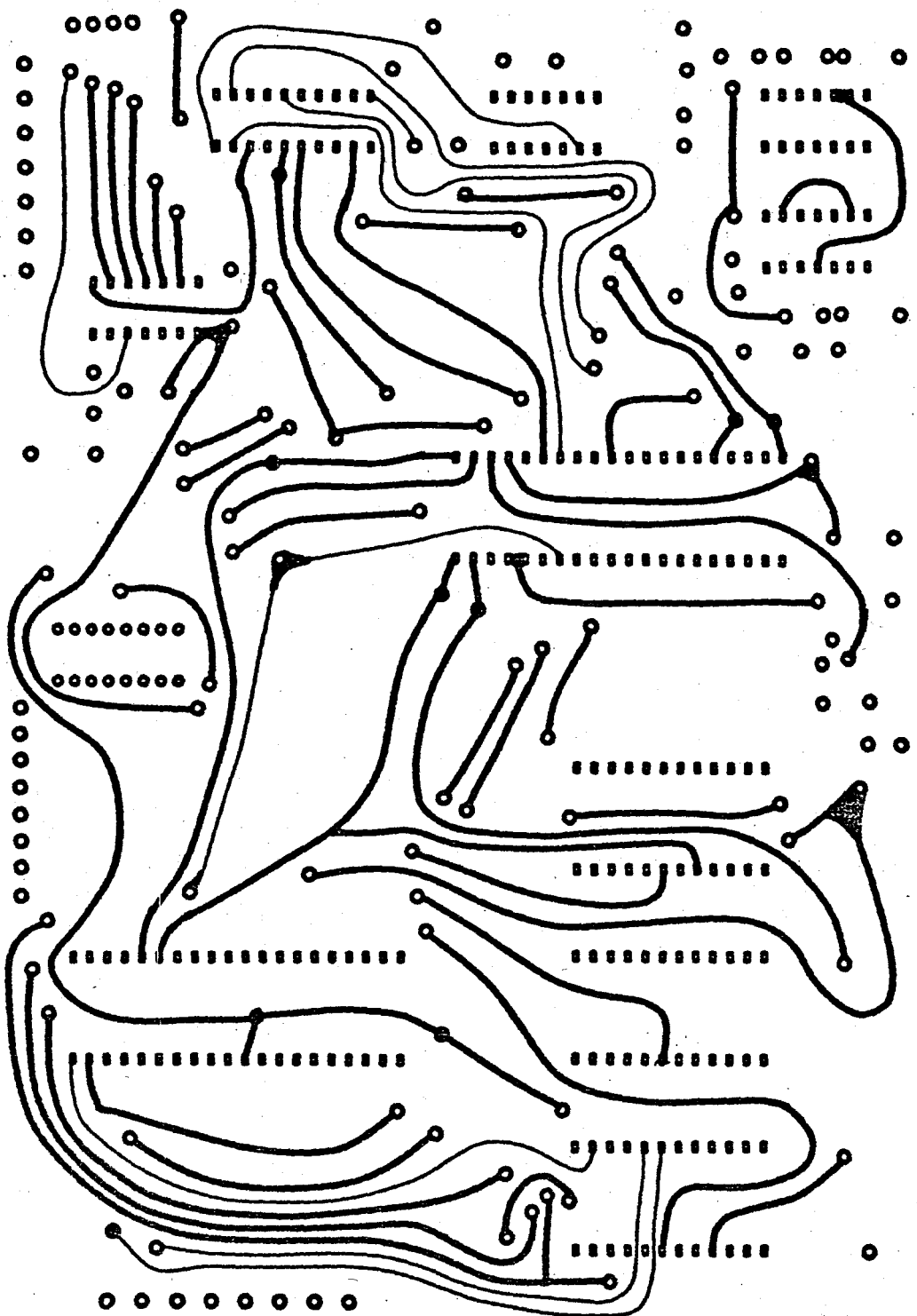


FIGURE 3.0.1  
PIO PIN CONFIGURATION

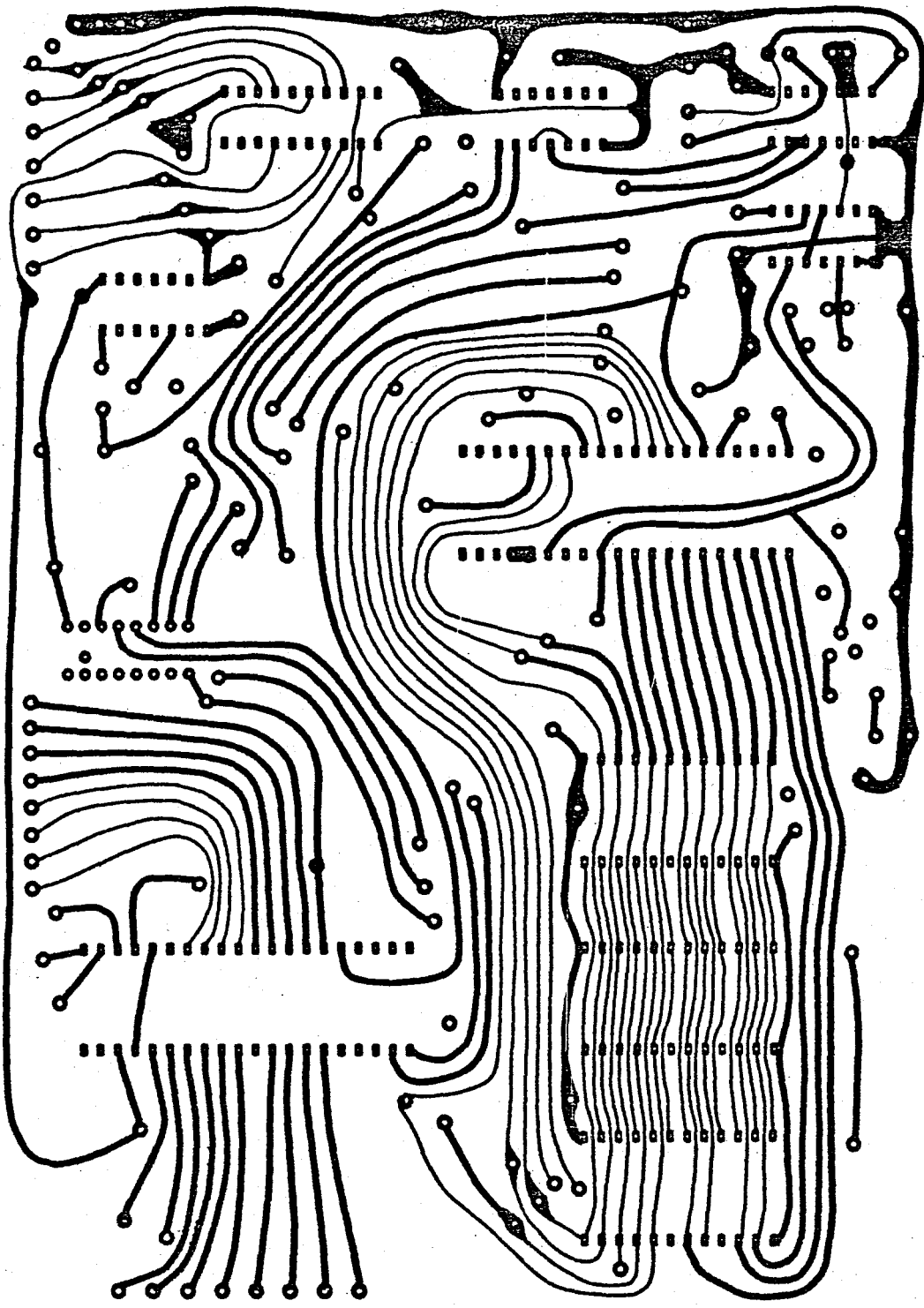


Stepper Motor Drive Card



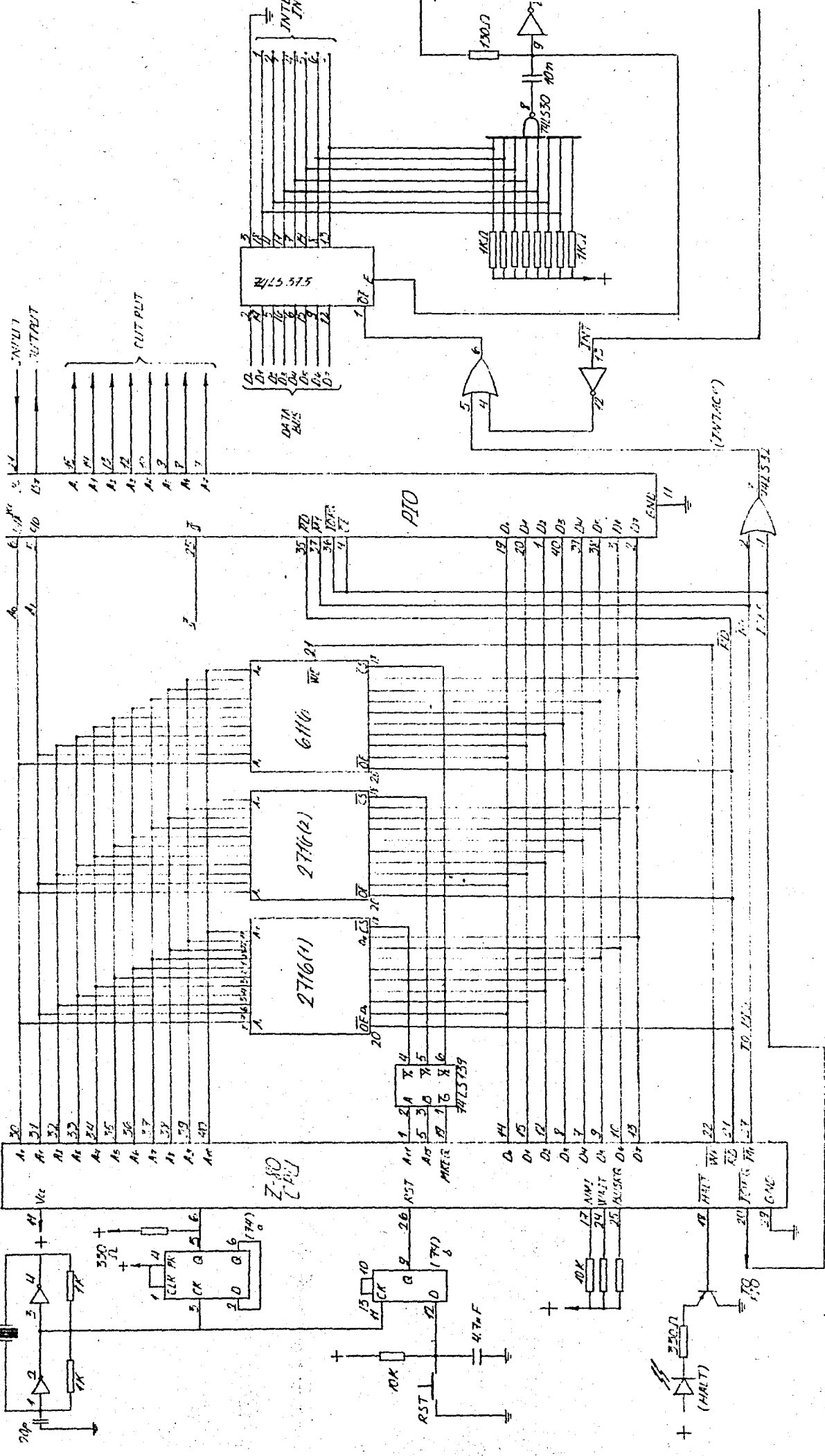
(Component side)

Z-80 Microprocessor Card



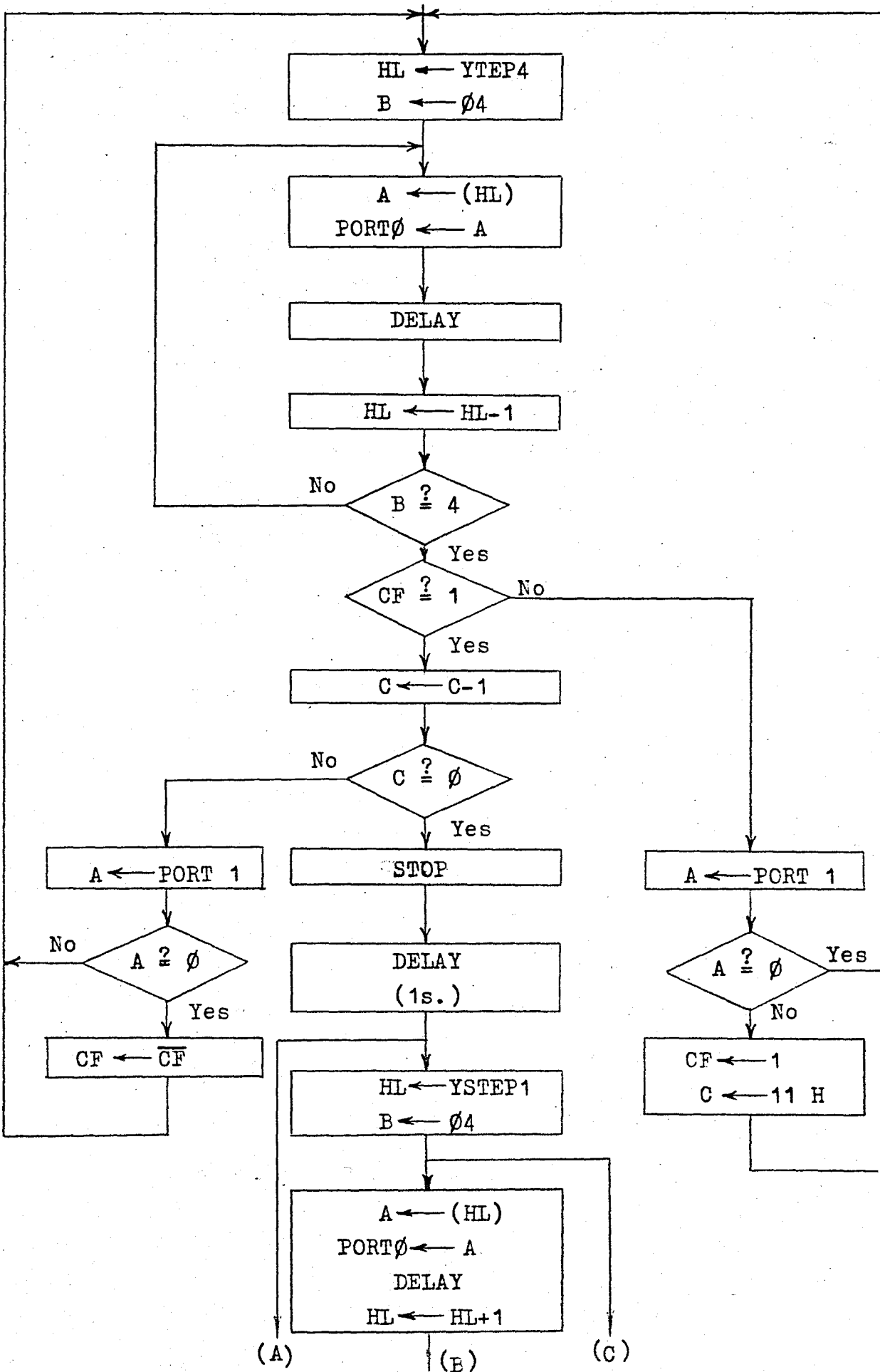
(Solder side)

Z-80 Microprocessor Card

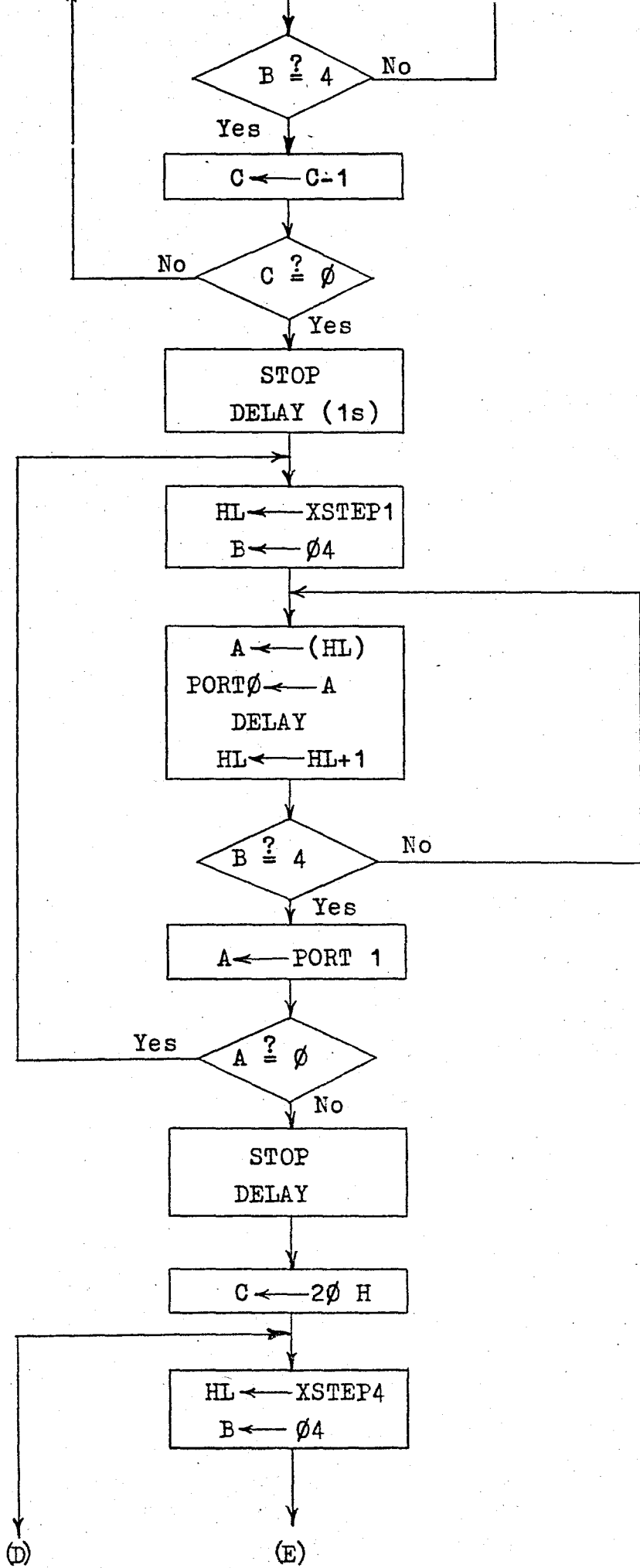


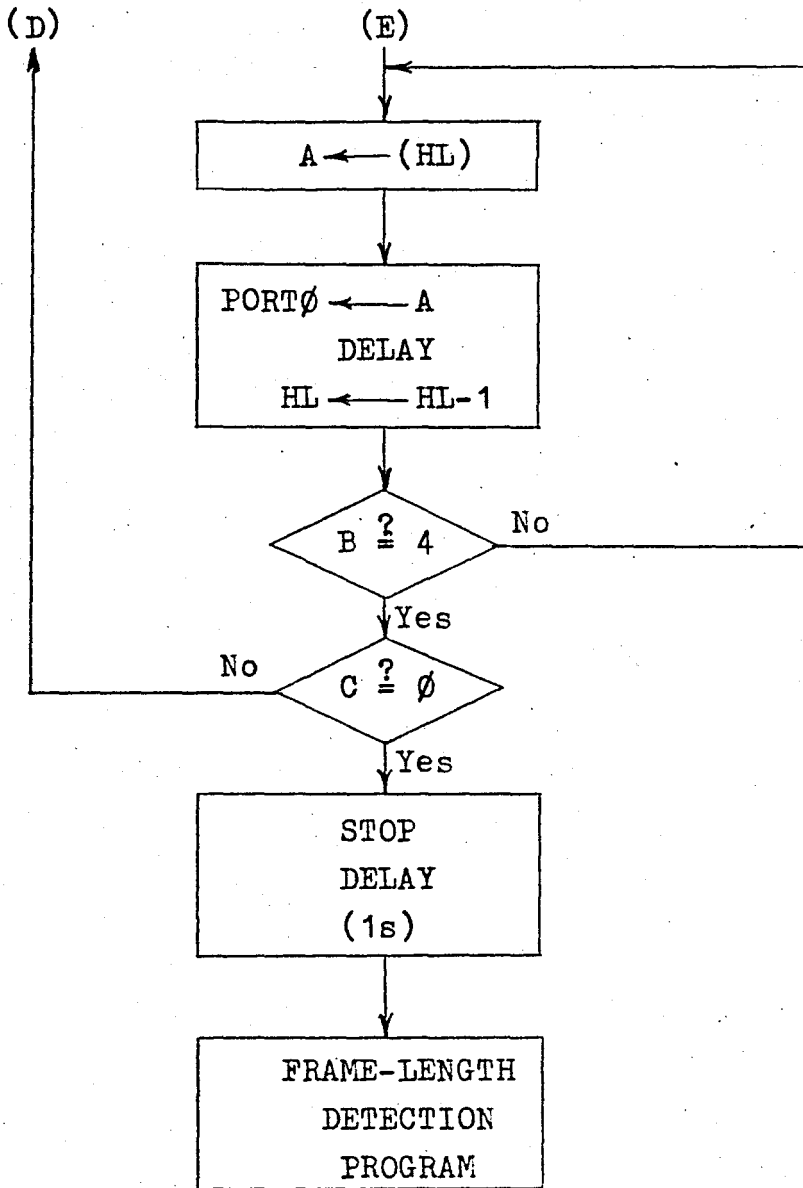
Z-80 MICRO PROCESSOR CARD

Frame Line Detection Program

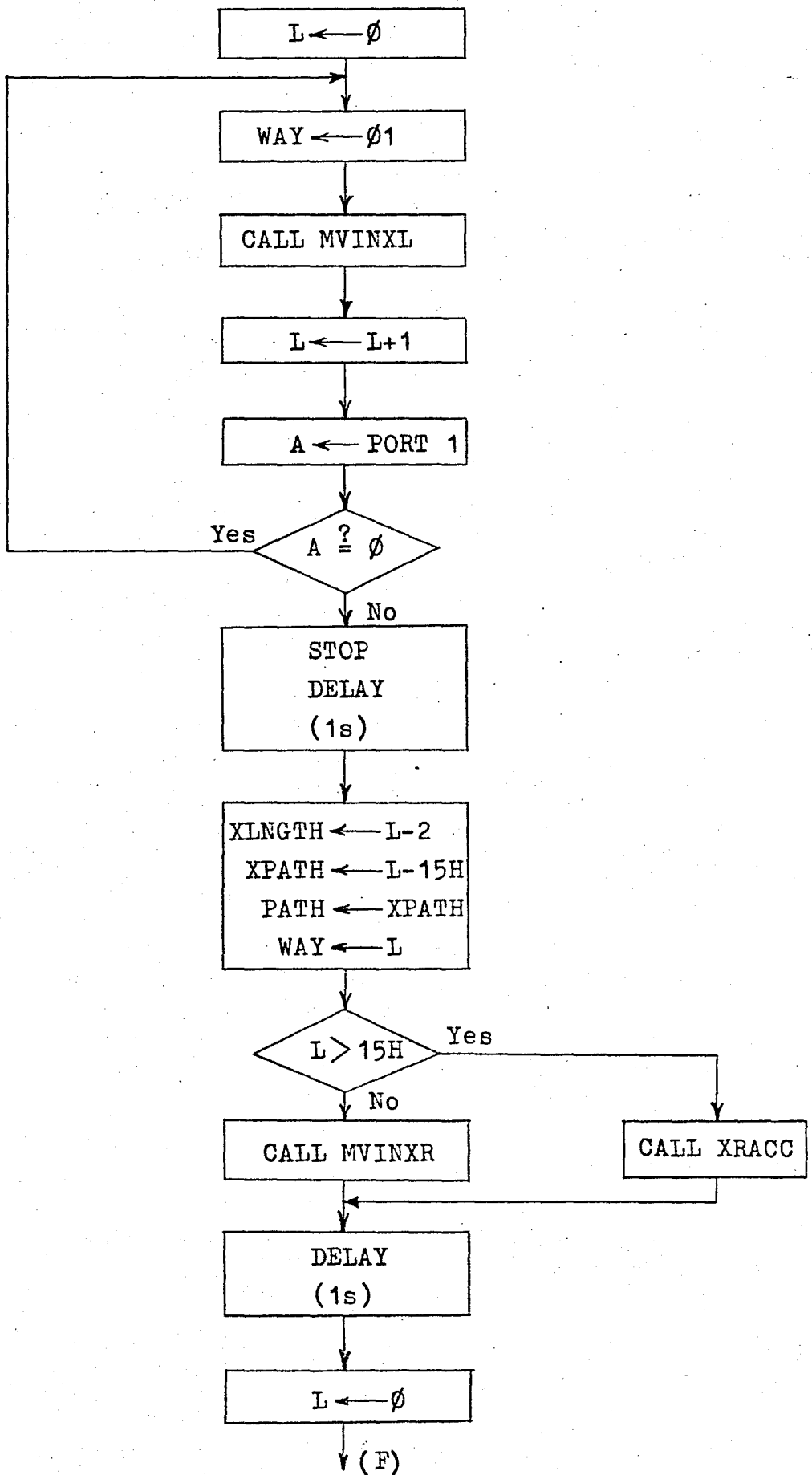


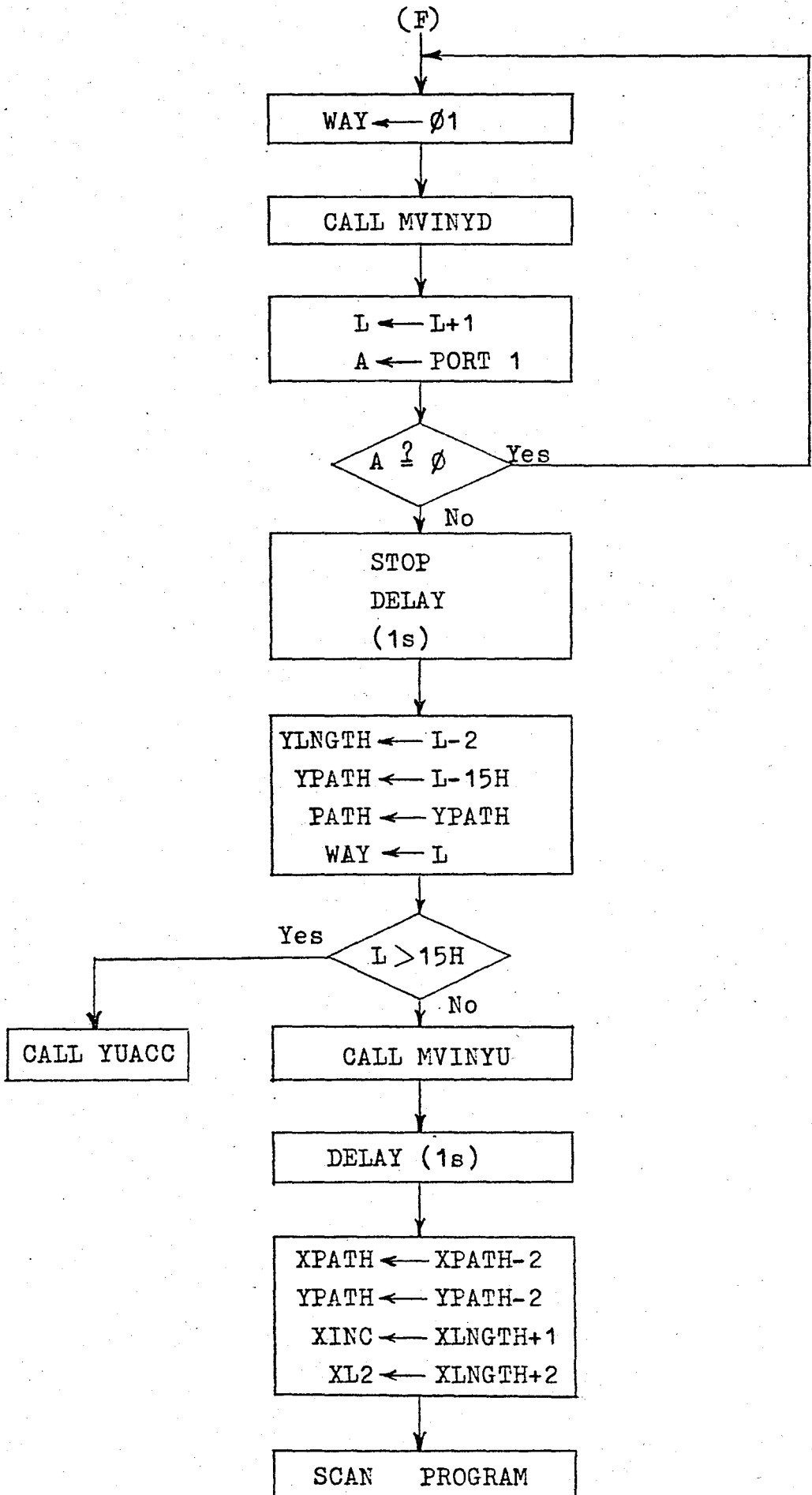




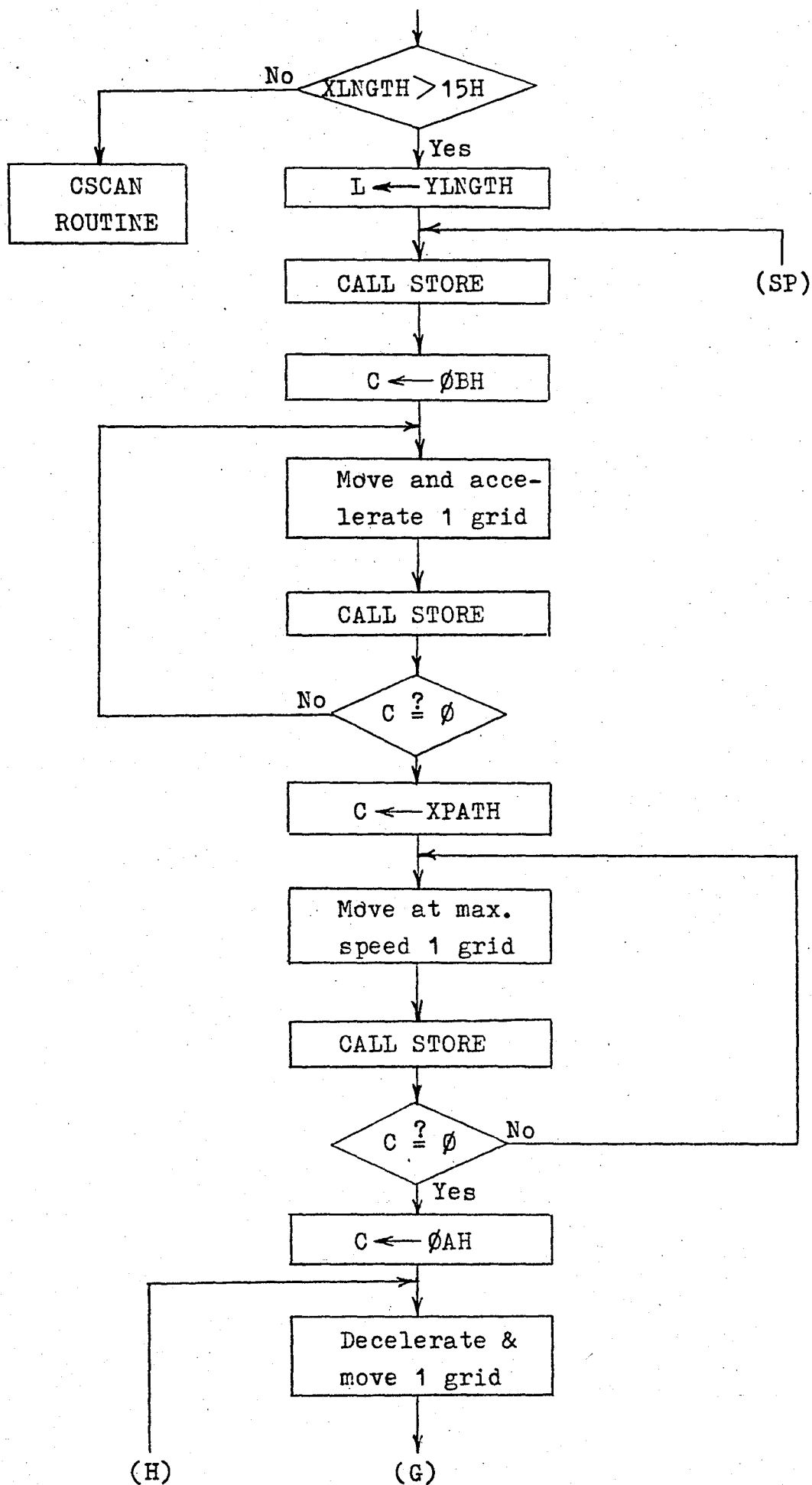


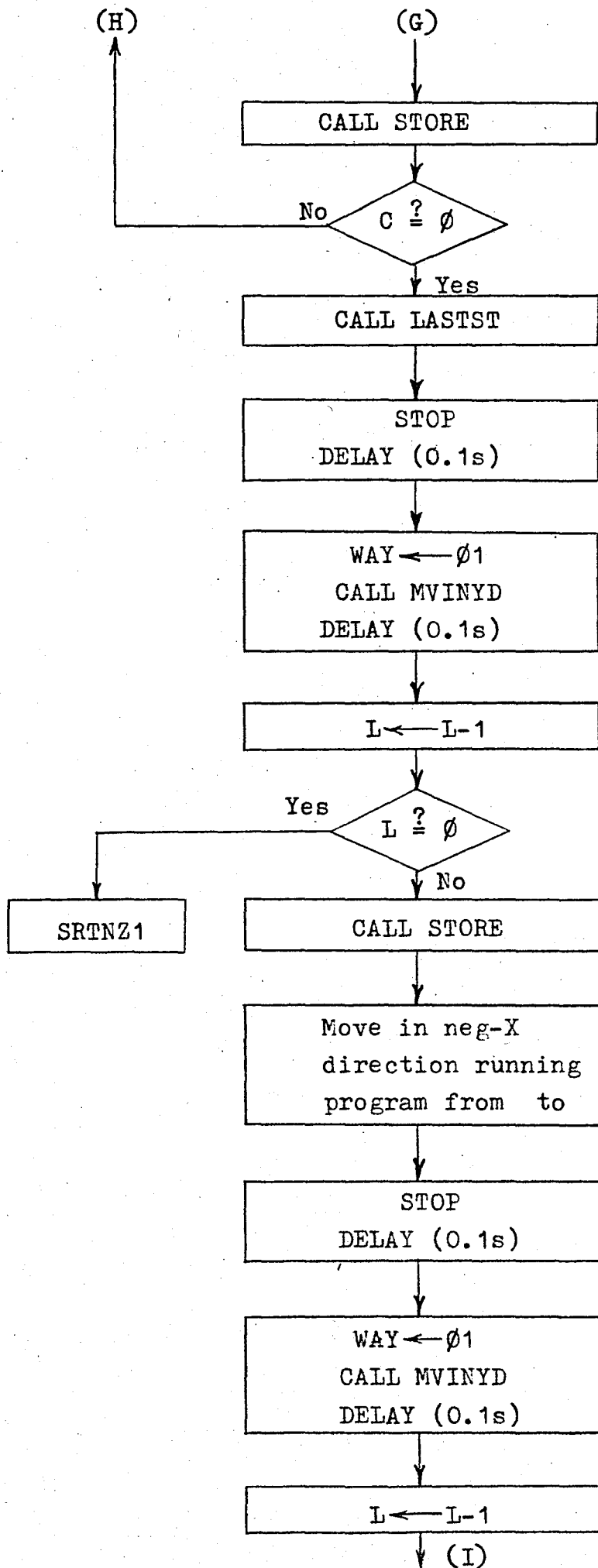
Frame-length Detection Program

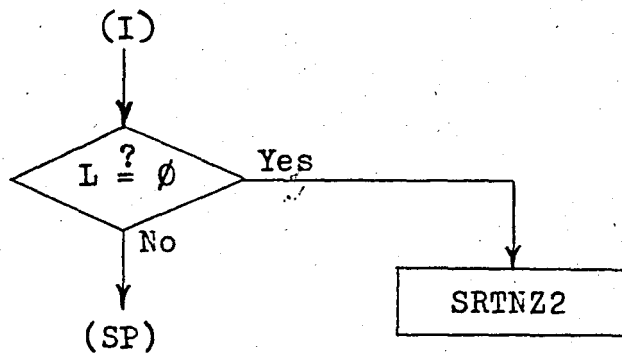




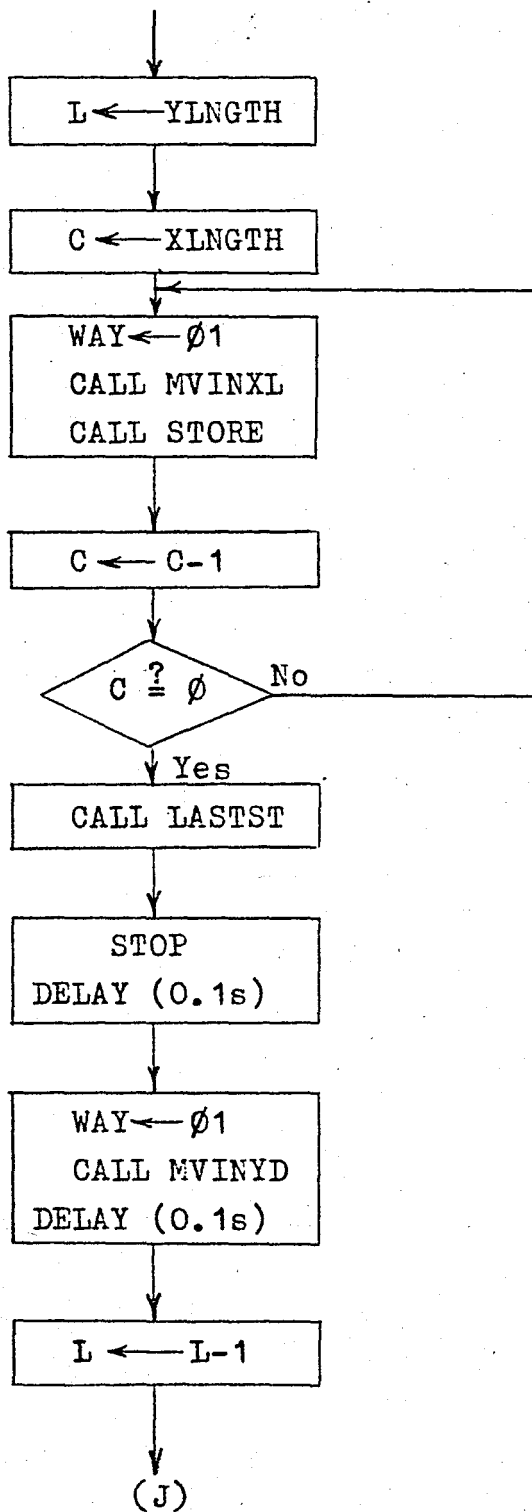
### Scanning Program

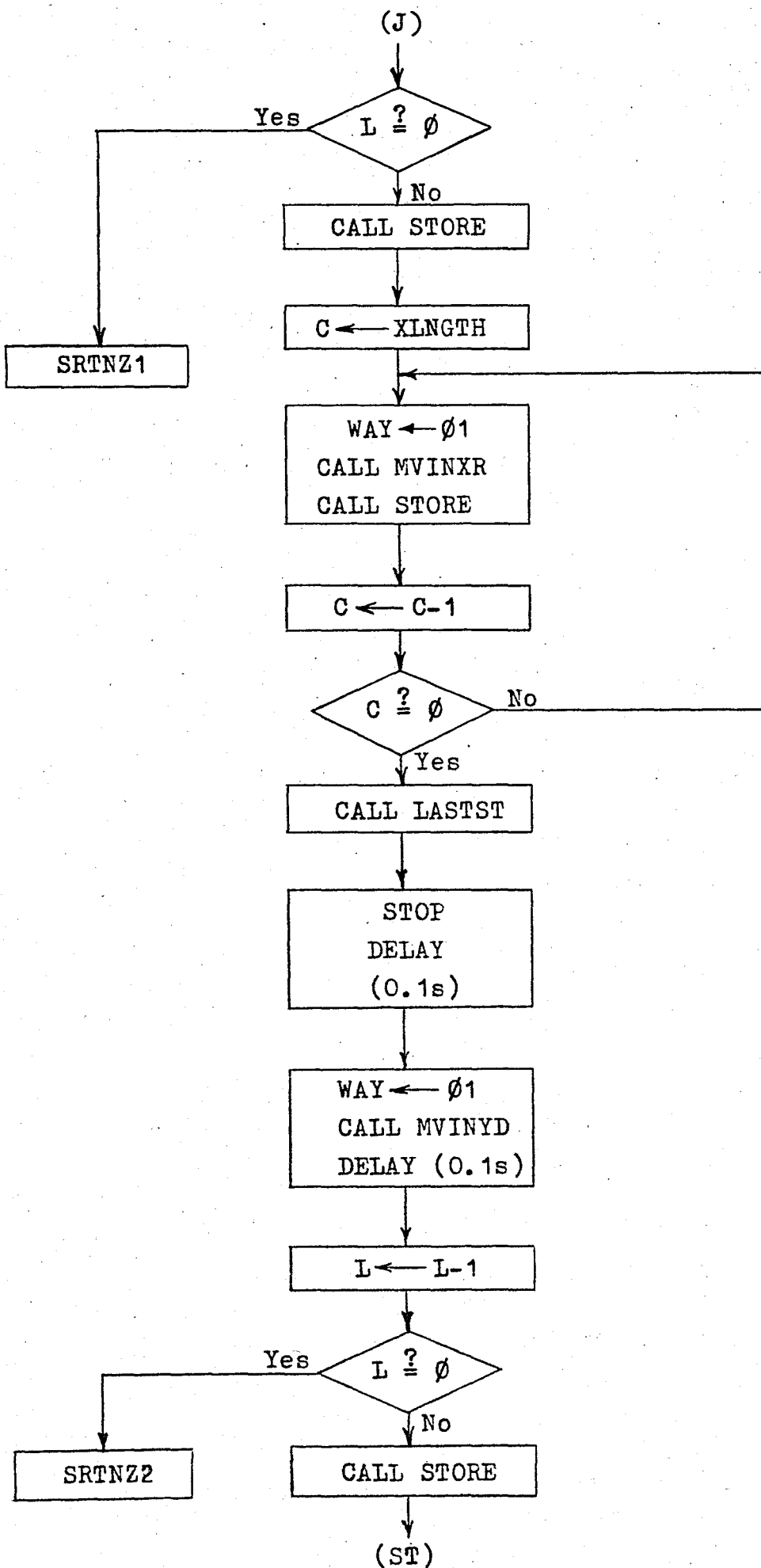






Constant speed scanning (CSCAN) Routine







Store Routine

Exchange  
Registers & Flags

A ← PORT 1  
B ← (LOC2)  
RRC B  
A.(OR).B  
LOC 2 ← A

LOC1 ← LOC1-1

No  
LOC1 ?= ∅

EXX  
Reg. & Flags

Return

Yes  
A ← (LOC2)  
RRC A  
STAM ← A  
STAM ← STAM+1  
LOC1 ← ∅8  
LOC2 ← ∅∅

EXX Reg. & Flags

Return

LOC2 ← A

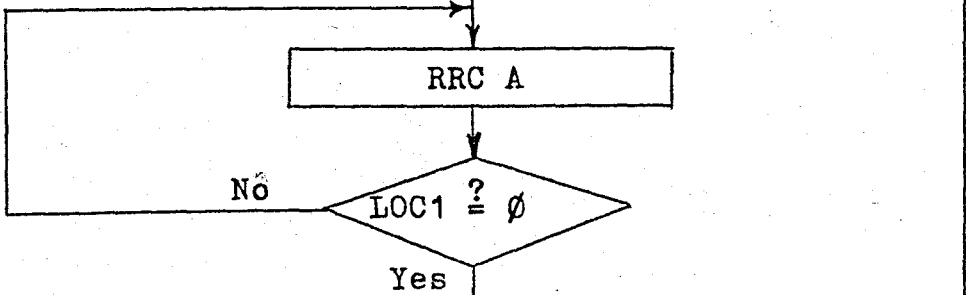
LASTST ROUTINE

A ← (LOC2)

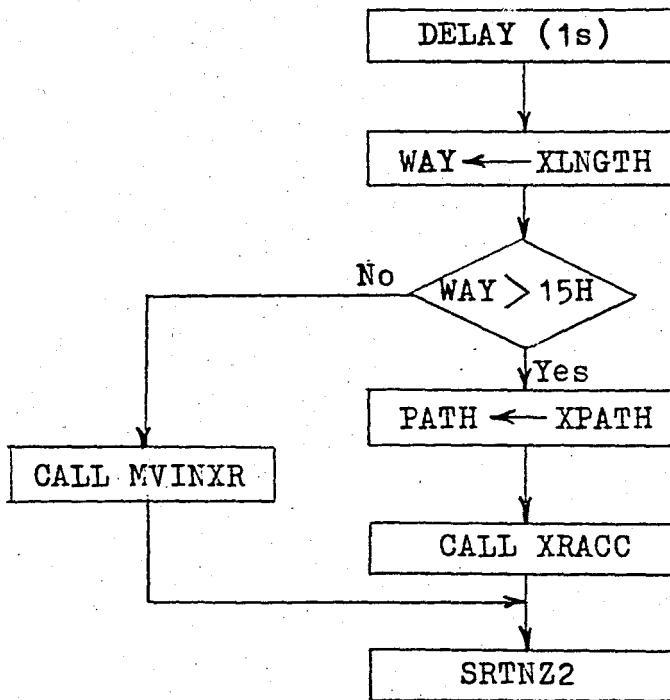
RRC A

No  
LOC1 ?= ∅

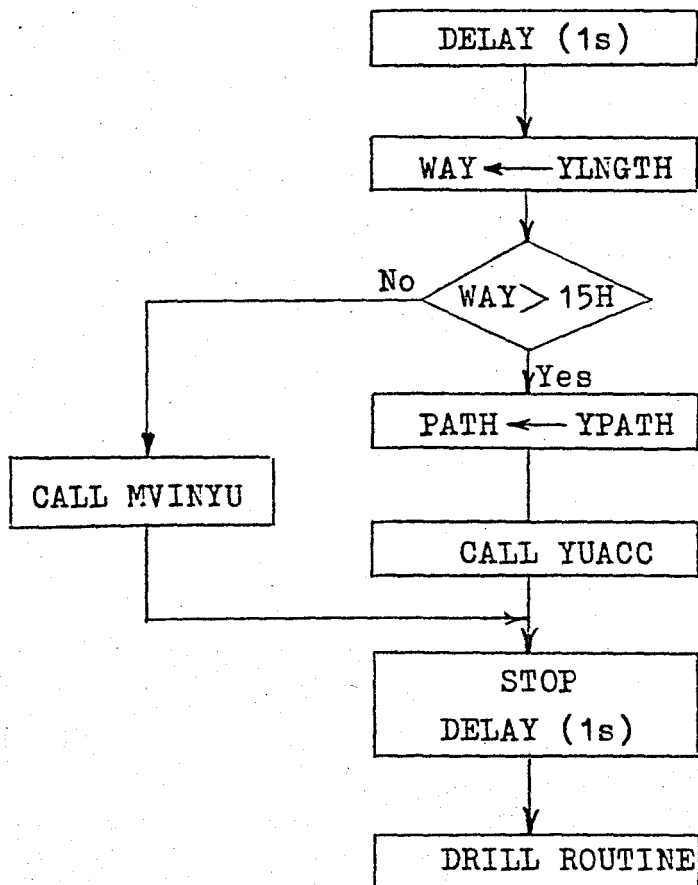
Yes



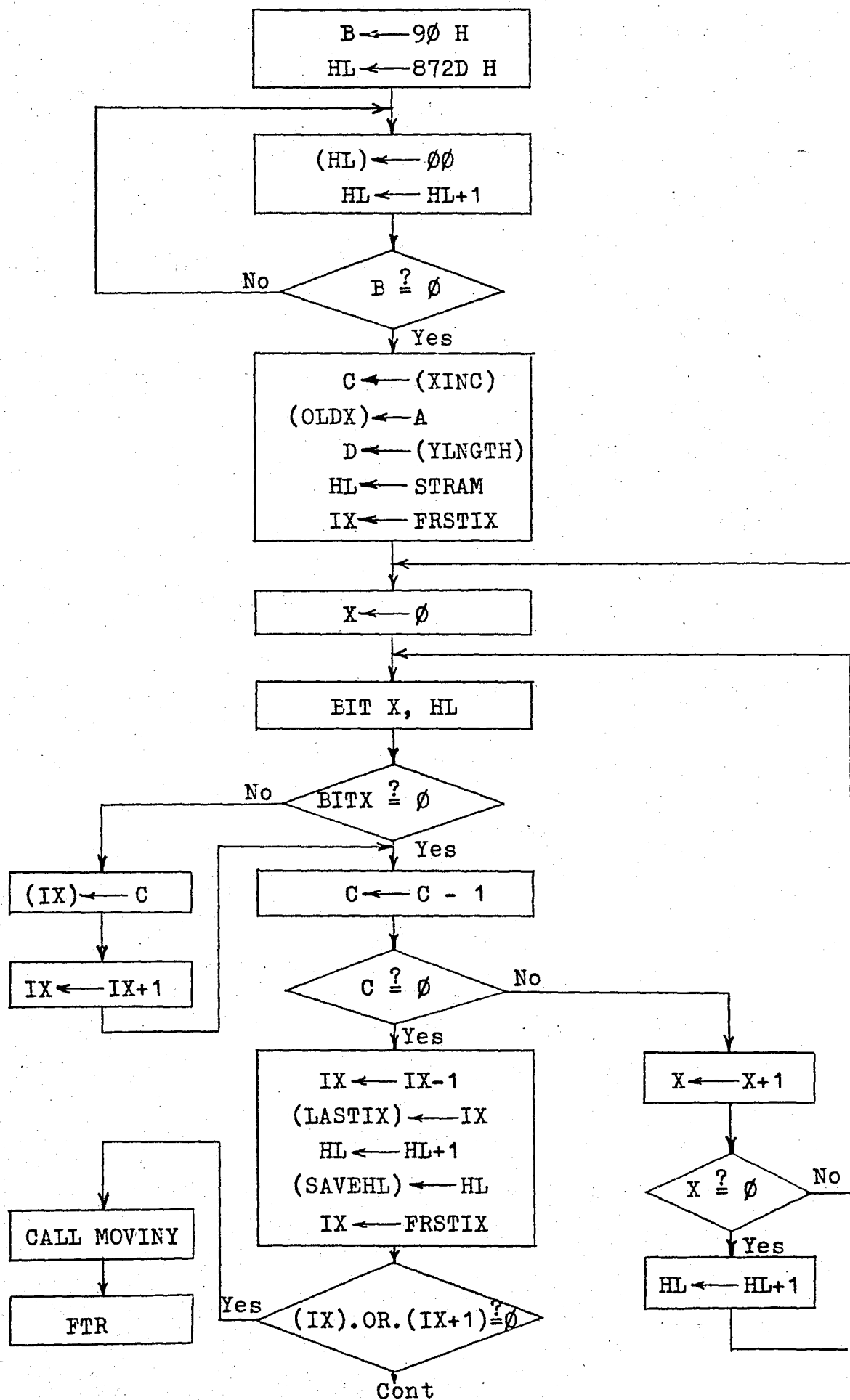
SRTNZ1 Routine

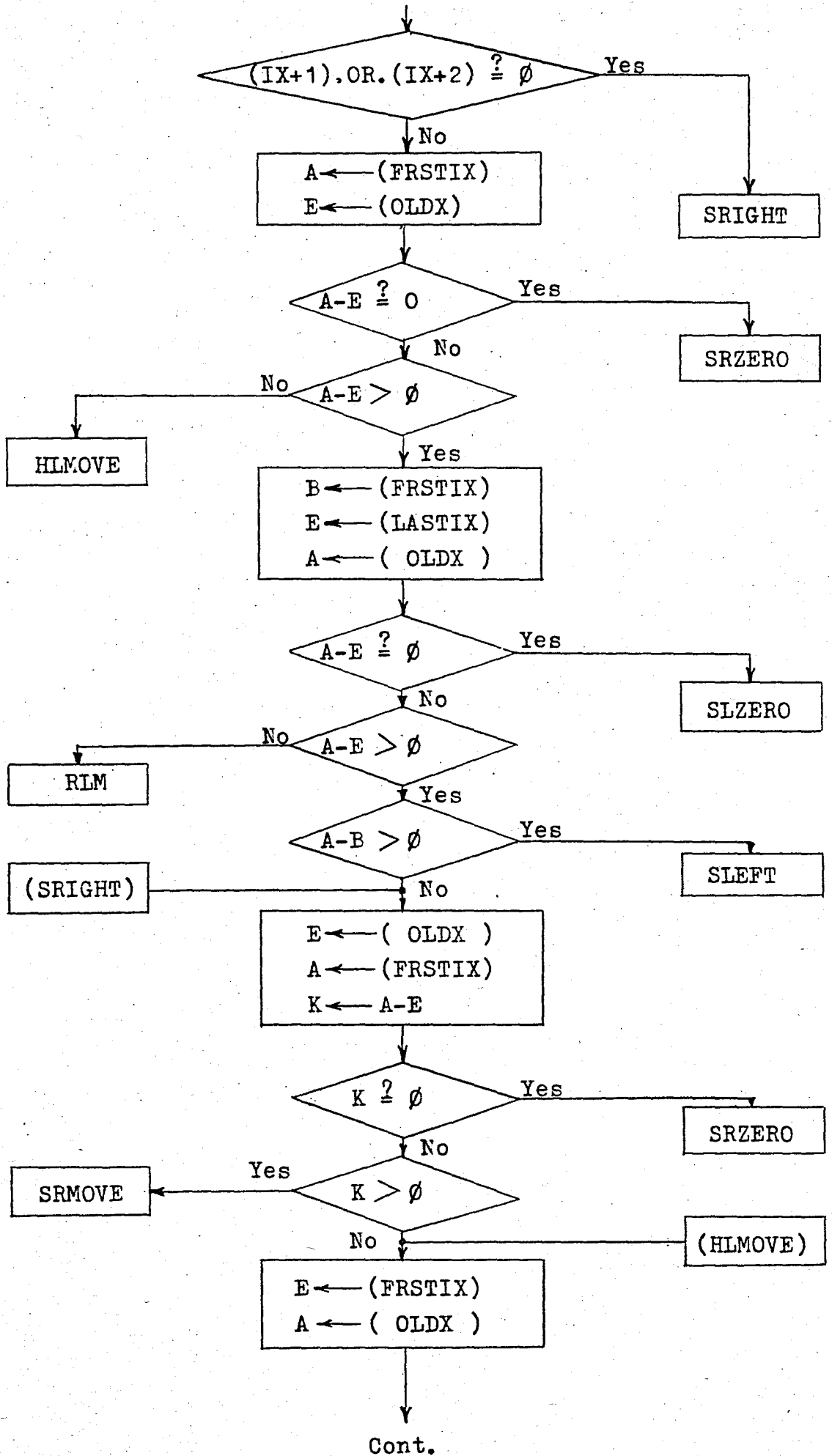


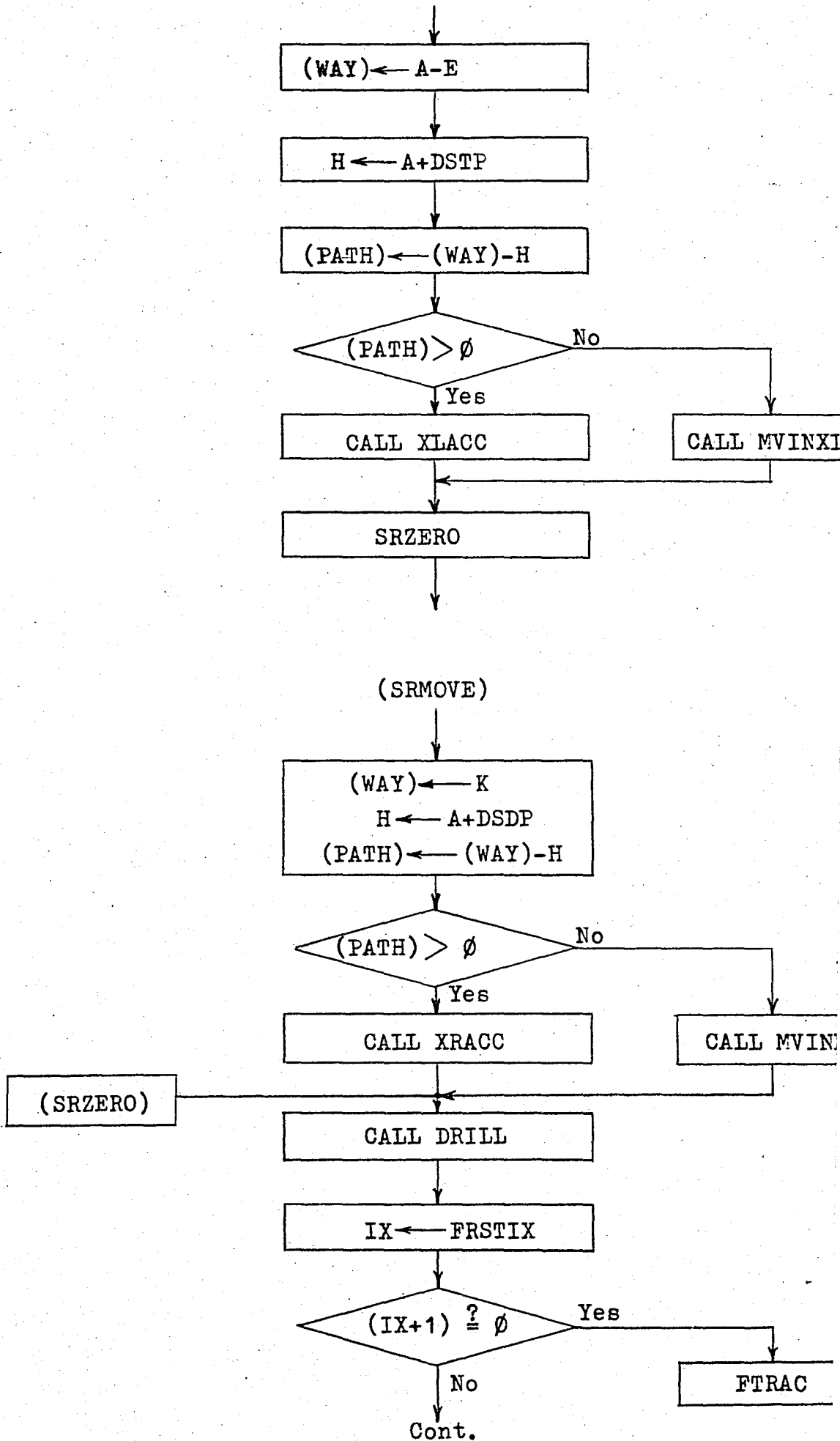
SRTNZ2 Routine

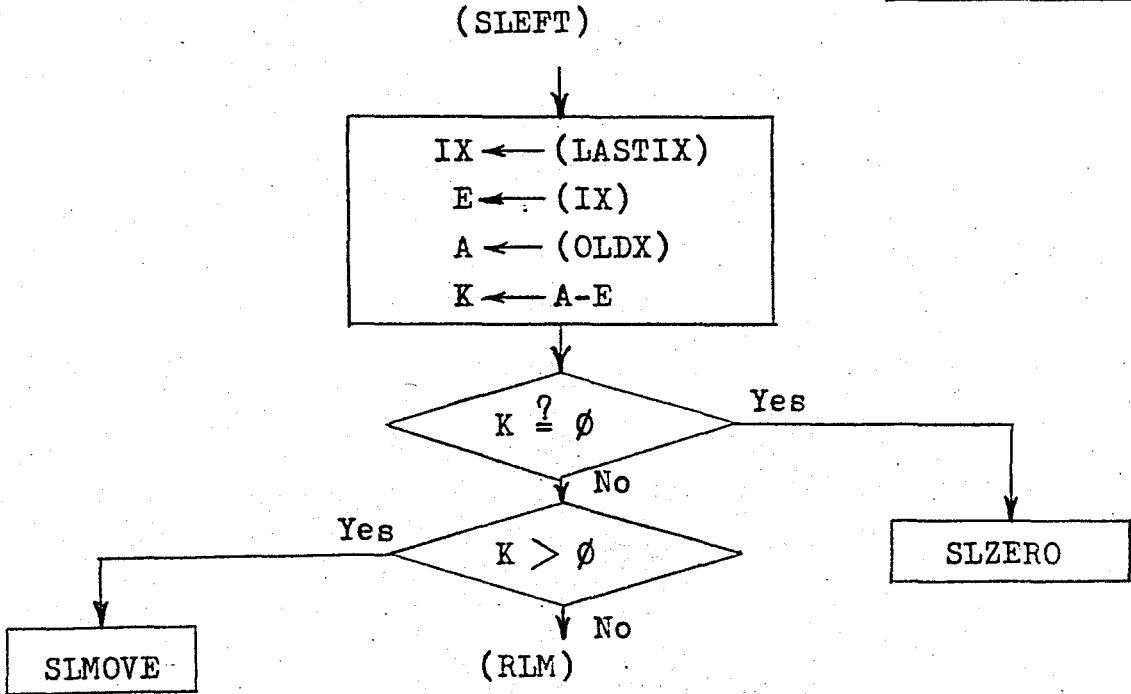
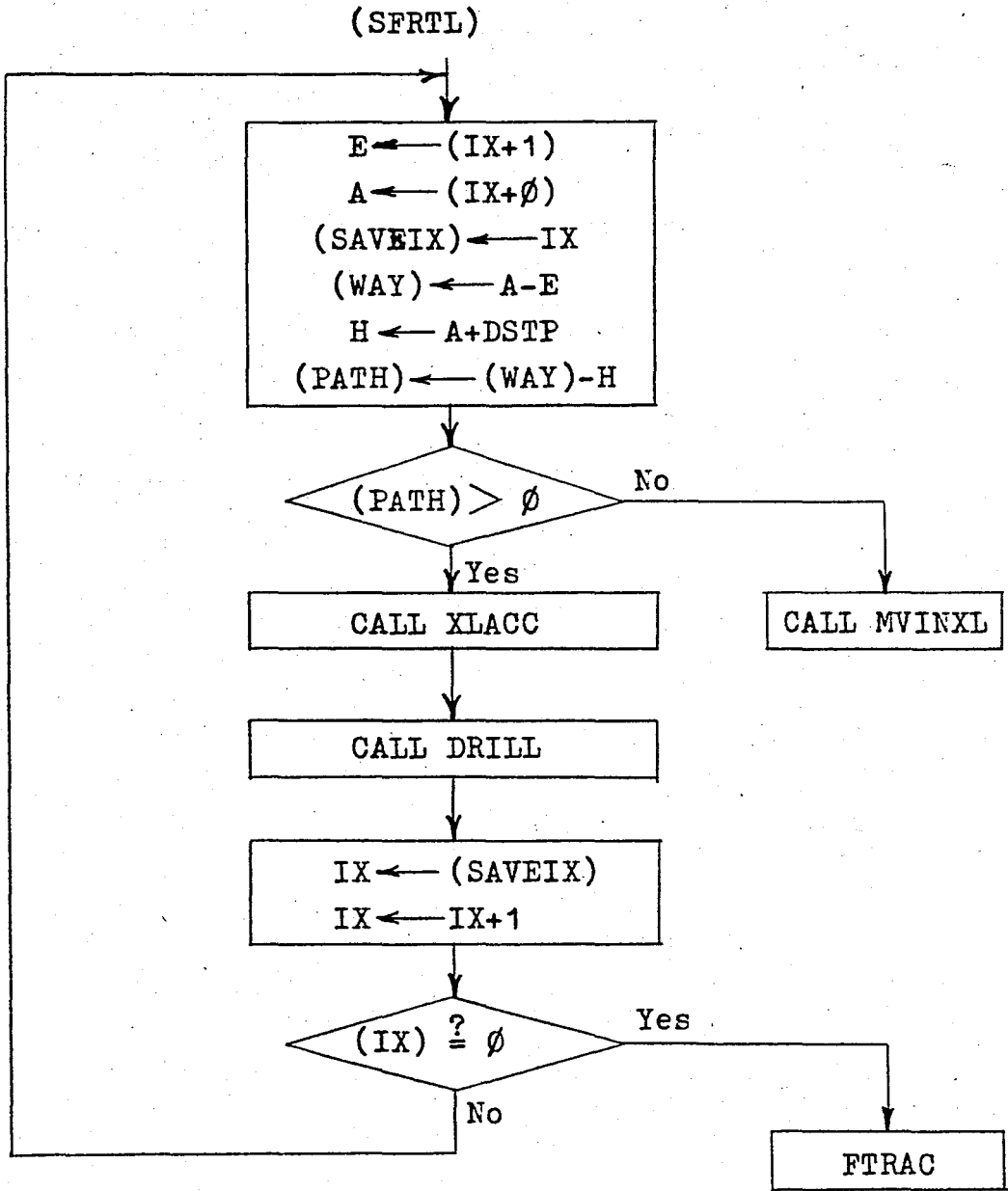


Drill Program (For odd lines)

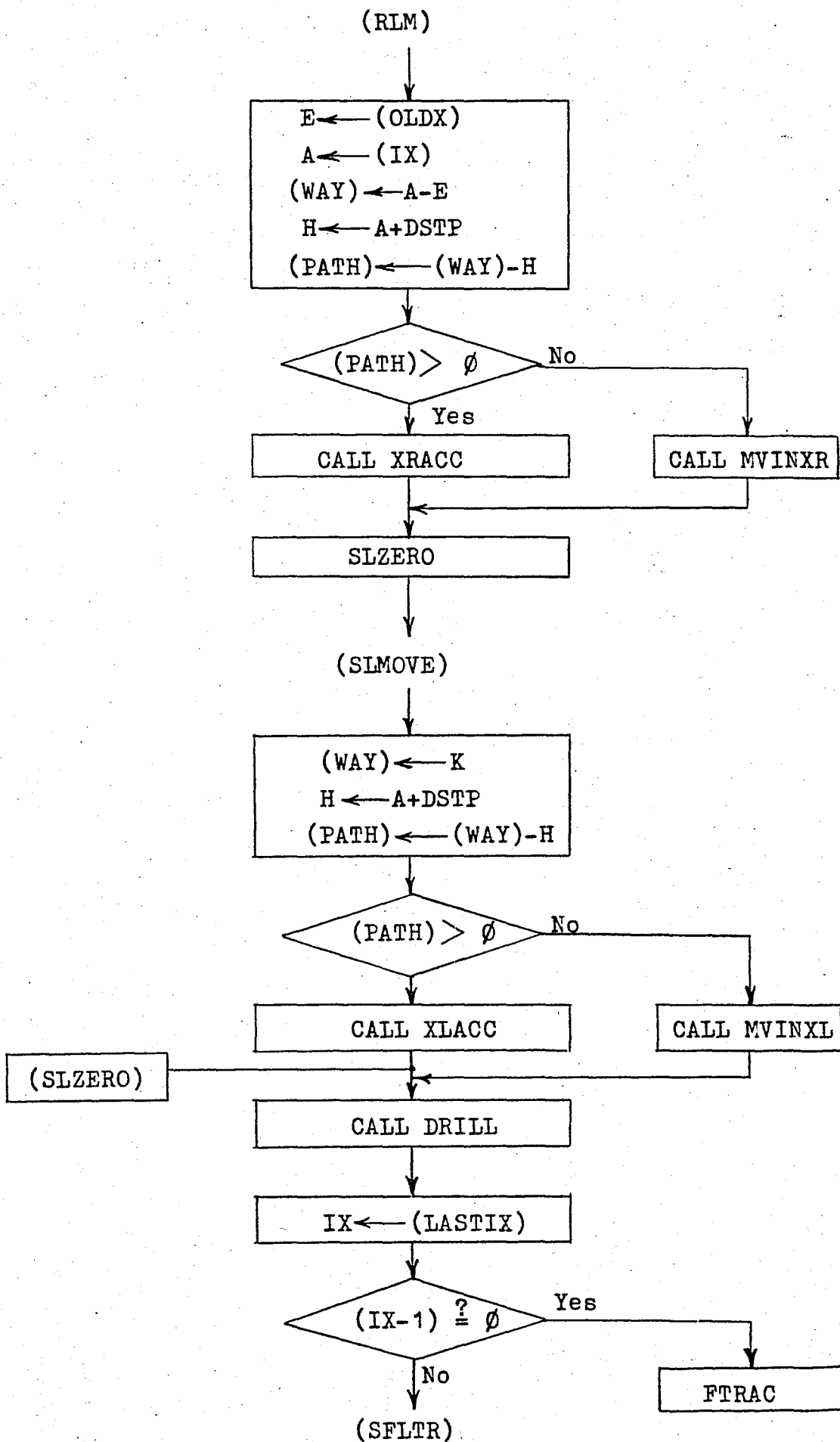








(RLM)



(SFLTR)

```

E ← (IX + 0)
A ← (IX - 1)
(SAVEIX) ← IX
(WAY) ← A - E
H ← A + DSTP
(PATH) ← (WAY) - H

```

PATH > 0

No

CALL MVINXR

Yes

CALL XRACC

CALL DRILL

IX ← (SAVEIX)

IX ← IX - 1

(IX) = 0

No

SFLTR

Yes

(OLDX) ← (IX)

CALL MOVINY

D ← D - 1

D = 0

Yes

RETURN

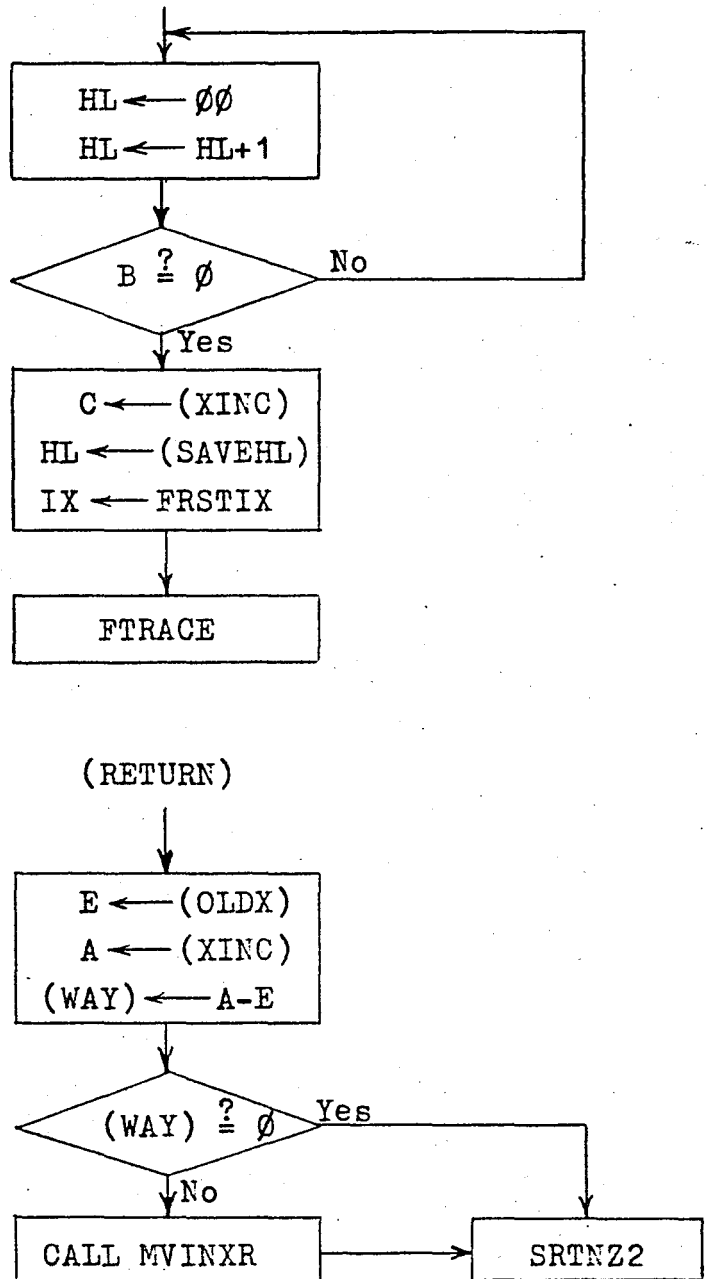
No

B ← 90 H

HL ← 872D H

Cont.



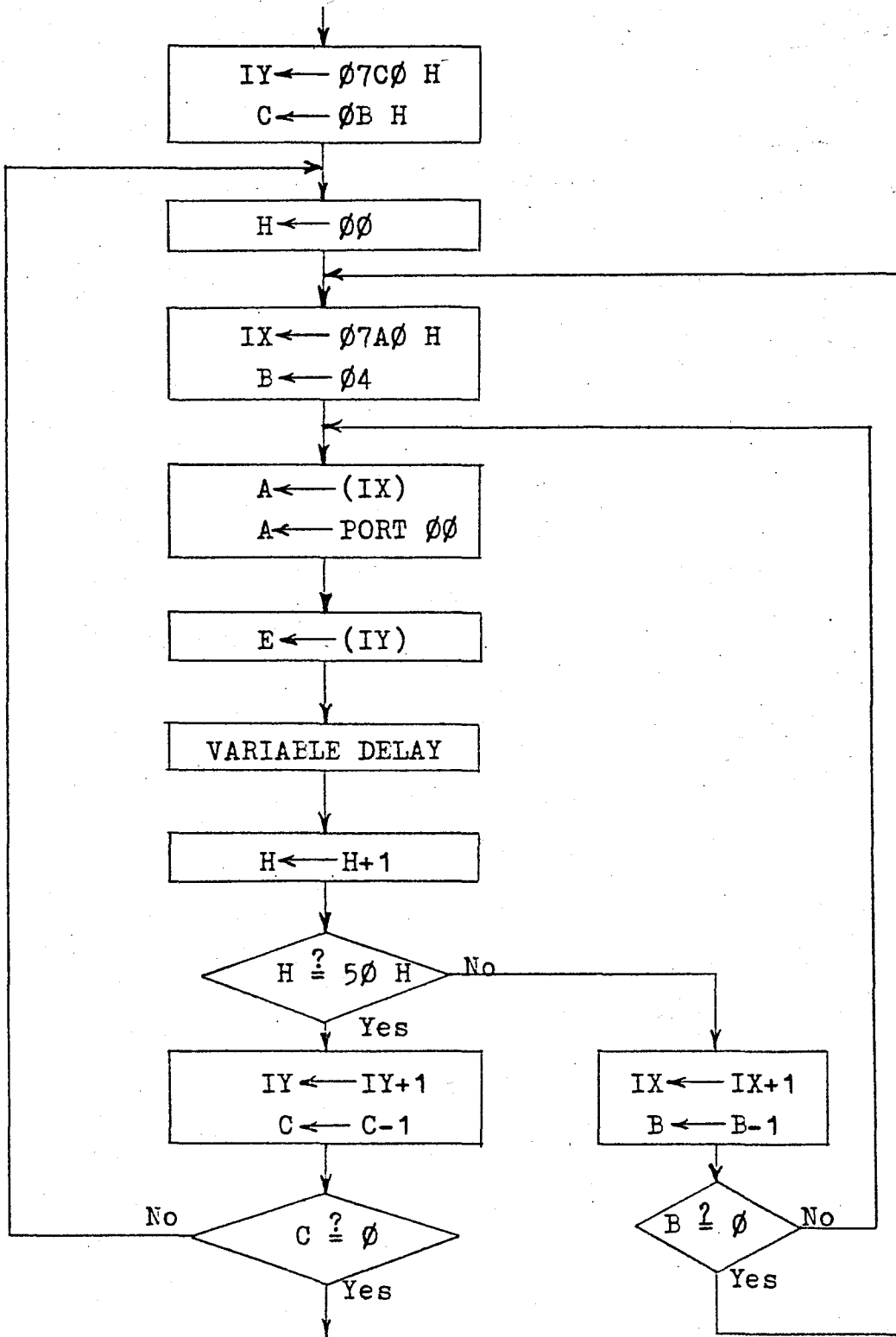


Drill Program

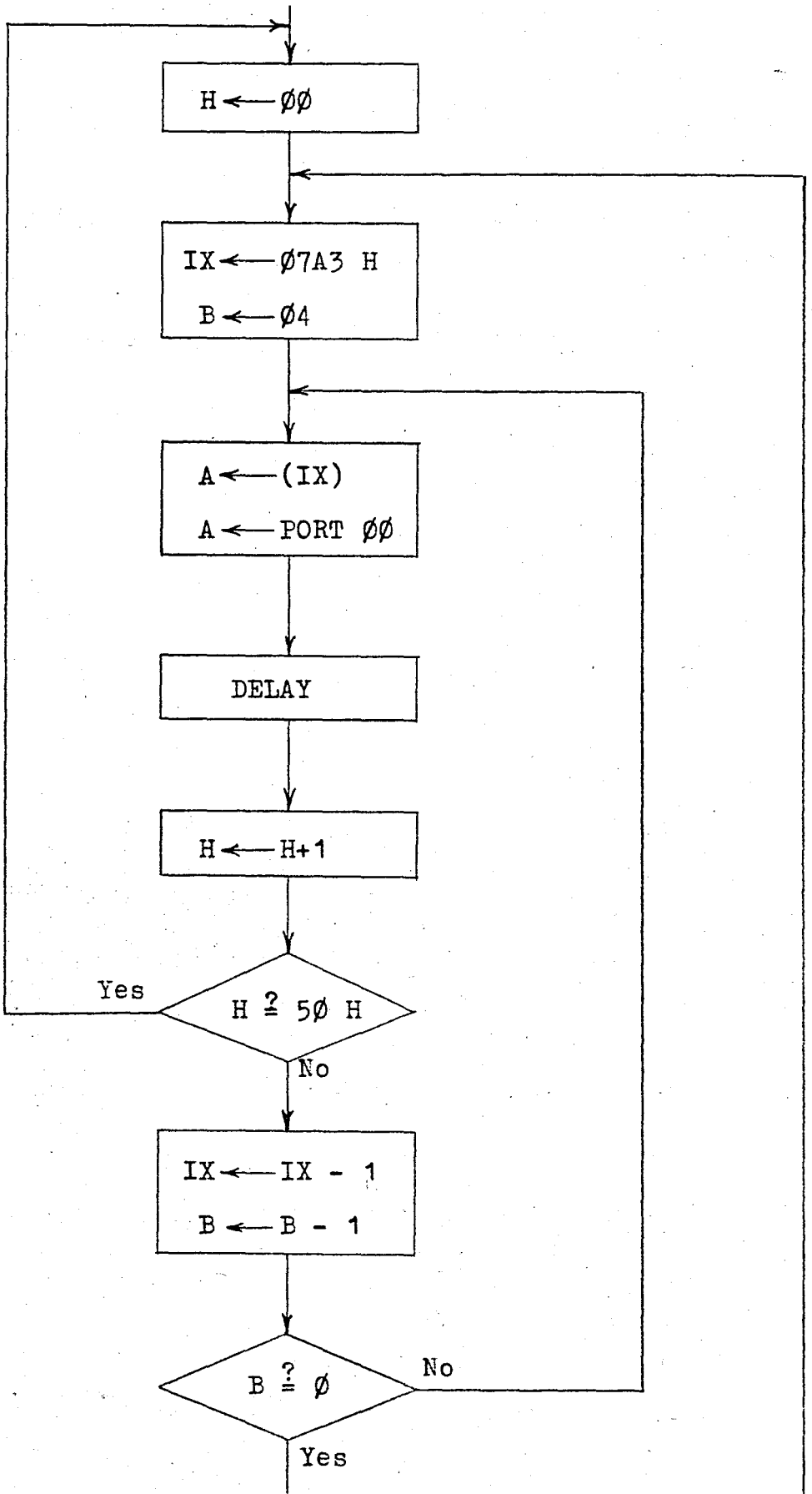
(For even lines)

The same flowchart (which is written for odd lines) can be used, with certain changes, for the even lines also. These changes can be understood by looking at the related sections of the drill program listing.

Acceleration Routine



Constant Speed Routine



0000	XLNGTH	: EQU 87F0H	;Memory location for X-length
0001	XPATH	: EQU 87F1H	;Memory location for X-path
0002	YLNTH	: EQU 87F2H	;Memory location for Y-length
0003	YPATH	: EQU 87F3H	;Memory location for Y-path
0004	XSTEP1	: EQU 07A0H	;Location of first X-motor constant
0005	XSTEP4	: EQU 07A3H	;Location of last X-motor constant
0006	YSTEP1	: EQU 07B0H	;Location of first Y-motor constant
0007	YSTEP4	: EQU 07B3H	;Location of last Y-motor constant
0008	XINC	: EQU 87F4H	;Location of incremented x-length
0009	XL2	: EQU 87E8H	; " of twice " x-length
0010	LOC1	: EQU 87F5H	;Location of byte count
0011	LOC2	: EQU 87F6H	;Location of incomplete store by
0012	STAM	: EQU 87FAH	;Starting address location of memory
0013	SAVEHL	: EQU 87EEH	;Location to save HL registers
0014	SAVEIX	: EQU 87FCH	;Location to save IX register
0015	LASTIX	: EQU 87F8H	; " to store last IX content
0016	OLDX	: EQU 87ECH	; " to store old position of
0017	FRSTIX	: EQU 8730H	; " to store first IX content
0018	PATH	: EQU 87F7H	;Location to store distance path
0019	WAY	: EQU 87EBH	;Location to store length way
0020	SRAM	: EQU 8000H	;Starting address of RAM
0021	A+DSTP	: EQU 15H	;Sum of acceleration+dec. steps
0022	ACOUNT	: EQU 0BH	;Acceleration steps
0023	DCOUNT	: EQU 0AH	;Deceleration steps
0024	COUNT	: EQU 04H	;Motor pulse sequence steps
0025	BYTE	: EQU 08H	;Bit count in a byte
0026	STEP	: EQU 01H	;One step length
0027	GRID	: EQU 50H	;One grid length, 80D steps
0028	MAXSPD	: EQU 12H	;Maximum speed constant

```

0029          LD IX,87F5H
0030          LD (IX+00),08H
0031          LD (IX+01),00H
0032          LD HL,8000H
0033          LD (STAM),HL
0034  NGY      : LD HL,YSTEP4      ;Frame Detection Program
0035          LD B,COUNT
0036  OUT      : LD A,(HL)          ;Move in 4-step sequence
0037          OUT (PORT0),A        ;and input data
0038          CALL DLY
0039          DEC HL
0040          DJNZ OUT
0041          JP NC,IN1
0042          DEC C
0043          JP Z,STOP
0044          IN A,(PORT1)
0045          BIT 0,A
0046          JP NZ,NGY
0047          CCF
0048          JP NGY
0049  IN1      : IN A,(PORT1)
0050          BIT 0,A
0051          JP Z,NGY              ;If input is zero continue
0052          LD C,11H              ;to move,if not move 68 mor
0053          SCF                    ;steps to determine the dei
0054          JP NGY
0055  STOP     : XOR A
0056          OUT (PORT0),A
0057          LD B,FFH

```

```

0058  DEL1  : CALL DLY
0059                DJNZ DEL1
0060                LD C,29H                ;Move out from the upper frame
0061  PSY    : LD HL,YSTEP1
0062                LD B,COUNT
0063  OUT3   : LD A,(HL)
0064                OUT (PORT0),A
0065                CALL DLY
0066                INC HL
0067                DJNZ OUT3
0068                DEC C
0069                JP NZ,PSY
0070                XOR A
0071                OUT (PORT0),A
0072                LD B,FFH
0073  DEL2   : CALL DLY
0074                DJNZ DEL2
0075  NGX    : LD HL,XSTEP1                ;Search for the right side
0076                LD B,COUNT                ;frame line
0077  OUT2   : LD A,(HL)
0078                OUT (PORT0),A
0079                CALL DLY
0080                INC HL
0081                DJNZ OUT2
0082                IN A,(PORT1)
0083                BIT 0,A
0084                JP Z,NGX
0085                XOR A
0086                OUT (PORT0),A

```

```

0087          LD B,FFH
0088  DEL3    : CALL DLY
0089          DJNZ DEL3
0090          LD C,20H          ;Move out from the right side
0091  PSX     : LD HL,XSTEP4    ;frame
0092          LD B,COUNT
0093  OUT4    : LD A,(HL)
0094          OUT (PORT0),A
0095          CALL DLY
0096          DEC HL
0097          DJNZ OUT4
0098          DEC C
0099          JP NZ,PSX
0100          XOR A          ;Stop on the zero position
0101          OUT (PORT0),A  ;location
0102          LD B,FF
0103  DEL4    : CALL DLY
0104          DJNZ DEL4
0105  FRLGTH  : LD L,00        ;Frame length program
0106  FPSX    : LD A,STEP      ;Measure x-length
0107          LD (WAY),A
0108          CALL MVINXL
0109          INC L
0110          IN A,(PORT1)
0111          BIT 0,A
0112          JP Z,FPSX
0113          XOR A
0114          OUT (PORT0),A
0115          LD B,FFH

```

```

Ø116   DEL5   : CALL DLY
Ø117           DJNZ DEL5
Ø118           DEC L
Ø119           DEC L
Ø120           LD DE,XLENGTH
Ø121           LD A,L
Ø122           LD (DE),A
Ø123           INC L
Ø124           INC L
Ø125           LD A,L
Ø126           SUB A+DSTP
Ø127           LD (XPATH),A
Ø128           LD (PATH),A
Ø129           LD A,L
Ø130           LD (WAY),A
Ø131           CALL Z,MVINXR
Ø132           JP Z,DLX
Ø133           CALL C,MVINXR
Ø134           JP C,DLX
Ø135           CALL XRACC
Ø136   DLX    : LD B,FFH
Ø137   DEL6   : CALL DLY
Ø138           DJNZ DEL6
Ø139           LD L,ØØ
Ø140   FPSY   : LD A,STEP           ;Measure y-length
Ø141           LD (WAY),A
Ø142           CALL MVINYD
Ø143           INC L
Ø144           IN A,(PORT1)

```



```

Ø145          BIT Ø,A
Ø146          JP Z,FPSY
Ø147          XOR A
Ø148          OUT (PORTØ),A
Ø149          LD B,FFH
Ø150 DEL7     : CALL DLY
Ø151          DJNZ DEL7
Ø152          DEC L
Ø153          DEC L
Ø154          LD DE,YLENGTH
Ø155          LD A,L
Ø156          LD (DE),A
Ø157          INC L
Ø158          INC L
Ø159          LD A,L
Ø160          SUB A+DSTP
Ø161          LD (YPATH),A
Ø162          LD (PATH),A
Ø163          LD A,L
Ø164          LD (WAY),A
Ø165          CALL Z,MVINYU
Ø166          JP Z,DLYY
Ø167          CALL C,MVINYU
Ø168          JP C,DLYY
Ø169          CALL YUACC
Ø170 DLYY     : LD B,FFH
Ø171 DEL8     : CALL DLY
Ø172          DJNZ DEL8
Ø173          LD A,(XPATH)

```

```

Ø174          DEC A
Ø175          DEC A
Ø176          LD (XPATH),A
Ø177          LD A,(YPATH)
Ø178          DEC A
Ø179          DEC A
Ø180          LD (YPATH),A
Ø181          LD A,(XLENGTH)
Ø182          INC A
Ø183          LD (XINC),A
Ø184          INC A
Ø185          LD (XL2),A
Ø186          SCANPR : LD A,(XLENGTH) ;Scanning Program
Ø187          SUB A+DSTP ;Test for constant speed scan
Ø188          JP Z,CSCAN ;or by acceleration
Ø189          JP C,CSCAN
Ø190          LD A,(YLENGTH)
Ø191          LD L,A
Ø192          CALL STORE
Ø193          SXPA : LD IY,ACONS ;Start scanning the first line
Ø194          LD C,ACOUNT ;by acceleration
Ø195          SXPAH : LD H,ØØ
Ø196          SXPAR : LD IX,XSTEP4
Ø197          LD B,COUNT
Ø198          SXPAM : LD A,(IX+ØØ)
Ø199          OUT (PORTØ),A
Ø200          LD E,(IY+ØØ)
Ø201          CALL VDLY
Ø202          INC H

```

Ø2Ø3	LD A, GRID	
Ø2Ø4	CP H	
Ø2Ø5	JR Z+9	
Ø2Ø6	DEC IX	
Ø2Ø7	DJNZ SXPAM	
Ø2Ø8	JP SXPAR	
Ø2Ø9	INC IY	
Ø21Ø	CALL STORE	
Ø211	DEC C	
Ø212	JP NZ, SXPAH	
Ø213	PUSH HL	
Ø214	LD HL, XPATH	
Ø215	LD C, (HL)	
Ø216	POP HL	
Ø217	SXAPH : LD H, ØØ	
Ø218	SXAPS : LD IX, XSTEP4	; Scanning with maximum speed
Ø219	LD B, COUNT	
Ø22Ø	SXAPM : LD A, (IX+ØØ)	
Ø221	OUT (PORTØ), A	
Ø222	LD E, MAXSPD	
Ø223	CALL VDLY	
Ø224	INC H	
Ø225	LD A, GRID	
Ø226	CP H	
Ø227	JR Z, +9	
Ø228	DEC IX	
Ø229	DJNZ SXAPM	
Ø23Ø	JP SXAPS	
Ø231	CALL STORE	

```

Ø232          DEC C
Ø233          JP NZ, SXAPH
Ø234  SXPDP  : LD IY, DCONS      ;Start to decelerate
Ø235          LD C, DCOUNT
Ø236  SXPDPH : LD H, ØØ
Ø237  SXPDR  : LD IX, XSTEP4
Ø238          LD B, COUNT
Ø239  SXPDM  : LD A, (IX+ØØ)
Ø240          OUT (PORTØ), A
Ø241          LD E, (IY+ØØ)
Ø242          CALL VDLY
Ø243          INC H
Ø244          LD A, GRID
Ø245          CP H
Ø246          JR Z, +9
Ø247          DEC IX
Ø248          DJNZ SXPDM
Ø249          JP SXPDR
Ø250          INC IY
Ø251          CALL STORE
Ø252          DEC C
Ø253          JP NZ, SXPDPH
Ø254          EXX
Ø255          EX AF, AF'
Ø256          LD HL, LOC1
Ø257          LD C, (HL)
Ø258          LD A, BYTE
Ø259          AND C
Ø260          JP NZ, SX1

```

```

Ø261          CALL LASTST
Ø261          JP SP1
Ø262  SX1     : EX AF,AF'
Ø263          EXX
Ø264  SP1     : XOR A           ;Stop at the end of the line
Ø265          OUT (PORTØ),A
Ø266          LD B,1FH
Ø267  SDEL1   : CALL DLY
Ø268          DJNZ SDEL1
Ø269          LD A,STEP
Ø270          LD (WAY),A
Ø271          CALL MVINYD      ;Move one grid down
Ø272          LD B,1FH
Ø273  SDEL2   : CALL DLY
Ø274          DJNZ SDEL2
Ø275          DEC L           ;Test whether the card is
Ø276          JP Z,SRTNZ1     ;finished,if yes,return to
Ø277          CALL STORE      ;zero position
Ø278  SXNA    : LD IY,ACONS   ;if not,scan the next line
Ø279          LD C,ACOUNT
Ø280  SXNAH   : LD H,ØØ
Ø281  SXNAR   : LD IX,XSTEP1
Ø282          LD B,COUNT
Ø283  SXNAM   : LD A,(IX+ØØ)
Ø284          OUT (PORTØ),A
Ø285          LD E,(IY+ØØ)
Ø286          CALL VDLY
Ø287          INC H
Ø288          LD A,GRID

```

Ø289		CP H
Ø290		JR Z+9
Ø291		INC IX
Ø292		DJNZ SXNAM
Ø293		JP SXNAR
Ø294		INC IY
Ø295		CALL STORE
Ø296		DEC C
Ø297		JP NZ, SXNAH
Ø298		PUSH HL
Ø299		LD HL, XPATH
Ø300		LD C, (HL)
Ø301		POP HL
Ø302	SXDPH	: LD H, ØØ
Ø303	SXDPS	: LD IX, XSTEP1
Ø304		LD B, COUNT
Ø305	SXDPM	: LD A, (IX+ØØ)
Ø306		OUT (PORTØ), A
Ø307		LD E, MAXSPD
Ø308		CALL VDLY
Ø309		INC H
Ø310		LD A, GRID
Ø311		CP H
Ø312		JR Z+9
Ø313		INC IX
Ø314		DJNZ SXDPM
Ø315		JP SXDPS
Ø316		CALL STORE
Ø317		DEC C

```
Ø318          JP NZ, SXDPH
Ø319  SXND    : LD IY, DCONS
Ø320          LD C, DCOUNT
Ø321  SXNDH   : LD H, ØØ
Ø322  SXNDR   : LD IX, XSTEP1
Ø323          LD B, COUNT
Ø324  SXNDM   : LD A, (IX+ØØ)
Ø325          OUT (PORTØ), A
Ø326          LD E, (IY+ØØ)
Ø327          CALL VDLY
Ø328          INC H
Ø329          LD A, GRID
Ø330          CP H
Ø331          JR Z, +9
Ø332          INC IX
Ø333          DJNZ SXNDM
Ø334          JP SXNDR
Ø335          INC IY
Ø336          CALL STORE
Ø337          DEC C
Ø338          JP NZ, SXNDM
Ø339          EXX
Ø340          EX AF, AF'
Ø341          LD HL, IOC1
Ø342          LD C, (HL)
Ø343          LD A, BYTE
Ø344          AND C
Ø345          JP NZ, SX2
Ø346          CALL LASTST
```

```

Ø347          JP SP2
Ø348  SX2     : EX AF,AF'
Ø349          EXX
Ø350  SP2     : XOR A
Ø351          OUT (PORTØ),A
Ø352          LD B,1FH
Ø353  SDEL3   : CALL DLY
Ø354          DJNZ SDEL3
Ø355          LD A,STEP
Ø356          LD (WAY),A
Ø357          CALL MVINYD
Ø358          CALL STORE
Ø359          LD B,1FH
Ø360  SDELR   : CALL DLY
Ø361          DJNZ SDELR
Ø361          DEC L
Ø362          JP Z,SRTNZ2
Ø363          JP SXPA
Ø364  CSCAN   : LD A,(YLNTH) ;Constant Speed Scanning Progr
Ø365          LD L,A
Ø366          CALL STORE
Ø367  CSTART  : LD A,(XLNTH)
Ø368          LD C,A
Ø369  LCONT   : LD A,STEP
Ø370          LD (WAY),A
Ø371          CALL MVINXL
Ø372          CALL STORE
Ø373          DEC C
Ø374          JP NZ,LCONT

```



Ø375		EXX
Ø376		EX AF,AF'
Ø377		LD HL,LOC1
Ø378		LD C,(HL)
Ø379		LD A,BYTE
Ø38Ø		AND C
Ø381		JP NZ,CX1
Ø382		CALL LASTST
Ø383		JP CP1
Ø384	CX1	: EX AF,AF'
Ø385		EXX
Ø386	CPI	: XOR A
Ø387		OUT (PORTØ),A
Ø388		LD B,1FH
Ø389	CDEL1	: CALL DLY
Ø39Ø		DJNZ CDEL1
Ø391		LD A,STEP
Ø392		LD (WAY),A
Ø393		CALL MVINYD
Ø394		LD B,1FH
Ø395	SDEL3	: CALL DLY
Ø396		DJNZ SDEL3
Ø397		DEC L
Ø398		JP Z,SRTNZ1
Ø399		CALL STORE
Ø4ØØ		LD A,(XLNGTH)
Ø4Ø1		LD C,A
Ø4Ø2	RCONT	: LD A,STEP
Ø4Ø3		LD (WAY),A

Ø4Ø4		CALL MVINXR	
Ø4Ø5		CALL STORE	
Ø4Ø6		DEC C	
Ø4Ø7		JP NZ,RCONT	
Ø4Ø8		EXX	
Ø4Ø9		EX AF,AF'	
Ø41Ø		LD HL,LOC1	
Ø411		LD C,(HL)	
Ø412		LD A,BYTE	
Ø413		AND C	
Ø414		JP NZ,CX2	
Ø415		CALL LASTST	
Ø416		JP CP2	
Ø417	CX2	: EX AF,AF'	
Ø418		EXX	
Ø419	CP2	: XOR A	
Ø42Ø		OUT (PORTØ),A	
Ø421		LD B,1FH	
Ø422	SDELR	: CALL DLY	
Ø423		DJNZ SDELR	
Ø424		LD A,STEP	
Ø425		LD (WAY),A	
Ø426		CALL MVINYD	
Ø427		DEC L	
Ø428		JP Z,SRTNZ2	
Ø429		CALL STORE	
Ø43Ø		JP CSTART	
Ø431	STORE	: EXX	;Store Program
Ø432		EX AF,AF'	

Ø433		IN A, (PORT1)	
Ø434		LD HL, LOC2	
Ø435		LD B, (HL)	
Ø436		RRC B	
Ø437		OR B	
Ø438		LD HL, LOC1	
Ø439		LD C, (HL)	
Ø440		LD (LOC2), A	
Ø441		DEC C	
Ø441		LD (HL), C	
Ø442		JP Z, STM	
Ø443		EX AF, AF'	
Ø444		EXX	
Ø445		RET	
Ø446	LASTST :	LD A, (LOC1)	;Last store
Ø447		LD B, A	
Ø448		LD A, (LOC2)	
Ø449	ROT :	RRC A	
Ø450		DJNZ ROT	
Ø451		LD (LOC2), A	
Ø452	STM :	LD A, (LOC2)	;Store to memory
Ø453		RRC A	
Ø454		LD HL, (STAM)	
Ø455		LD (HL), A	
Ø456		INC HL	
Ø457		LD (STAM), HL	
Ø458		LD A, BYTE	
Ø459		LD (LOC1), A	
Ø460		LD A, ØØ	

```

Ø461          LD (LOC2),A
Ø462          EX AF,AF'
Ø463          EXX
Ø464          RET
Ø465  SRTNZ1  : LD B,FFH          ;Return to zero position from
Ø466  SDELX   : CALL DLY         ;an odd numbered line
Ø467          DJNZ SDELX
Ø468          LD A,(XLENGTH)
Ø469          LD (WAY),A
Ø470          SUB A+DSTP
Ø471          CALL Z,MVINXR
Ø472          JP Z,SRTNZ2
Ø473          CALL C,MVINXR
Ø474          JP C,SRTNZ2
Ø475          LD A,(XPATH)
Ø476          LD (PATH),A
Ø477          CALL XRACC
Ø478  SRTNZ2  : LD B,FFH          ;Return to zero-position from
Ø479  SDEL4   : CALL DLY         ;an even-line
Ø480          DJNZ SDEL4
Ø481          LD A,(YLENGTH)
Ø482          LD (WAY),A
Ø483          SUB A+DSTP
Ø484          CALL Z,MVINYU
Ø485          JP Z,END
Ø486          CALL C,MVINYU
Ø487          JP C,END
Ø488          LD A,(YPATH)
Ø489          LD (PATH),A

```

```

Ø49Ø          CALL YUACC
Ø491  END      : XOR A
Ø492          OUT (PORTØ),A
Ø493          LD B,FFH
Ø494  SDEL5    : CALL DLY
Ø495          DJNZ SDEL5
Ø496          LD B,9ØH          ;DRILLING Program
Ø497          LD HL,872DH
Ø498  ZERØ     : INC HL
Ø499          LD (HL),ØØ
Ø5ØØ          DJNZ ZERØ
Ø5Ø1          LD A,(XINC)
Ø5Ø2          LD C,A
Ø5Ø3          LD (OLDX),A
Ø5Ø4          SRL A
Ø5Ø5          LD (HALFX),A
Ø5Ø6          LD A,(YLENGTH)
Ø5Ø7          LD D,A
Ø5Ø8          LD HL,STRAM
Ø5Ø9          LD IX,FRSTIX
Ø51Ø          JP STR
Ø511  FTRACE   : BIT Ø,(HL)          ;Routine to trace an even-lin
Ø512          JP NZ,FLDØ
Ø513  FTRØ     : DEC C
Ø514          JP Z,NXTLIN
Ø515          BIT 1,(HL)
Ø516          JP NZ,FLD1
Ø517  FTR1     : DEC C
Ø518          JP Z,NXTLIN

```

Ø519		BIT 2, (HL)
Ø52Ø		JP NZ, FLD2
Ø521	FTR2	: DEC C
Ø522		JP Z, NXTLIN
Ø523		BIT 3, (HL)
Ø524		JP NZ, FLD3
Ø525	FTR3	: DEC C
Ø526		JP Z, NXTLIN
Ø527		BIT 4, (HL)
Ø528		JP NZ, FLD4
Ø529	FTR4	: DEC C
Ø53Ø		JP Z, NXTLIN
Ø531		BIT 5, (HL)
Ø532		JP NZ, FLD5
Ø533	FTR5	: DEC C
Ø534		JP Z, NXTLIN
Ø535		BIT 6, (HL)
Ø536		JP NZ, FLD6
Ø537	FTR6	: DEC C
Ø538		JP Z, NXTLIN
Ø539		BIT 7, (HL)
Ø54Ø		JP NZ, FLD7
Ø541	FTR7	: DEC C
Ø542		JP Z, NXTLIN
Ø543		INC HL
Ø544		JP FTRACE
Ø545	FLDØ	: LD A, (XL2)
Ø546		SUB C
Ø547		LD (IX+Ø), A

```
Ø548          INC IX
Ø549          JP FTRØ
Ø56Ø         FLD1   : LD A,(XL2)
Ø561          SUB C
Ø562          LD (IX+Ø),A
Ø563          INC IX
Ø564          JP FTR1
Ø565         FLD2   : LD A,(XL2)
Ø566          SUB C
Ø567          LD (IX+Ø),A
Ø568          INC IX
Ø569          JP FTR2
Ø57Ø         FLD3   : LD A,(XL2)
Ø571          SUB C
Ø572          LD (IX+Ø),A
Ø573          INC IX
Ø574          JP FTR3
Ø575         FLD4   : LD A,(XL2)
Ø576          SUB C
Ø577          LD (IX+Ø),A
Ø578          INC IX
Ø579          JP FTR4
Ø58Ø         FLD5   : LD A,(XL2)
Ø581          SUB C
Ø582          LD (IX+Ø),A
Ø583          INC IX
Ø584          JP FTR5
Ø585         FLD6   : LD A,(XL2)
Ø586          SUB C
```

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0587      LD (IX+0),A .
0588      INC IX
0589      JP FTR6
0590  FLD7  : LD A,(XL2)
0591      SUB C
0592      LD (IX+0),A
0593      INC IX
0594      JP FTR7
0595  NXTLIN : DEC IX
0596      LD (LASTIX),IX
0597      INC HL
0598      LD (SAVEHL),HL
0599      LD IX,FRSTIX ;Test whether there is a hole
0600      LD A,(IX+0) ;on this line
0601      LD E,(IX+1)
0602      OR E
0603      CALL Z,MOVINY
0604      JP Z,STRACE
0605      LD A,(IX+1) ;Test whether there is only
0606      LD E,(IX+2) ;one hole
0607      OR E
0608      JP Z,FLEFT
0609      LD A,(OLDX)
0610      LD E,A
0611      LD IX,(LASTIX)
0612      LD A,(IX+0)
0613      SUB E
0614      JP Z,RZERO
0615      JP C,LRM

```



```

Ø616      LD B,A
Ø617      LD A,(FRSTIX)
Ø618      LD E,A
Ø619      LD A,(OLDX)
Ø62Ø      SUB E
Ø621      JP Z,LZERO
Ø622      JP C,RM
Ø623      SUB B
Ø624      JP NC,FRIGHT
Ø625      JP FLEFT
Ø626      FRIGHT : LD A,(OLDX)      ;Routine to move right
Ø627      LD E,A
Ø628      LD IX,(LASTIX)
Ø629      LD A,(IX+Ø)
Ø63Ø      SUB E
Ø631      JP Z,RZERO
Ø632      JP NC,RMOVE
Ø633      LRM      : LD A,(IX+Ø)
Ø634      LD E,A
Ø635      LD A,(OLDX)
Ø636      SUB E
Ø637      LD (WAY),A
Ø638      LD H,A+DSTP
Ø639      SUB H
Ø64Ø      CALL Z,MVINXL
Ø641      JP Z,RZERO
Ø642      CALL C,MVINXL
Ø643      JC C,RZERO
Ø644      LD (PATH),A

```

```

Ø645          CALL XLACC
Ø646          JP RZERO
Ø647  FLEFT  : LD A, (FRSTIX) ;Routine to move left
Ø648          LD E, A
Ø649          LD A, (OLDX)
Ø650          SUB E
Ø651          JP LZERO
Ø652          JP NC, LMOVE
Ø653  RM     : LD A, (OLDX)
Ø654          LD E, A
Ø655          LD A, (FRSTIX)
Ø656          SUB E
Ø657          LD (WAY), A
Ø658          LD H, A+DSTP
Ø659          SUB H
Ø660          CALL Z, MVINXR
Ø661          JP Z, LZERO
Ø662          CALL C, MVINXR
Ø663          JP C, LZERO
Ø664          LD (PATH), A
Ø665          CALL XRACC
Ø666          JP LZERO
Ø667  RMOVE  : LD (WAY), A
Ø668  RATEST : LD H, A+DSTP
Ø669          SUB H
Ø670          CALL Z, MVINXR
Ø671          JP Z, RZERO
Ø672          CALL C, MVINXR
Ø673          JP C, RZERO

```

Ø674		ID (PATH),A	
Ø675		CALL XRACC	
Ø676	RZERO	: NOP	
Ø677		CALL DRILL	
Ø678		ID IX,(LASTIX)	
Ø679		ID A,(IX-1)	
Ø68Ø		OR A	
Ø681		JP Z,STRAC	
Ø682	FRRTL	: ID E,(IX-1)	;Routine to move from right
Ø683		ID A,(IX+Ø)	;to left on an evenline
Ø684		ID (SAVEIX),IX	
Ø685		SUB E	
Ø686		ID (WAY),A	
Ø687		ID H,A+DSTP	
Ø688		SUB H	
Ø689		CALL Z,MVINXL	
Ø69Ø		JP Z,DL	
Ø691		CALL C,MVINXL	
Ø692		JP C,DL	
Ø693		ID (PATH),A	
Ø694		CALL XLACC	
Ø695	DL	: NOP	
Ø696		CALL DRILL	
Ø697		ID IX,(SAVEIX)	
Ø698		DEC IX	
Ø699		ID A,(IX-1)	
Ø7ØØ		OR A	
Ø7Ø1		JP Z,STRAC	
Ø7Ø2		JP FRRTL	

```

Ø7Ø3  LMOVE  : LD (WAY),A
Ø7Ø4  LATEST : LD H,A+DSTP
Ø7Ø5          LD A,(WAY)
Ø7Ø6          SUB H
Ø7Ø7          CALL Z,MVINXL
Ø7Ø8          JP Z,LZERO
Ø7Ø9          CALL C,MVINXL
Ø71Ø          JP C,LZERO
Ø711          LD (PATH),A
Ø712          CALL XLACC
Ø713  LZERO  : NOP
Ø714          CALL DRILL
Ø715          LD IX,FRSTIX
Ø716          LD A,(IX+1)
Ø717          OR A
Ø718          JP Z,STRAC
Ø719  FRLTR  : LD E,(IX+Ø)      ;Routine to move from left
Ø72Ø          LD A,(IX+1)      ;to right on an evenline
Ø721          LD (SAVEIX),IX
Ø722          SUB E
Ø723          LD (WAY),A
Ø724          LD H,A+DSTP
Ø725          SUB H
Ø726          CALL Z,MVINXR
Ø727          JP Z,DR
Ø728          CALL C,MVINXR
Ø729          JP C,DR
Ø73Ø          LD (PATH),A
Ø731          CALL XRACC

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Ø732   DR      : NOP
Ø733           CALL DRILL
Ø734           LD IX, (SAVEIX)
Ø735           INC IX
Ø736           LD A, (IX+1)
Ø737           OR A
Ø738           JP Z, STRAC
Ø739           JP FRLTR
Ø740   DRILL   : EXX           ;Drill simulating routine
Ø741           EX AF, AF'
Ø742           XOR A
Ø743           OUT (PORTØ), A
Ø744           LD A, 8ØH
Ø745           OUT (PORT1), A
Ø746           LD B, 7FH
Ø747   DR2    : CALL DLY
Ø748           DJNZ DR2
Ø749           XOR A
Ø750           OUT (PORT1), A
Ø751           EX AF, AF'
Ø752           EXX
Ø753           RET
Ø754   STRAC  : LD A, (IX+Ø)
Ø755           LD (OLDX), A
Ø756           CALL MOVINY
Ø757   STRACE : DEC D
Ø758           JP Z, RETURN
Ø759           LD B, 9ØH
Ø760           LD HL, 872DH

```

Ø761	SZERO	:	INC HL	
Ø762			LD (HL),ØØ	
Ø763			DJNZ SZERO	
Ø764			LD A,(XINC)	
Ø765			LD C,A	
Ø766			LD HL,(SAVEHL)	
Ø767			LD IX,FRSTIX	
Ø768	STR	:	BIT Ø,HL	;Routine to trace an odd-line
Ø769			JP NZ,SØ	
Ø77Ø	RØ	:	DEC C	
Ø771			JP Z,SECLIN	
Ø772			BIT 1,(HL)	
Ø773			JP NZ,S1	
Ø774	R1	:	DEC C	
Ø775			JP Z,SECLIN	
Ø776			BIT 2,(HL)	
Ø777			JP NZ,S2	
Ø778	R2	:	DEC C	
Ø779			JP Z,SECLIN	
Ø78Ø			BIT 3,(HL)	
Ø781			JP NZ,S3	
Ø782	R3	:	DEC C	
Ø783			JP Z,SECLIN	
Ø784			BIT 4,(HL)	
Ø785			JP NZ,S4	
Ø786	R4	:	DEC C	
Ø787			JP Z,SECLIN	
Ø788			BIT 5,(HL)	
Ø789			JP NZ,S5	

Ø79Ø	R5	: DEC C
Ø791		JP Z, SECLIN
Ø792		BIT 6, (HL)
Ø793		JP NZ, S6
Ø794	R6	: DEC C
Ø795		JP Z, SECLIN
Ø796		BIT 7, (HL)
Ø797		JP NZ, S7
Ø798	R7	: DEC C
Ø799		JP Z, SECLIN
Ø8ØØ		INC HL
Ø8Ø1		JP STR
Ø8Ø2	SØ	: LD (IX+Ø), C
Ø8Ø3		INC IX
Ø8Ø4		JP RØ
Ø8Ø5	S1	: LD (IX+Ø), C
Ø8Ø6		INC IX
Ø8Ø7		JP R1
Ø8Ø8	S2	: LD (IX+Ø), C
Ø8Ø9		INC IX
Ø81Ø		JP R2
Ø811	S3	: LD (IX+Ø), C
Ø812		INC IX
Ø813		JP R3
Ø814	S4	: LD (IX+Ø), C
Ø815		INC IX
Ø816		JP R4
Ø817	S5	: LD (IX+Ø), C
Ø818		INC IX

```
Ø819          JP R5
Ø82Ø      S6   : LD (IX+Ø),C
Ø821          INC IX
Ø822          JP R6
Ø823      S7   : LD (IX+Ø),C
Ø824          INC IX
Ø825          JP R7
Ø826      SECLIN : DEC IX
Ø827          LD (LASTIX),IX
Ø828          INC HL
Ø829          LD (SAVEHL),HL
Ø83Ø          LD IX,FRSTIX
Ø831          LD A,(IX+Ø)
Ø832          LD E,(IX+1)
Ø834          OR E
Ø835          CALL Z,MOVINY
Ø836          JP Z,FTR
Ø837          LD A,(IX+1)
Ø838          LD A,(IX+2)
Ø839          OR E
Ø84Ø          JP Z,SRIGHT
Ø841          LD A,(OLDX)
Ø842          LD E,A
Ø843          LD A,(FRSTIX)
Ø844          SUB E
Ø845          JP Z,SRZERO
Ø846          JP C,HLMOVE
Ø847          LD B,A
Ø848          LD IX,(LASTIX)
```



Ø849	LD E, (IX+Ø)	
Ø85Ø	LD A, (OLDX)	
Ø851	SUB E	
Ø852	JP Z, SLZERO	
Ø853	JP C, RLM	
Ø854	SUB B	
Ø855	JP C, SLEFT	
Ø856	SRIGHT : LD A, (OLDX)	;Routine to move right on
Ø857	LD E, A	;an odd-line
Ø858	LD A, (FRSTIX)	
Ø859	SUB E	
Ø86Ø	JP Z, SRZERO	
Ø861	JP NC, SRMOVE	
Ø862	HLMOVE : LD A, (FRSTIX)	
Ø863	LD E, A	
Ø864	LD A, (OLDX)	
Ø865	SUB E	
Ø866	LD (WAY), A	
Ø867	LD H, A+DSTP	
Ø868	SUB H	
Ø869	CALL Z, MVINXL	
Ø87Ø	JP Z, SRZERO	
Ø871	CALL C, MVINXL	
Ø872	JP C, SRZERO	
Ø873	LD (PATH), A	
Ø874	CALL XLACC	
Ø875	JP SRZERO	
Ø876	SRMOVE : LD (WAY), A	
Ø877	LD H, A+DSTP	

```

Ø878          SUB H
Ø879          CALL Z,MVINXR
Ø88Ø         JP Z,SRZERO
Ø881          CALL C,MVINXR
Ø882          JP C,SRZERO
Ø883          LD (PATH),A
Ø884          CALL XRACC
Ø885  SRZERO : NOP
Ø886          CALL DRILL
Ø887          LD IX,FRSTIX
Ø888          LD A,(IX+1)
Ø889          OR A
Ø89Ø         JP Z,FTRAC
Ø891  SFRTL  : LD E,(IX+1)      ;Routine to move from right
Ø892          LD A,(IX+Ø)      ;to left on an odd-line
Ø893          LD (SAVEIX),IX
Ø894          SUB E
Ø895          LD (WAY),A
Ø896          LD H,A+DSTP
Ø897          SUB H
Ø898          CALL Z,MVINXL
Ø899          JP Z,SDL
Ø9ØØ        CALL C,MVINXL
Ø9Ø1        JP C,SDL
Ø9Ø2        LD (PATH),A
Ø9Ø3        CALL XLACC
Ø9Ø4  SDL    : NOP
Ø9Ø5        CALL DRILL
Ø9Ø6        LD IX,(SAVEIX)

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Ø9Ø7          INC IX
Ø9Ø8          LD A,(IX+1)
Ø91Ø          OR A
Ø911          JP Z,FTRAC
Ø912          JP SFRTL
Ø913  SLEFT  : LD IX,(LASTIX) ;Routine to move left on
Ø914          LD A,(IX+Ø)      ;an odd-line
Ø915          LD E,A
Ø916          LD A,(OLDX)
Ø917          SUB E
Ø918          JP Z,SLZERO
Ø919          JP NC,SLMOVE
Ø92Ø  RLM    : LD A,(OLDX)
Ø921          LD E,A
Ø922          LD A,(IX+Ø)
Ø923          SUB E
Ø924          LD (WAY),A
Ø925          LD H,A+DSTP
Ø926          SUB H
Ø927          CALL Z,MVINXR
Ø928          JP Z,SLZERO
Ø929          CALL C,MVINXR
Ø93Ø          JP C,SLZERO
Ø931          LD (PATH),A
Ø932          CALL XRACC
Ø933          JP SLZERO
Ø934  SLMOVE : LD (WAY),A
Ø935          LD H,A+DSTP
Ø936          LD A,(WAY)

```

```

Ø937          SUB H
Ø938          CALL Z,MVINXL
Ø939          JP Z,SLZERO
Ø940          CALL C,MVINXL
Ø941          JP C,SLZERO
Ø942          LD (PATH),A
Ø943          CALL XLACC
Ø944          SLZERO : NOP
Ø945          CALL DRILL
Ø946          LD IX,(LASTIX)
Ø947          LD A,(IX-1)
Ø948          OR A
Ø949          JP Z,FTRAC
Ø950          SFLTR  : LD E,(IX+Ø)      ;Routine to move from left
Ø951          LD A,(IX-1)      ;to right on an odd-line
Ø952          LD (SAVEIX),IX
Ø953          SUB E
Ø954          LD (WAY),A
Ø955          LD H,A+DSTP
Ø956          SUB H
Ø957          CALL Z,MVINXR
Ø958          JP Z,SDR
Ø959          CALL C,MVINXR
Ø960          JP C,SDR
Ø961          LD (PATH),A
Ø962          CALL XRACC
Ø963          SDR    : NOP
Ø964          CALL DRILL
Ø965          LD IX,(SAVEIX)

```

Ø966		DEC IX	
Ø967		LD A, (IX-1)	
Ø968		OR A	
Ø969		JP Z, FTRAC	
Ø970		JP SFLTR	
Ø971	FTRAC	: LD A, (IX+Ø)	
Ø972		LD (OLDX), A	
Ø973		CALL MOVINY	
Ø974	FTR	: DEC D	
Ø975		JP Z, RETURN	
Ø976		LD B, 9ØH	
Ø977		LD HL, 872DH	
Ø978	ZR	: INC HL	
Ø979		LD (HL), ØØ	
Ø980		DJNZ ZR	
Ø981		LD A, (XINC)	
Ø982		LD C, A	
Ø983		LD HL, (SAVEHL)	
Ø984		LD IX, ERSTIX	
Ø985		JP FTRACE	
Ø986	RETURN	: LD A, (OLDX)	;Return to zero-position after
Ø987		LD E, A	;drilling of the whole card i
Ø988		LD A, (XINC)	;finished
Ø989		SUB E	
Ø990		JP Z, SRTNZ2	
Ø991		LD (WAY), A	
Ø992		CALL MVINXR	
Ø993		JP SRTNZ2	

```

Ø994  MOVINY : LD A,STEP           ;Routine to move one grid i
Ø995                LD (WAY),A     ;y-direction downwards.
Ø996                CALL MVINYD
Ø997                RET
Ø998  DLY      : LD D,7DH           ;Constant delay routine.
Ø999  LOOP     : LD E,Ø3H
1ØØØ                DEC E
1ØØ1                JR NZ,-1
1ØØ2                DEC D
1ØØ3                JP NZ,LOOP
1ØØ4                RET
1ØØ5  VDLY    : LD D,Ø8H           ;Variable delay routine.
1ØØ6  IND      : DEC D
1ØØ7                JP NZ,IND
1ØØ8                DEC E
1ØØ9                JP NZ,VDLY
1Ø1Ø                RET
1Ø11  MVINXL  : EXX                 ;Routine to move left in
1Ø12                EX AF,AF'       ;x-direction with constant
1Ø13                LD A,(WAY)       ;speed.
1Ø14                LD C,A
1Ø15  RH      : LD H,ØØ
1Ø16  RLINE   : LD IX,XSTEP4
1Ø17                LD B,COUNT
1Ø18  RNEXT   : LD A,(IX+ØØ)
1Ø19                OUT (PORTØ),A
1Ø2Ø                CALL DLY
1Ø21                INC H
1Ø22                LD A,GRID

```

1023	CP H	
1024	JR Z,+9	
1025	DEC IX	
1026	DJNZ RNEXT	
1027	JP RLINE	
1028	DEC C	
1029	JP NZ,RH	
1030	EXX	
1031	EX AF,AF'	
1032	RET	
1033	MVINXR : EXX	;Routine to move right in
1034	EX AF,AF'	;x-direction with constant
1035	LD A,(WAY)	;speed.
1036	LD C,A	
1037	LH : LD H,00	
1038	LLINE : LD IX,XSTEP1	
1039	LD B,COUNT	
1040	LNEXT : LD A,(IX+00)	
1041	OUT (PORT0),A	
1042	CALL DLY	
1043	INC H	
1044	LD A,GRID	
1045	CP H	
1046	JR Z,+9	
1047	INC IX	
1048	DJNZ LNEXT	
1049	JP LLINE	
1050	DEC C	
1051	JP NZ,LH	

1052		EXX	
1053		EX AF,AF'	
1054		RET	
1055	ACONS	: EQU 07C0H	;Acceleration constants
1056	DCONS	: EQU 07D0H	;Deceleration constants
1057	YUACC	: EXX	;Routine to move the detect
1058		EX AF,AF'	;up in y-direction by accel
1059		LD IY,ACONS	;tion.
1060		LD C,ACOUNT	
1061	YRTH	: LD H,00	
1062	YARTN	: LD IX,YSTEP4	
1063		LD B,COUNT	
1064	BMOVE	: LD A,(IX+00)	
1065		OUT (PORT0),A	
1066		LD E,(IY+00)	
1067		CALL VDLY	
1068		INC H	
1069		LD A,GRID	
1070		CP H	
1071		JR Z,+9	
1072		DEC IX	
1073		DJNZ BMOVE	
1074		JP YARTN	
1075		INC IY	
1076		DEC C	
1077		JP NZ,YRTH	
1078		LD HL,PATH	
1079		LD C,(HL)	
1080	YMAXH	: LD H,00	



```
1081   YMAX   : LD IX, YSTEP4
1082           LD B, COUNT
1083   YAMV   : LD A, (IX+00)
1084           OUT (PORT0), A
1085           LD E, MAXSPD
1086           CALL VDLY
1087           INC H
1088           LD A, GRID
1089           CP H
1090           JR Z, +9
1091           DEC IX
1092           DJNZ YAMV
1093           JP YMAX
1094           DEC C
1095           JP NZ, YMAXH
1096   YDEC   : LD IY, DCONS
1097           LD C, DCOUNT
1098   YDRTH  : LD H, 00
1099   YDRTN  : LD IX, YSTEP4
1100           LD B, COUNT
1101   YDMV   : LD A, (IX+00)
1102           OUT (PORT0), A
1103           LD E, (IY+00)
1104           CALL VDLY
1105           INC H
1106           LD A, GRID
1107           CP H
1108           JR Z, +9
1109           DEC IX
```

1110	DJNZ YDMV
1111	JP YDRTN
1112	INC IY
1113	DEC C
1114	JP NZ, YDRTH
1115	XOR A
1116	OUT (PORT0), A
1117	EX AF, AF'
1118	EXX
1119	RET

```

1120     MVINYU : EXX           ;Routine to move the detect
1121             EX AF,AF'      ;up in y-direction with
1122             LD A,(WAY)     ;constant speed.
1123             LD C,A
1124             LD H,00
1125     ULINE  : LD IX,YSTEP4
1126             LD B,COUNT
1127     UNEXT  : LD A,(IX+00)
1128             OUT (PORT0),A
1129             CALL DLY
1130             INC H
1131             LD A,GRID
1132             CP H
1133             JR Z,+9
1134             DEC IX
1135             DJNZ UNEXT
1136             DEC C
1137             JP NZ,ULINE
1138             EXX
1139             EX AF,AF'
1140             XOR A
1141             OUT (PORT0),A
1142             RET

```

```

1143   MVINYD : EXX                               ;Routine to move the detec
1144           EX AF,AF'                           ;down in y-direction with
1145           LD A,(WAY)                           ;constant speed.
1146           LD C,A
1147           LD H,00
1148   DLINE  : LD IX, YSTEP1
1149           LD B,COUNT
1150   DNEXT  : LD A,(IX+00)
1151           OUT (PORT0),A
1152           CALL DLY
1153           INC H
1154           LD A,GRID
1155           CP H
1156           JR Z,+9
1157           INC IX
1158           DJNZ DNEXT
1159           DEC C
1160           JP NZ,DLINE
1161           EXX
1162           EX AF,AF'
1163           XOR A
1164           OUT (PORT0),A
1165           RET

```

```

1166 XRACC : EXX ;Routine to move the detec
1167 EX AF,AF' ;right in x-direction by
1168 LD IY,ACONS1 ;acceleration.
1169 LD C,ACOUNT ;Acceleration starts.
1170 XRTH : LD H,00
1171 XARTN : LD IX,XSTEP1
1172 LD B,COUNT
1173 AMOVE : LD A,(IX+0)
1174 OUT (PORT0),A
1175 LD E,(IY+0)
1176 CALL VDLY
1177 INC H
1178 LD A,GRID
1179 CP H
1180 JR Z,+9
1181 INC IX
1182 DJNZ AMOVE
1183 JP XARTN
1184 INC IY
1185 DEC C
1186 JP NZ,XRTH
1187 LD HL,PATH
1188 LD C,(HL)
1189 XNMXH : LD H,00 ;Maximum speed is reached
1190 XNMAX : LD IX,XSTEP1 ;the stage moves with the
1191 LD B,COUNT ;speed PATH long.
1192 XAMV : LD A,(IX+0)
1193 OUT (PORT0),A

```

```

1194          LD E,MAXSPD
1195          CALL VDLY
1196          INC H
1197          LD A,GRID
1198          CP H
1199          JR Z,+9
1200          INC IX
1201          DJNZ XAMV
1202          JP XNMAX
1203          DEC C
1204          JP NZ,XNMXH
1205  XDEC      : LD IY,DCONS1      ;Deceleration begins.
1206          LD C,DCOUNT
1207  XDRTH    : LD H,00
1208  XDRTN    : LD IX,XSTEP1
1209          LD B,COUNT
1210  XDMV     : LD A,(IX+0)
1211          OUT (PORT0),A
1212          LD E,(IY+0)
1213          CALL VDLY
1214          INC H
1215          LD A,GRID
1216          CP H
1217          JR Z,+9
1218          INC IX
1219          DJNZ XDMV
1220          JP XDRTN
1221          INC IY

```

```

1222          DEC C
1223          JP NZ,XDRTH
1224          XOR A          ;Deceleration lasts,and the
1225          OUT (PORT0),A ;x-stage stops.Then the routine
1226          EXX            ;returns to where it is called.
1227          EX AF,AF'
1228          RET
1229  XLACC  : EXX            ;Routine to move the detector
1230          EX AF,AF'      ;left in x-direction by
1231          LD IY,ACONS1   ;acceleration using the same
1232          LD C,ACOUNT    ;procedures described in XRACC
1233  SXPAH  : LD H,00      ;routine.
1234  SXPAR  : LD IX,XSTEP4
1235          LD E,COUNT
1236  SXPAM  : LD A,(IX+0)
1237          OUT (PORT0),A
1238          LD E,(IY+00)
1239          CALL VDLY
1240          INC H
1241          LD A,GRID
1242          CP H
1243          JR Z,+9
1244          DEC IX
1245          DJNZ SXPAM
1246          JP SXPAR
1247          INC IY
1248          DEC C
1249          JP NZ,SXPAH

```

```

1250          LD HL, PATH
1251          LD C, (HL)
1252  SXAPH   : LD H, 00
1253  SXAPS   : LD IX, XSTEP4
1254          LD B, COUNT
1255  SXAPM   : LD A, (IX+0)
1256          OUT (PORT0), A
1257          LD E, MAXSPD
1258          CALL VDLY
1259          INC H
1260          LD A, GRID
1261          CP H
1262          JR Z, +9
1263          DEC IX
1264          DJNZ SXAPM
1265          JP SXAPS
1266          DEC C
1267          JP NZ, SXAPH
1268  SXPD    : LD IY, DCONS1
1269          LD C, DCOUNT
1270  SXPDH   : LD H, 00
1271  SXPDR   : LD IX, XSTEP4
1272          LD B, COUNT
1273  SXPDM   : LD A, (IX+0)
1274          OUT (PORT0), A
1275          LD E, (IY+0)
1276          CALL VDLY
1277          INC H

```



1278	LD A,GRID
1279	CP H
1280	JR Z,+9
1281	DEC IX
1282	DJNZ SXPDM
1283	JP SXPDR
1284	INC IY
1285	DEC C
1286	JP NZ,SXPDH
1287	EXX
1288	EX AF,AF'
1289	RET

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